Title & Document Type: Manual Part Number: Serial Prefixes: Revision Date:

Errata HP5501B Laser Head Operating & Service Manual 05501-90035 2632 September 1986

HP References in this Manual

This manual may contain references to HP or Hewlett-Packard. Please note that Hewlett-Packard's former test and measurement, semiconductor products and chemical analysis businesses are now part of Agilent Technologies.

Changes to this Manual

No changes have been made to this manual, with the exception of correcting the odd spelling and grammatical errors. In some places original photographs may be replaced or augmented with modern digital photographs. (it's weird looking at an old BW HP manual and seeing a color photograph... still gets me)

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OPERATING AND SERVICE MANUAL

HP5501B LASER HEAD

SERIAL NUMBER PREFIX: 2632A

This manual applies directly to **HP5501B** Laser Heads with serial numbers prefixed 2632A. Lower number serial prefixes are covered in Section 7 while higher number serial prefixes are documented with "Manual Changes" Supplements described in Section 7.

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MANUAL PART NUMBER 05501-90035 Microfiche Part Number 05501-90036

Printed: SEPTEMBER 1986

ELECTRICAL SAFETY CONSIDERATIONS

GENERAL

The product and related documentation must be reviewed for familiarization with safety markings and instructions before operation.

This product is a Safety Class I instrument (provided with a protective earth terminal).

BEFORE APPLYING POWER

Verify that the product is set to match the available line voltage and the correct fuse is installed. Refer to <u>Section 2, Installation</u>.

SAFETY EARTH GROUND

An uninterruptible safety earth ground must be provided from the main power source to the product input wiring terminals, power cord, or supplied power cord set.

SAFETY SYMBOLS



Instruction manual symbol: the product will be marked with this symbol when it is necessary for the user to refer to the instruction manual.



Indicates hazardous voltages.

Indicates earth (ground) terminal.



The WARNING sign denotes a hazard. It calls attention to a procedure, practice, or the like, which, if not correctly performed or adhered to, could result in personal injury. Do not proceed beyond a WARNING sign until the indicated conditions are fully understood and met.



The **CAUTION** sign denotes a hazard. It calls attention to an operating procedure, practice, or the like, which, if not correctly performed or adhered to, could result in damage to or destruction of part or the entire product. Do not continue beyond a CAUTION sign until the indicated conditions are fully understood and met.



Any interruption of the protective (grounding) conductor (inside or outside the instrument) or disconnecting the protective earth terminal will cause a potential shock hazard that could result in personal Injury. (Grounding one conductor of a two conductor outlet is not sufficient protection).

Whenever it is likely that the protection has been impaired, the instrument must be made inoperative and be secured against any unintended operation.

If this instrument is to be energized via an autotransformer (for voltage reduction) you must make sure the common terminal is connected to the neutral (earthed pole) of the power source. Servicing instructions are for use by service-trained personnel only. To avoid dangerous electric shock, do not perform any servicing unless qualified to do so.

Adjustments described in the manual are performed with power supplied to the instrument while protective covers are removed. Energy available at many points may, if contacted, result in personal injury.

Capacitors inside the instrument may still be charged even if the instrument has been disconnected from its source of supply.

For continued protection against the fire hazard, replace the line fuse(s) only with 125V fuse(s) of the same current rating and type (for example, normal blow, time delay, etc.). Do not use repaired fuses or short circuited fuse holders.

From 1.2 kilovolts to 12 kilovolts dc is present on the anode of the laser tube in the 5501B. Exercise extreme caution when working inside the instrument. The high voltage could cause serious personal injury if contacted. Any adjustments performed should be by service trained personnel only.

LASER HEAD SAFETY CONSIDERATIONS

CAUTION

LASER RADIATION IS EMITTED FROM THE APERTURE ON THE 5501B LASER HEAD AS ILLUSTRATED ON THE FOLLOWING PAGE. DO NOT STARE INTO BEAM. THIS PRODUCT IS A CLASS II LASER PRODUCT CONFORMING TO U.S. NATIONAL CENTER FOR DEVICES AND RADIOLOGICAL HEALTH REGULATIONS 21 CFR 1040.10 AND 1040.11. THE MAXIMUM RADIANT POWER OUTPUT IS 1 MILLIWATT, THE PULSE SPECIFICATION IS CONTINUOUS WAVE, THE LASER MEDIUM IS HELIUM-NEON, AND THE WAVELENGTH IS 632.991 NANOMETRES.

LASER RADIATION IS ACCESSIBLE WHEN THE 5501B COVERS ARE REMOVED AND THE TEST-NORM SWITCH, A1S2, IS IN THE TEST POSITION.

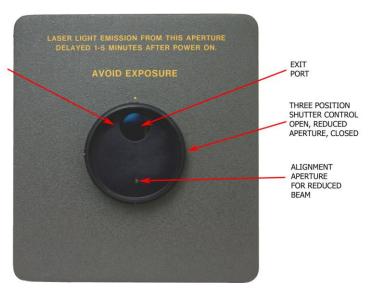
USE OF CONTROLS OR ADJUSTMENTS OR PERFORMANCE OF PROCEDURES OTHER THAN THOSE SPECIFIED HEREIN MAY RESULT IN HAZARDOUS RADIATION EXPOSURE.

LASER HEAD SAFETY LABELS



CAUTION

CAUTION Laser radiation present when exit port open and interlock failed or defeated DO NOT STARE INTO BEAM



-

END PRODUCT LASER SAFETY CONSIDERATIONS

The 5501B Laser Head complies with U.S. National Center for Devices and Radiological Health regulations 21 CFR 1040.10 and 1040.11.

These regulations may also apply to the end product into which the 5501B will be designed. Care must be taken to insure that the end product complies with all applicable national and local laser safety regulations.

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Figure 1-1 HP5501B Laser Head

1 GENERAL INFORMATION

1-1. Introduction

- 1-2. This Operating and Service Manual contains information required to install, operate, test, adjust, and service the Hewlett-Packard Model 5501B Laser Head. The information in this manual is specific to the **HP5501B** and supplements other publications available for Hewlett-Packard Laser Transducer products. Also available is the **HP5501A** Laser Transducer System Manual (HP Part Number 05501-90028) that describes how to setup, align, and use the laser system to make interferometer measurements.
- 1-3. The **HP** part number of this manual is listed on the title page. Also listed is a microfiche part number for ordering 4 X 6" microfilm transparencies of this manual. The microfiche package also includes the latest "Manual Changes" supplement and any pertinent Service Notes.

1-4. Equipment Description

- 1-5. The HP5501B Laser Head consists of a thermally-tuned laser tube, control circuits, a reference receiver, and a high-voltage power supply. The laser head requires ±15 Volt supplies, each with a minimum capacity of 1 Amp. The HP5501B produces a frequency stabilized laser beam, a balanced reference output (see paragraph 16), a +15 Volt fused output, and a +5 Volt output. Diagnostic LED's, mounted on the 5501B's rear panel, provide status information on power supply input (±15 Volts), fuses, laser output and tuning, and the reference frequency output.
- 1-6. The 5501B laser beam consists of two linearly polarized and mutually perpendicular (orthogonal) components separated in frequency by approximately 1.8 MHz. The two components have light frequencies of F1 and F2. The higher frequency component (F2) is oriented parallel to the laser base, while the lower frequency component (F1) is perpendicular to the laser base. An optical receiver inside the HP5501B detects the 1.8 MHz frequency difference and places it at the rear panel REFERENCE SIGNAL connector as a balanced output (called the REFerence Frequency). The reference output is one signal used by the external electronics to measure distance traveled.
- 1-7. During a typical measurement application, the laser beam travels through external optics where the horizontal and vertical components of the beam are separated. One component travels along a fixed path and returns to an external optical receiver. The other component travels along the path (axis) to be measured and then returns to the external receiver. The external receiver detects the frequency difference between the two components and outputs a signal called the MEASure Frequency. The MEASure Frequency from the external receiver and the REFerence Frequency from the laser head are compared by external, customer selected electronics. If the distance between the external optics is fixed, the MEASure and REFerence frequencies are equal. As the relative distance between the external optics changes, the MEASure Frequency changes due to a Doppler frequency shift. This relative change between the MEASure and REFerence Frequencies is used by the system electronics to compute distance traveled. The laser transducer system can be configured for computer control of open- and closed-loop positioning and measuring applications, having single or multiple axes. For more detailed information, refer to the HP5501A Laser Transducer System manual (HP Part Number 05501-90028).

1-8. Manual Organization

- 1-9. This Service Manual is organized as follows:
- **SECTION 1, GENERAL INFORMATION**: covers Equipment Description, Manual Organization, Instruments Covered by this Manual, Safety Considerations, Equipment Supplied, Available Accessories, Specifications, Recommended Test Equipment, and Warranty Information.
- **SECTION 2, INSTALLATION**: covers Grounding Considerations, Power Requirements, Interconnecting Cabling, Operating and Storage Environments, Storage and Shipment, and Packaging.
- **SECTION 3, OPERATION**: provides operating information and covers Equipment Front and Rear Panel Features, Warm-up Time Considerations, and Program Notes.
- **SECTION 4, PERFORMANCE TESTS:** provides Safety Considerations, Performance Tests, and a Test Record.
- **SECTION 5, ADJUSTMENTS:** covers Safety Considerations, Test Equipment Required, Adjustment Procedures, and an Adjustment Record.
- SECTION 6, REPLACEABLE PARTS: includes Tables of Replaceable Parts including illustrated parts breakdowns of chassis and mechanical assemblies, Abbreviations, Ordering Information, and the HP Direct Mail Order System.
- **SECTION 7, MANUAL CHANGES:** describes how to update or backdate the manual for prefixes other than those listed on the title page.
- **SECTION 8, SERVICE:** contains Safety Considerations, Theory and Block Diagram Descriptions, Trouble Isolation, Troubleshooting, Schematics, and Component Locations.

1-10. Instruments covered by this manual

- 1-11. Attached to each instrument is a serial plate. The serial number is in the form: OOOOAOOOOO. It is in two parts; the first four digits and the letter are the serial number prefix and the last five digits are the suffix. The prefix is the same for all identical instruments; it changes only when a change is made to the instrument. The suffix is assigned sequentially and is unique to the individual instrument. This manual applies to instruments with the serial number prefix listed on the title page of this manual.
- 1-12. An instrument manufactured after the printing of this manual may have a serial number prefix that is not listed on the title page. This unlisted serial number prefix indicates the instrument is different from those described in this manual. The manual for this newer instrument is accompanied by a yellow "Manual Changes" supplement. This supplement contains updating information that explains how to change the manual to be applicable to newer instruments.
- 1-13. In addition to the new serial number prefix change information, the supplement may contain information for correcting errors in the manual (errata). To keep this manual as current and as accurate as possible, Hewlett-Packard recommends that you periodically request the latest "Manual Changes" supplement. The supplement for this manual is identified with the manual print date and part number, both of which appear on the manual title page. Complementary copies of the supplement are available.

1-14. Safety Considerations

1-15. The **HP5501B** Laser Head is designed to receive its power from a Safety Class 1 product. It is designed and tested in accordance with international safety standard IEC* 348. It is also a Class 1/ Laser product certified as conforming to U. S. National Center for Devices and Radiological Health Regulations 21 CFR ** 1040.10 and 1040.11. The instrument and the manual should be inspected and reviewed for safety markings and instructions before operation. A safety summary is included on the page following the title page.

1-16. Equipment Supplied

1-17. The **HP5501B** Laser Head is supplied with a test polarizer and two 4-pin connectors for use in fabricating the power and reference cables. The HP Part Numbers for the three items are:

Test Polarizer	1000-0616
Reference Signal Connector (P1)	1251-3450
Power Connector (P2)	1251-3447

1-18. Available Accessories

1-19. The HP 10778B and HP 10779B cables may be ordered from Hewlett-Packard. Figures <u>2-1</u> and 2-2 show photos of the cables, identify the connector markings, and give the pin numbers and corresponding wire color codes.

*IEC, International Electrotechnical Commission

**CFR, Code of Federal Regulations (U.S.A.)

1-20. Specifications

1-21. Table 1-1 lists the specifications and performance characteristics for the HP5501B Laser Head.

Table 1-1. HP5501B Laser Head Specifications and Performance Characteristics

Description:	The HP5501B Laser Head contains an automatically tuned Helium-Neon laser, circuits to control the laser, and a reference optical receiver. The laser generates a coherent, collimated, two frequency beam of light. This is a Class II Laser Product conforming to U.S. National Center for Devices and Radiological Health Regulations 21 CFR 1040.10 and 1040.11.
Environmental Conditions:	
Temperature (Operating):	0 to 40°C (32 to 104°F)
Temperature (Non Operating):	Can be stored or shipped in environments within the range of - $40 \text{ to } +75^{\circ}\text{C}.$

NOTE

This unit should also be protected from temperature extremes that could cause condensation within the instrument.

Relative Humidity (Operating):	0 to 95% Non-condensing
Vacuum Wavelength (Nominal):	632.991372 nanometers
Vacuum Wavelength Accuracy:	1 X 10-7
Vacuum Wavelength Stability:	2 X 10-8, typical
Beam Diameter:	6 mm typical
Maximum Beam Power Output:	1 milliwatt
Minimum Beam Power Output:	120 microwatts
Warm-Up Time:	less than 10 minutes
Power Requirements:	The HP5501B requires the following power inputs:
	+15 Volts \pm 0.3 Volts at 0.8 Amperes maximum
	-15 Volts \pm 0.3 Volts at 0.7 Amperes maximum

NOTE

Internal laser head 1.5 amp fuses permit power distribution to other laser equipment.

Safety Features:	Front shutter to block Laser Beam.
	A safety switch disables high voltage when cover is removed.
Outputs:	
Reference signal:	Differential square wave at approximately 1.8 MHz. Levels
-	compatible with all Laser Transducer System inputs.
Enclosure:	NEMA Type 12
Dimensions:	32.5 X 13.2 X 12.7 cm
Weight::	3.4 Kg (7.5 lbs)
•	

1-22. Recommended Test Equipment

1-23. The equipment required to maintain the **HP5501B** Laser Head is listed in Table 1-2. Other equipment may be substituted if it meets or exceeds the critical specifications listed in the table.

INSTRUMENT	USE*	CRITICAL SPECIFICATIONS	RECOMMENDED EQUIPMENT (Equipment Having Equivalent Characteristics May Be Substituted)
Signature Multimeter	Т	Detect TTL level signals	HP 5005A/B
Oscilloscope	Т	100 MHz Bandwidth	HP 1740A (if available)
Laser Power Meter	Т	Range: 1 microwatt to 1 milliwatt Accuracy: ±10%	United Detector Technology Model 351L
Clip-on Milliammeter	T,A	10 ma range accuracy ±0.1 ma	HP 428B
Logic Pulser	Т	TTL level	HP 546A
Current Tracer	Т	Sensitivity: 1 ma to 1 amp	HP 547A
Logic Clip	Т	TTL Compatible 16-pin IC. mounting	HP 548A
Logic Probe	Т	TTL/CMOS Capability with Pulse	HP 545A
Digital Voltmeter	т	DC Volts: Floating Inputs Input Resistance: >10 MΩ Range: 1, 10, 20 Volts DC Accuracy: 0.1%	HP 3435A
*P = Performance	e Test; (C = Calibration; A = Adjustments; T = Performance Test	Troubleshooting; S = Shortened

Table 1-2. Recommended Test Equipment

1-24. Warranty

1-25. The warranty statement for the instrument including the laser tube is located on the inside cover of this manual.

2 INSTALLATION

2-1. Introduction

2-2. This section provides installation instructions for the **HP5501B** Laser Head including unpacking, inspection and reshipment, installation, operating environment, and storage. Installation includes information on grounding considerations, power supply requirements, power dissipation, fusing, dimensions, and mounting and fixturing.

2-3. Unpacking, Inspection, and Reshipment

2-4. The following paragraphs contain information for unpacking and inspection, warranty claims, laser tube shipment, tagging for service, and packaging for reshipment.



TO AVOID HAZARDOUS ELECTRIC SHOCK, DO NOT PERFORM ELECTRI-CAL TESTS WHEN THERE ARE SIGNS OF SHIPPING DAMAGE TO ANY PORTION OF THE OUTER ENCLOSURE (COVERS, PANELS, CONNECTORS, LEOS, ETC.).

2-5. Unpacking and Inspection

2-6. Inspect the shipping container for damage. If the shipping container or cushioning material is damaged, it should be kept until the contents of the shipment have been checked for completeness and the instrument has been checked mechanically and electrically. Procedures for checking electrical performance are given in <u>Section 4</u>. If the contents are incomplete, if there is mechanical damage or defect, or if the instrument or some component fails the performance tests, notify the nearest Hewlett-Packard office. If the shipping container is damaged, or the cushioning material shows signs of stress, notify the carrier as well as the Hewlett-Packard office. Keep the shipping materials for the carrier's inspection. The HP office will arrange for repair or replacement at HP's option without waiting for a claim settlement.

2-7. Warranty Claims

2-8. Contact the nearest HP Sales and Support Office (see list at the end of this manual) for information relative to warranty claims.

2-9. Laser Tube Shipment

NOTE

The laser tube assembly MUST be shipped in an approved HP container.

2-10. The laser tube assembly (HP Part Number 05501-60102) should only be shipped in an HP container designed for that purpose. In addition, the container must indicate that the laser tube contains magnetic material. If it is necessary to ship a laser tube, contact your nearest HP Sales and Support Office for an approved container.

2-11. Tagging for Service

2-12. If the instrument is being returned to Hewlett-Packard for service, please complete one of the blue repair tags (HP Part Number 9320-3896) located at the end of this manual and attaches it to the instrument.

2-13. Packaging for Reshipment

- 1. Original Packaging
 - a. The same containers and materials used in factory packaging can be obtained through Hewlett-Packard Sales and Support Offices listed at the rear of this manual.
 - b. In any correspondence refer to the equipment by model number.

2. Other Packaging Methods

- a. If it becomes necessary to reship equipment, good commercial packing should be used.
- b. Contract packaging companies can provide dependable custom packaging on short notice. The following general instructions should be followed when repackaging with commercially available materials.
- c. If shipping to a Hewlett-Packard Support Office or Center, attach a blue tag indicating the type of service required, return address, and model number.
- d. Wrap the equipment in heavy paper or plastic.
- e. Use a strong shipping container. A double-wall carton made of 350 pound test material is adequate.
- f. Use enough shock-absorbing material (three to four inch layer) around all sides of the equipment to provide a firm cushion and prevent movement inside the container.
- g. Seal the shipping container securely.
- h. Mark the shipping container FRAGILE to assure careful handling.

2-14. Installation

2-15. The following paragraphs provide installation information for the **HP5501B** Laser Head including system cabling, grounding considerations, power supply requirements, power dissipation, fusing, and mounting and fixturing.

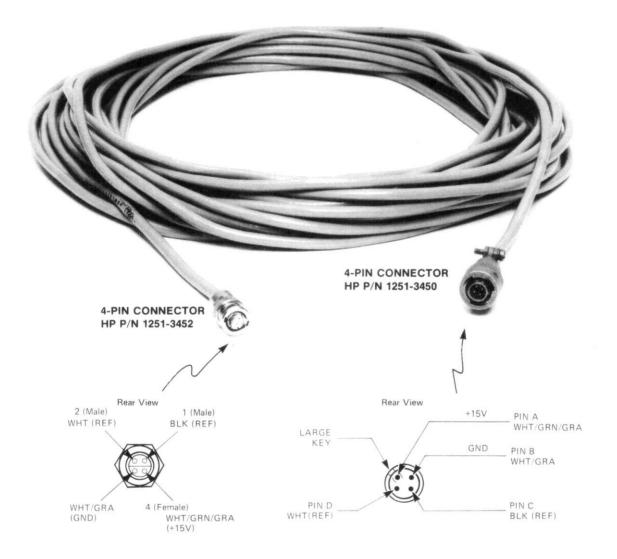
2-16. System Cabling

- 2-17. The **HP5501B** Laser Head is designed for use with the **HP5501A** Laser Transducer System and is a direct replacement for the **HP5501A** Laser Head. The **HP10778B** Power and **HP10779B** Reference cables (Figures 2-1 and 2-2 respectively), are available for connecting the laser head to the laser transducer system.
- 2-18. The HP10778B and HP10779B cables are both 10 Meters (32.8 ft) in length.



10778B LENGTH 10 METRES (32.8 FT)

Figure 2-1. HP 10778B Power Cable



10779B LENGTH 10 METRES (32.8 FT)

Figure 2-2. HP 10779B Reference Cable

2-19. Power and Signal Connections

2-20. The laser head rear panel contains two multi-pin connectors used for connecting **HP5501B** power and signal lines to other laser transducer system components. (Refer to Figure 2-3 for an interconnection diagram of a typical system.) Table 2-2 lists all power and signal lines that are available at the rear-panel connectors. The laser transducer system manual gives additional system wiring information.

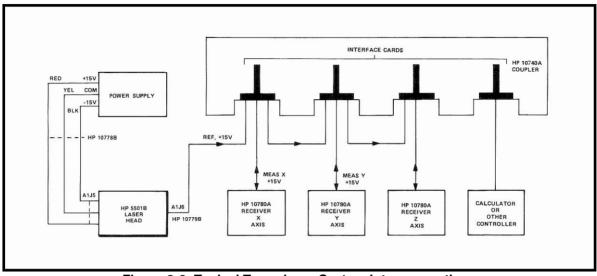


Figure 2-3. Typical Transducer System Interconnections

2-21. Cable Fabrication

2-22. Power and signal interconnecting cables of suitable length may be fabricated using the two plugs included with the laser head. Figures 2-4 and 2-5 illustrate the physical details of the two plugs supplied and give part numbers for both the plugs and the recommended cables. Refer to Table 2-1 for rear-panel connector pin numbers of all available power and signal lines.

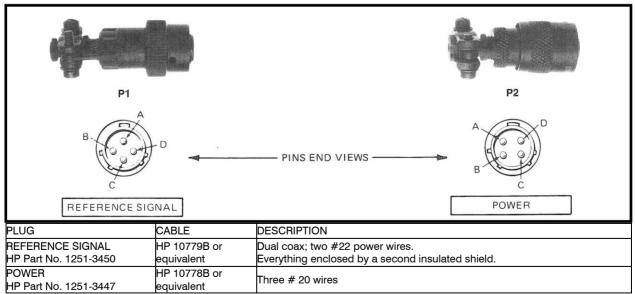


Figure 2-4. Interconnecting Plug Details

Input	Output	Signal Name	Function	Source	Destination
	A1J6-A	Fused +15V	Accessory +15V Operating Power		Accessory Equipment
	A1J6-B	Fused +15V RET	Accessory +15V Return		Accessory Equipment
	A1J6-C	REF	System REFerence signal, equal to the difference in frequency between		Accessory Equipment
	A1J6-D	-REF	laser beam components F1 and F2.		
A1J5-A		+15V	External +15V Power Input	Ext. Pwr. Sup.	
A1J5-B		-15V	External -15V Power Input	Ext. Pwr. Sup	
	A1J5-C	+5V	+5V power test point		Accessory Equipment (test use only)
A1J5-D		GND	Power Ground	Ext. Pwr. Sup	

Table 2-1. Laser Head System Signal Chart

REF AND -REF OUTPUTS ARE CAPABLE OF DRIVING ONLY ONE UNIT

CAUTION NOTE

THE RUBBER COLLAR WHICH GOES OVER THE CABLES IS A VERY TIGHT FIT. USE SILICON GREASE TO FACILITATE INSTAILATION ON CABLE.

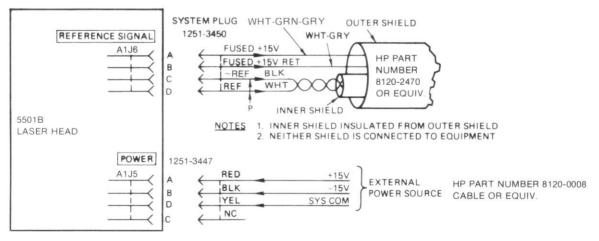


Figure 2-5. HP 5501B Laser Head Interconnect Wire Fabrication



Observe the current and grounding requirements described below.

2-23. Grounding Considerations

2-24. In order to avoid ground loops, the laser head base should be the only connection to earth ground. To accomplish this, the outputs of the ±15 Volt power supplies used to power the laser head should be floating. The +5 Volt power supply output required for either the **HP10740A** based electronics or **HP10781A** Pulse Converters, should also be floating. Alternatively, any other single point earth ground connection can be used to satisfy grounding requirements.

2-25. Power Supply Requirements

2-26. Table 2-2 lists the supply voltages, currents, and tolerances required by the **HP5501B** Laser Head. Note that other components of the system also use ±15 Volts. Add these to the laser head current requirements to obtain the overall system requirements.

Supply Voltage	Tolerance	Current Requirement				
+15 Volts	±0.3 Volts	0.8 Amperes				
		3.5 Amperes peak surge for approximately 2 milliseconds at power-up				
-15 Volts	±0.3 Volts	0.7 Amperes				
Other Power Supply Requirements						
Line I	Regulation	0.01%				
Load	Regulation	0.01%				
Ripple + Noise		60 millivolts peak-to-peak				
Isolat	ed Output					
Over	Voltage Protection					
(Reco	ommended)					
Unde	r Voltage Protection					
(curre	ent limited)					
(Reco	ommended)					

Table 2-2. HP 5501B Power Supply Requirements

2-27. Power Dissipation

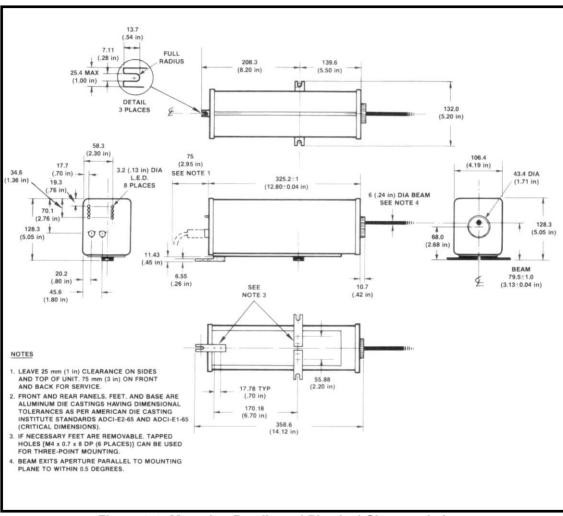
2-28. The **HP5501B** dissipates approximately 21 watts during operation.

2-29. Fusing

2-30. The **HP5501B** has two internal 1.5 Ampere fuses to protect the ±15V lines. Both fuses are located on the A1 Connector Board and are accessible by removing the left and right covers of the laser head.

2-31. Dimensions

2-32. Figure 2-6 shows the HP5501B Laser Head dimensions.



DIMENSIONS IN MILLIMETERS

Figure 2-6. Mounting Details and Physical Characteristics

2-33. Mounting and Fixturing

- 2-34. Heat Flow Considerations. The laser tuning technique of the **HP5501B** requires efficient heat exchange with the ambient. Heat flow is primarily through the base of the laser head assembly to the surrounding environment. An external heat sink is not required but free air circulation around the laser head will ensure good performance.
- 2-35. In cases where vertical mounting of the **HP5501B** is desired, care should be taken to minimize laser beam disturbances due to air turbulence caused by the **HP5501B** heat exchange. It is most important to prevent differential effects which can occur due to turbulence in the beam path between a polarizing beam splitter and a retroreflector or plane mirror. Differential turbulence causes fluctuations in the optical path length difference that is being measured. Both differential and common mode turbulence can cause fluctuations in alignment by bending the light beam. Common mode turbulence is turbulence that is present in the beam path between the **HP5501B** and a polarizing beam splitter. In either case some amount of noise can be present in the interferometer measurement due to turbulence.
- 2-36. If interferometer components (optics) are mounted very close to the **HP5501B** such that the operating temperature of the optics are affected, it is recommended that alignment and operation of the interferometer be performed after the **HP5501B** has been running for a sufficient period of time to allow thermal equilibrium to be established. In well ventilated installations, one hour of running time should be sufficient. When enclosures are used and the ambient temperature is changed by several degrees (centigrade) by the **HP5501B**, thermal equilibrium is not established as quickly and the laser should be run for a longer period of time.
- 2-37. Mounting. Mount the laser head by means of the three slotted tabs that extend outward from the bottom edges of the unit (refer to Figure 2-1 for exact locations and dimensions). The mounting tabs may be secured to the work surface in any fashion that will not transmit stresses to the main enclosure and, consequently, to the laser tube or printed-circuit assemblies. If necessary, the tabs can be removed and the unit mounted on a flat surface with 4 mm machine screws; use the same tapped holes that are used to secure the tabs, ensuring that the mounting method does not stress the base casting and that the screws do not penetrate the base casting more than 7 mm.
- 2-38. Beam Alignment. Rotate the turret at the front of the laser head so that the beam exits through the large aperture. DO NOT STARE DIRECTLY INTO THE BEAM APERTURE. Presence of the red laser beam can be verified by placing a piece of paper in the beam path and observing the beam reflection on the paper. The components of the laser transducer system must now be aligned so that the laser beam strikes the photodetector of the receiver (**HP10780A**). Refer to the **HP10780A** Receiver documentation and the Laser Transducer System Manual for further alignment information.
- 2-39. Pointing Stability. The angle at which the laser beam exits the **HP5501B** can change from turnon through the time when the **HP5501B** and its surroundings reach thermal equilibrium.
- 2-40. The **HP5501B** should not be exposed to ambient temperature changes greater than ±5 Centigrade during operation to keep pointing stability variations to a minimum during interferometer measurements.

3 OPERATION

3-1. Introduction

- 3-2. This section provides operating information for the **HP5501B** Laser Head. Included are operation features of the instrument's front and rear panel controls and connectors. Also provided is supplemental operating information for **HP5501A** Laser Transducer Systems equipped with **HP5501B** Laser Heads.
- 3-3. Installation instructions for the **HP5501B** Laser Head are given in <u>Section 2</u> of this manual.

3-4. Power Application

3-5. The laser head installed is activated when +15 Vdc and -15 Vdc are applied to the unit. ±15 Volts is applied by connecting the power cable (**HP10778B** or fabricated equivalent) to the rear panel POWER connector (A1J5). Ensure that the power source is adjusted to conform to the following requirements before connecting it to the **HP5501B**:

Measured Voltage $+15V\pm0.3$ Vdc $-15V\pm0.3$ Vdc NOTE

REPETITIVE POWER-UP CYCLING SHOULD BE AVOIDED. THIS WILL REDUCE THE EXPECTED LIFE OF THE HIGH VOLTAGE COMPONENTS.

3-6. HP5501B Laser Head Front Panel Controls

3-7. Figure 3-1 identifies and describes each of the operating controls, connectors, and indicators. Refer to Table 2-1 for information regarding the specific power and signal/lines at each of the connectors.



Figure 3-1. HP5501B Front Panel Controls

1. Shutter: The shutter, also known as the aperture ring, allows for three aperture settings: open, reduced, and closed. The open aperture position is used during normal operation and the reduced aperture is used during alignment of measurement axes.

3-8. HP5501B LASER HEAD REAR PANEL INDICATORS AND CONNECTORS NOTE

A TILDE ("~") PRECEDING A SIGNAL NAME INDICATES NEGATIVE-TRUE LOGIC LEVELS.

3-9. Following are descriptions of the **HP5501B** rear panel features shown in Figure 3-2.

		2 3 -15V 3 +15V 3 -15V 3 -15V 3 REFERE	NATALLATION DATE: MADE IN UISA SUPPLY UNBALANCE FUSE FUSE C READY O LASER ON ENCE
		SIGN	AL POWER COMPLIES WITH 21CFR 1040.10 AND 1040.11 COMPLIES WITH 21CFR 1040.10 AND 1040.11 COMPLIES WITH 21CFR 1040.10 AND 1040.11
2.	+15V SUPPLY UNBALANCE	RED LED	LED lights if the $\pm 15V$ input voltages are unbalanced in the positive direction by one Volt or more. For example: When the positive supply measures ± 16 Volts (or
			more positive) and the negative supply remains at - 15 Volts.
			When the positive supply measures +15 Volts and the negative supply is -14 Volts (or less negative).
3.	-15V SUPPLY UNBALANCE	RED LED	LED lights if the $\pm 15V$ input voltages are unbalanced in the negative direction by one Volt or more. For example: When the negative supply measures -16 Volts (or more negative) and the positive supply remains at
			+15 Volts.
			When the negative supply measures -15 Volts and the positive supply is $+14$ Volts (or less positive).
			Both $\pm 15V$ SUPPLY UNBALANCE LED's light if the TEST-NORM switch (A1S2) is in NORM position with cover off or in TEST with cover on.

Figure 3-2. HP5501B Rear Panel Connectors and Indicators



4.	+15V FUSE OPEN	RED LED	LED lights if +15 Vdc fuse opens.
5.	-15V FUSE OPEN	RED LED	LED lights if -15 Vdc fuse opens.
6.	+15V POWER ON	GREEN LED	LED lights when +15 Vdc power is applied to the HP5501B .
7.	-15V POWER ON	GREEN LED	LED lights when -15 Vdc power is applied to the HP5501B .
8.	READY	GREEN LED	LED remains off while heating rod to normal operating temperature. At this point the READY LED begins to flash and continues to do so until the laser head reaches operating temperature. When the laser head is ready for use, the READY LED stays on steady (i.e., Laser has achieved lock and is now generating a stable reference signal).
9.	LASER ON	AMBER LED	LED lights to indicate that the high voltage power supply (HVPS) is on and that laser light is being emitted.
10.	POWER	CONNECTOR (A1J5)	Provides connection point for external power supply input (i.e., 10778B Power Cable connector).
11.	REFERENCE	CONNECTOR (A1J6)	Allows the reference signals (REF and -REF), and +15 power to be connected to other system components (i.e., 10779B Reference Cable connector).
	Figure 3-2 HP5501	B Rear Panel C	onnectors and Indicators (Continued)

Figure 3-2. HP5501B Rear Panel Connectors and Indicators (Continued)

3-10. OPERATING MODES

3-11. When power is applied to the **HP5501B**, an internal state machine resets the laser head to a warmup mode. This mode is used to establish the initial operating temperature of a glass rod that controls the laser cavity length. When this temperature is reached, the state machine switches to an optical tuning mode. Upon successfully switching from warmup to optical mode, the laser head enables the REFerence signal and lights a READY LED indicator on the rear panel to indicate that the laser head is ready for use. The following table will give the proper operating sequence for the **HP5501B** rear panel Led's from initial power-up (warmup mode) to when the laser is ready to use (optical mode).

		OPERATING MODES*							
		WARMUP				OPTICAL			
LED's		PREHEAT		HEATER QUALIFIED		LOCKING		LOCKED	
		←3-6 N	∕lin**→	\leftarrow 100 sec \rightarrow		\leftarrow 50 sec \rightarrow		Continuous use	
+15V SUI UNBALAN (Red LED)	ICE	OFF		OFF		OFF		OFF	
-15V SUP UNBALAN (Red LED)	ICE	OFF		OFF		OFF		OFF	
+15V FUSE OP (Red LED)		OFF		OFF		OFF		OFF	
-15V FUSE OPEN (Red LED)		OFF		OFF		OFF		OFF	
+15V POWER ON (Green LED)		ON		ON		ON		ON	
-15V POWER C (Green LE		ON		ON		ON		ON	
READY (Green LE	ED)	OFF		Flashing 2Hz		Flashing 2Hz		ON	
LASER ON OFF (Amber LED)		FF	OFF		ON		ON		
	↑ ↑ 15V Applied Glass ro to Laser reaches Head. Heater temper Full On (begin second stabiliza period		s ature 100	HVPS on re Laser I) on		signal			

*Time intervals reflect that laser tube was cold at turn-on; shorter times can be expected if tube is warm at turn-on.

**Refer to paragraph 8-100 for further explanation of laser operating modes.

3-12. Warmup Time Operating Notes

- Allow a full 10 minute warmup period for the **HP5501B**.
- Warmup completion is indicated by the READY LED on the HP5501B rear panel.
- If warmup is not complete after 10 minutes, a failure may be indicated.
- If the READY indication at the laser head is not convenient to use because of the mounting scheme, try the alternate monitoring suggestions that follow.

3-13. HP 10740A Coupler Based Systems - Manual Monitoring

- The REFerence and MEASurement signals terminate at either the **HP10760A** Counter Card or the **HP10764A/B/C** Fast Pulse Converter Card.
- Each of these cards includes an LED to monitor the presence of the REFerence and MEASurement signals.
- The REFERENCE LED will be extinguished until the HP5501B is ready for use.

HOWEVER, FOR SYSTEMS WITH MULTIPLE HP 10760A CARDS

- Every ODD HP10760A that uses the replicated REF and -REF will have their REFERENCE LED lit during the laser head warmup period. (This is due to inversion in the replication circuitry.) Note that this does not apply to multiple HP10764A/B/C card installations.
- The MEASUREMENT LED will momentarily light several times during the laser head warmup period provided that the HP10780A Receiver is aligned properly with the beam. (This occurs because the laser periodically produces functional optical frequencies during warmup.)

NOTE

The above monitoring scheme assumes no reversal of the REF and -REF lines in the cabling.

3-14. Systems with HP10745A or HP10746A Cards - Automatic Monitoring

3-15. Systems with these cards can use the system computer and software to monitor the laser head warmup. Before describing the software, it will be helpful to examine some background information on the **HP10740A** Coupler, **HP10745A** HP-IB Interface, and **HP10746A** Binary Interface.

3-16. HP10740A Coupler - Error Signal Information

- Four error signal lines are provided on the HP 10740A Backplane:
 - REFERENCE ERROR BIT
 - MEASUREMENT ERROR BIT
 - V.O.L. ERROR BIT
 - OVFL BIT

3-17. HP10746A Error Signal Processing

- If any of the **HP10740A** backplane error bits are true, the four most significant bits of the most significant word in a data transfer from the **HP10746A** to the host computer will be all ones. These four bits are normally the decimal point bits.
- Errors are not the only condition that can set these bits to all ones. When the difference output of an addressed **HP10762A** is within tolerance, these bits will also be set.
- After detecting all ones, the host computer must check the next four MSB's to differentiate between an error condition and the within tolerance condition.
- If the tolerance condition is true, these next four bits will also be all ones. Otherwise, each of these bits corresponds to one of the backplane error bits.

3-18. HP 10745A Background Information

• When a backplane error bit is true, the **HP10745A** asserts SRQ. The STATUS BYTE of the **HP10745A** can be read to determine the source of SRQ. In the STATUS BYTE, bit 0 corresponds to the REFERENCE ERROR-BIT.

3-19. Program Modifications

- 3-20. To monitor warmup time, the following program modifications can be added to the example programs contained in Tables 4-12 and 4-13 of the **HP5501A** Laser Transducer Operating and Service Manual, HP Part Number 05501-90028. If desired, some form of time-out algorithm can be added to check if the **HP5501B** warms up within 10 minutes.
- 3-21. Table 3-1 shows the program steps used to modify Table 4-12 in the **HP5501A** System Manual. The program uses the **HP10760A** x-axis card to monitor the laser warmup.
- 3-22. Table 3-2 shows the program steps used to modify Table 4-13 in the System Manual. The program is for a two axis system with the **HP10746A** in 16-bit mode and using positive-true logic. The program uses the x-axis card to monitor the laser warmup.
- 3-23. Tables 3-3, 3-4, and 3-5 are complete listings of the modified versions of Tables 4-12 and 4-13 found in the **HP5501A** System Manual.

Table 3-1. Program Modifications for Table 4-12 in the HP5501A System Manual

0: gsb "warmup"	Branch to subroutine to monitor laser
38: "warmup":clr 7; rem 7	status Send Device Clear: Send Remote Enable
39: wrt 709,"000x"	Send 10740A Backplane reset preset x- axis counter and select normal resolution
40: wrt 709,"1x2x30"	Transfer x-axis counter (10760A), contents including error bits to 10745A
41: if rds(7)<128; ret	If SRQ false ~REFERENCE ERROR BIT must be false laser ready
42: rds(709)→B	Read 10745A STATUS BYTE to verify that it is asserting SRQ
43: if B<64;gto "bus error"	If 10745A not asserting SRQ; alert operator.
44: B-112→B	
45: if B>=8;B-8→B	Isolate ~REFERENCE ERROR BIT
46: if 8>=4;B-4→B	
47: if B>=2;B-2→B	
48: if B=1;dsp "LASER NOT READY"	If true; 5517A not READY
49: if B=1;gto -11	Try again
50: gsb "check"	Otherwise, use subroutine "check" to identify remaining error
51: ret	Return to step one if only ~OVF ERROR true
52: "bus error":	Alert operator that another device asserted SRQ
53: prt "SRQ ASSERTED BUT 10745A STATUS BYTE,BIT6 CLEAR"	·
54: stp	
55: gto 0	Return to step 0 if CONTINUE pressed
56: end	

Table 3-2. Program Modifications for Table 4-13 in the HP5501A System Manual

0: gsb "warmup"	Branch to warmup subroutine monitor laser status
66: "warmup":wtb 2,0,0,0	System reset 10746A in 16 bit mode
67: wtb 2,1,130, 3	1 = simultaneous sample 130 = transfer X Comparator Counter contents to 10746A 3 = prepare for output to host computer
68: rdb(2) →B;if B<0;65536+B→B	Read first word
69: if B<61440; ret	If 4 MSB's are clear, 5517A is READY
70: int(B/256)240→B;15-B→B	Otherwise isolate ~REFERENCE ERROR BIT
71: if B>=8;B8→B	
72: if B>=4;B4→B	
73: if B>=2;dsp "LASER NOT READY"	
74: if B>=2;sto -8	If ~REFERENCE ERROR BIT true, try again
75: wtb 2,1,130, 3	Abort transfer and setup new transfer in order to read first word again.
76: rdb(2) →B;if B<0;65536+B→B	Use subroutine "er" to identify remaining error
77: gsb "er"	
78: ret	Return to program step 1 only if ~OVL ERROR BIT is true
79: end	

Table 3-3. Modified HP10745A HP-IB Interface Program

```
0: gsb "warmup"
1: wrt 709,"006x"
2: wrt 709,"2v30"
 3: red 709,C
 4: 0→E
 5: "loop": E+1→E; if E=10;gto -3
 6: wrt709,"102x30"
 7: red 709,X
     if rds(7)<128;gto +2
 8:
     0→A; gsb "status"
(X-16)*6.23023e-6*C→X
 9:
10:
     fmt 1,f12.6
11:
12: dsp X
13: gto "loop"
14: "status":rds(709)→B
15: if B>=64;gsb "check"
16: wrt 709,"0P"
17: ret
18: "check": B-112→B
19: if B \ge 8; gsb "ovf"

20: if B \ge 4; prt "VOL OUT OF RANGE"; B - 4 \rightarrow B; 0 \rightarrow D

21: if B \ge 2; prt "MEAS ERROR"; B - 2 \rightarrow B; 0 \rightarrow D
22: if B=1; prt "REF ERROR";0→D
23: if D=2; ret
24: if A=0; prt "X-AXIS ERROR"
25: if A=1; prt "Y-AXIS ERROR"
26: dsp "GO TO GAGE"; stp
27: gto 0
28: "ovf":B-8→B; 1→D
29: if A=0;X-2^28/10→X
30: if A=1;Y-2^28→Y
31: ret
32: "warmup": clr 7; rem 7
33: wrt 709,"000x"
34: wrt 709, "1x2x30"
35: if rds(7)<128;ret
36: rds(709)→B
      if B<64;gto "bus error"
37:
38: B-112→B
39: if B>=8;B-8→B
40: if B>=4;B-4→B
41: if B>=2;B-2→B
42: if B=1;dsp "LASER NOT READY"
43: if B=1;gto -11
44: gsb "check"
45: ret
46: "bus error":
47:
      prt "SRQ ASSERTED BUT 10745A STATUS BYTE, BIT6 CLEAR"
48:
     stp
49: gto 0
50: end
```

Table 3-4 Modified HP10746A Binary Interface Program

```
0: gsb "warmup"
1: wtb 2,0,0,0,98,3
2: gsb "in"
3: B→C
4: ent "X TOLERANCE IN MICRONS?", r1
5: ent "Y TOLERANCE IN MICRONS?", r2
6: "newdest":0→X;ent "X DESTINATION IN MM?",X
7: 0→Y;ent "Y DESTINATION IN MM?",Y
8: "comp":wtb 2,98,3
9: gsb "in"
10: B→C
11: X→A;gsb "cnv"
12: A→X
13: Y→Ajgsb "cnv"
14: A→Y
15: int(r1/1.58248e-1)*2^228+X→A
16: gsb "out"
17: wtb 2,131
18: int(r2/1.528248e-1)*2^228+Y→A
19: gsb "out"
20: wtb 2,147
21: "newsample":wtb 2,1,130,3
22: 0→F
23: gsb "in"
24: B→r3
25: wtb 2→146,3
26: I→F
27: gsb "in"
28: B→r4
29: fmt 1,2fI0.0,fI0.7
30: wrt .1,r3-160,r4-160,C
31: if abs(X-r3) \ll r1/1(.158*C) and abs(Y-r4) \ll r2/1(.158*C); gto "newdest"
32: gto "newsample"
33: "in":rdb(2)→B if B(0;65536+B→B
34: if B>=61440;gto "er"
35: rdb(2)→G;if G(0;65536+G→G
36: int(B/14096) →D
37: B-4096*D→B
38: (65536*B+G)*tn^(2-D)→B;ret
39: "cnv":A/1(1.58248e-4*C)+160→A;ret
40: "out":wtb 2,4
41: int(A/165536)→B;if B>32767;B-65536→B
42: wtb 2,B
43: A-65536*intCR/165536)→B;if B>32767;B-65536→B
44: wtb 2,B
45: ret
46: "er":int(B/1256)-240→B; 15-B→B
47: if B>=8;prt "vol error";B-8→B;O→D
48: if B>=4;B-4)B;1→D
49: if B>=2;prt "ref error";0→D
50: if B=I;prt "meas error";0→D
51: if D:0;gto "prterr"
52: rdb(2) →B
53: wtb 2,240,3
54: rdb(2)→B; if B<0;65536+B→B
55: rdb(2)→G;if G<0;65536+G→G
56: int(B/4096)→D
57: B-4096*D→B
58: (65536*B+G)*tn^(2-D)→B
59: if F=0 and B-160#0;B-2^28→B
60: if F=1 and B-160#0;B-2^28→B
61: ret
```

HP5501B Operation

- 62: "prterr": if F=0;prt "X-AXIS ERROR" 63: if F=1;prt "Y-AXIS ERROR" 64: dsp "GO TO GAGE";stp 65: gto 0 66: "warmup":wtb 2,0,0,0 67: wtb 2,1,130,3 68: rdb(2)→B;if B<0;65536+E→B 69: if B<61440;ret 70: int(B/256)-240→B;15-B→B 71: if B>=S;B-S→B 72: if B>=4;B-4→B 73: if B>=2;dsp "LASER NOT READY" 74: if B>=2;gto -S 75: wtb 2,1,130,3 76: rdb(2)→B; if B<0;65536+B→B 77: gsb "er" 78: ret
- 79: end

4 PERFORMANCE TESTS

4-1. Introduction

4-2. This section contains a performance test for the **HP5501B** Laser Head. A test record is included to record test results for future comparison.

4-3. RECOMMENDED TEST EQUIPMENT

4-4. Test equipment requirements are included in the following procedure. Detailed critical specifications for the required test equipment are contained in Table 1-2, Recommended Test Equipment. Any equipment that satisfies the critical specifications given in the table may be substituted for the recommended model(s).

4-5. TEST RECORD

4-6. Results of the performance test may be tabulated on the test record at the end of these procedures.

4-7. HP5501B PERFORMANCE TEST

4-8. The **HP5501B** performance test consists of measuring the **HP5501B** input voltages and laser power output.

4-9. Input Voltage Check

4-10. Check the **HP5501B** voltages in the following manner:

Disconnect the POWER cable.

Measure the voltages at the disconnected cable plug as outlined in Table 4-1.

Plug Pin	Voltage
A1J5 (A)	+15 ±0.3 Vdc
A1J5 (B)	-15 ±0.3 Vdc

Table 4-1. Input Voltage

4-11. Laser Power Output Test

4-12. Test Equipment Required. The following test equipment is required to test the laser output power.

Laser Power Meter, United Detector Technology (Model No. 351L)

4-13. Procedure

a. Connect the **HP5501B** to the **HP5501A** system (or any suitable dual DC voltage power supply such as the **HP6255A**) using **HP10778B** Power Cable as shown in

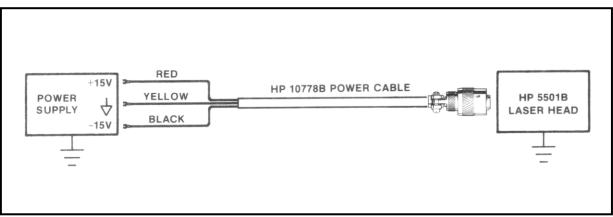


Figure 4-1. HP5501B Power Connection

- b. On the **HP5501B**, set the exit shutter of the turret assembly to its open aperture position.
- c. Turn the ± 15 Volt power supply on and wait until the READY indicator is on, not blinking. This should occur less than 10 minutes after power is applied.
- d. Using the Laser Power Meter, align the power meter detector for maximum reading.

NOTE

Laser beam must fall totally within the active region of the power meter's detector.

e. If the laser power output is less than 120 microwatts, perform the laser tube current adjustment procedure in <u>Section 5</u>.

5 ADJUSTMENTS

5-1. Introduction

5-2. This section describes adjustments and checks required to return the **HP5501B** Laser Head to peak operating capabilities when repairs have been made. Included in this section are the test equipment required, equipment setups, and procedures to perform the adjustments.

5-3. Safety Considerations

5-4. The following warnings contain information that must be understood for your safety.

WARNING

FROM 1.2 KILOVOLTS TO 12 KILOVOLTS DC IS PRESENT ON THE ANODE OF THE LASER TUBE IN THE HP5501B. EXERCISE EXTREME CAUTION WHEN WORKING INSIDE THE INSTRUMENT. THE HIGH VOLTAGE COULD CAUSE SERIOUS PERSONAL INJURY IF CONTACTED. THE FOLLOWING ADJUSTMENTS SHOULD BE PERFORMED BY SERVICETRAINED PERSONNEL.

NOTE

The High Voltage Power Supply, A2, is disconnected automatically by A1S1, when the HP5501B covers are removed. For Adjustments and Servicing purposes, the High Voltage Supply can be re-enabled by setting the TESTNORM switch, A1S2, to TEST after the HP5501B covers are removed.

WARNING

LASER RADIATION IS ACCESSIBLE WHEN THE HP5501B COVERS ARE REMOVED AND THE TEST-NORM SWITCH, A1S2, IS IN THE TEST POSITION.

5-5. Recommended test equipment

5-6. Test equipment required for each adjustment is included in the adjustment procedure. Detailed critical specifications for the required test equipment are contained in Table 1-2. Any equipment that satisfies the critical specifications given in the table may be substituted for the recommended model(s).

5-7. Factory Selected Components

5-8. As of the publication date on the title page of this manual there are no factory selected components.

5-9. Adjustment Procedures

5-10. The following paragraphs contain the adjustment procedures for the **HP5501B** Laser Head. A performance test is given in <u>Section 4</u>.

5-11. Reference Temperature Adjustments

- 5-12. This adjustment sets the laser preheat temperature to 105°C (221°F). The adjustment must be performed when the laser tube is at room temperature, 21 to 25°C (69.8 to 77.0°F).
- 5-13. Test Equipment Required. The reference temperature adjustment requires the following test equipment: Digital Voltmeter, HP Model 3435A

5-14. Preliminary Procedure

5-15. This adjustment must be made with the laser tube at room temperature. If the laser High Voltage Power Supply (A2) or heater has been on, allow at least two hours with ±15 Volts off before performing this procedure. Regardless of whether power is on or off, observe the safety precautions in paragraph 5-4 and proceed as follows:

Remove the HP5501B Laser Head covers by following the procedure outlined in paragraph 8-55.

a. Check that the TEST-NORM switch (A1S2) located on the A1 Connector Board is set to NORM. See Figure 5-1.

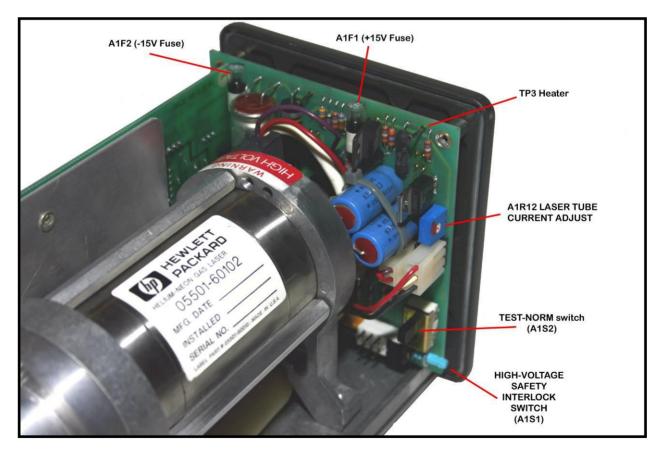


Figure 5-1. A1 Connector Board, TEST-NORM Switch and Adjustment Locations

- b. On A3, change the HEATER jumper from NRM to OFF. See Figure 5-2.
- c. Apply power to the Digital Voltmeter and set its controls to the 1 Volt DC range. Connect the positive lead of the Digital Voltmeter to A3TP11 then connect the negative lead to A3TP1. See Figure 5-2.
- d. If **HP5501B** power has been disconnected for least 2 hours, reconnect ± 15 Volts system power supplies and continue with the adjustment procedure in Paragraph 5-16.
- 5-16. Procedure to adjust the reference temperature, proceed as follows:
 - a. Check that the Voltmeter reads between +0.22V and +0.31V. This voltage is V(A3TP11).
 - b. Record value of V(A3TP11) measured in step 5-16(a).
 - c. Calculate the heater adjust set point using the following equation:
 - d. Vset = 1.285 x V(A3TP11)
 - e. Connect Digital Voltmeter plus lead to A3TP15. Connect the minus lead to A3TP1. See Figure 5-2.
 - f. Check that the voltage at A3TP15 equals Vset ± 1 millivolt as calculated in step b. If not, adjust A3R16 SET TEMP (see Figure 5-2).
 - g. Note and record the SET TEMP voltage in the "ADJUSTMENT RECORD" table located at the end of this section.
 - h. Disconnect ±15 Volts from **HP5501B** Laser Head.
 - i. On A3, change the HEATER jumper back to NRM (left-most position). Remove the test equipment leads, and reinstall the laser head covers.

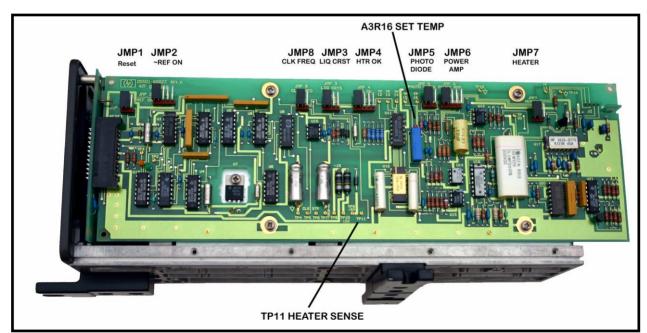


Figure 5-2. A3 Controller/Ref Board, Jumpers, Test Points, and Adjustment Locations

5-17. Laser Tube Current Adjustment

NOTE

A TILDE ("~") PRECEDING A SIGNAL NAME INDICATES NEGATIVE-TRUE LOGIC LEVELS.

5-18. This procedure adjusts the laser tube current to 3.5 milliamperes \pm 0.1 milliampere.

Test Equipment Required. The laser current adjustment requires the following test equipment:

Clip-On DC Milliammeter, HP Model 428B

- 5-19. Procedure to adjust the laser tube current, observe the safety precautions in Paragraph 5-4 and proceed as follows:
 - a. Turn the system power supplies OFF.
 - b. Remove the laser head covers by following the procedures outlined in paragraph 8-55.
 - c. On the A1 Connector Board, set TEST-NORM (A1S2) switch to TEST. See Figure 5-1.
 - d. Set indicated jumpers to the following positions:
 - 1. JMP2 (~REF ON)LO
 - 2. JMP4 (HTR OK)HI
 - 3. JMP7 (HEATER)OFF
 - 4. JMP8 (CLK FREQ)HI

NOTE

Setting the A3 jumpers causes the laser to come on soon after power is applied.

- e. Set the milliammeter to the 10 milliampere range.
- f. Clip the HP428B probe around the red (Anode) High Voltage Power Supply wire located underneath the laser tube (See Figure 5-3). The arrow on the milliammeter probe should point away from the supply. Keep the probe as far as possible from and perpendicular to the magnet assemblies. It may be necessary to prop up the probe to achieve the perpendicular orientation.
- g. On the milliammeter, adjust for zero indication. If zero indication cannot be obtained, degauss the probe as directed on the back of the milliammeter.

NOTE

After the zero setting has been made on the milliammeter, do not move the probe, this will affect the zero setting. h. Apply power to the system power supplies.

NOTE

READY LED will flash rapidly for about 5 seconds. LASER LED illuminates followed almost immediately by emission of laser light.

- i. Adjust A1R12 (Figure 5-1) for 3.5 milliamperes \pm 0.1 milliampere. If the current cannot be adjusted to this value, see Laser High Voltage Troubleshooting in <u>Section 8</u>. If the laser power output (as measured in paragraph 4-9) is not greater than 120 microwatts (at this current level), the laser assembly may require replacement.
- j. Record the laser tube current in the "ADJUSTMENT RECORD" located at the end of this section.
- k. Turn off the system power supplies, disconnect the probe, set the TEST-NORM switch to NORM, and reinstall the laser head covers.
- I. Return all A3 jumpers, moved in step 5-20(d), back to NRM position (left-most position).

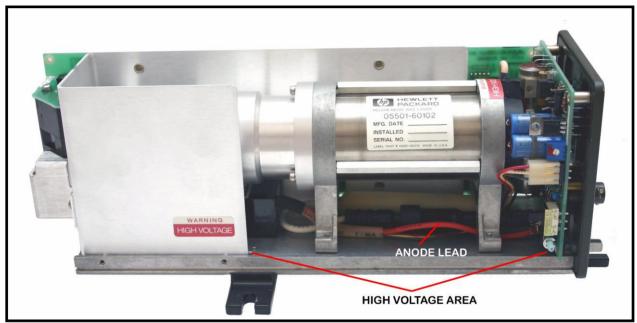


Figure 5-3. 55018 High Voltage Areas and Anode Lead

6 REPLACEABLE PARTS

6-1. Introduction

- 6-2. This section contains information for ordering replacement parts. Part numbers for replacement parts are provided in either illustrated parts breakdown or tabulated listings depending on the type of part. Purchase Order and Direct Mail Order information are provided in Paragraphs 6-9 through 6-13.
- 6-3. Table 6-1 is a list of exchange assemblies and Table 6-2 gives abbreviations and reference designators used in the parts lists and throughout the manual. Table 6-3 lists replaceable parts that are mounted on pc board assemblies. Table 6-4 contains the names and addresses that correspond to the manufacturer's code numbers given in Table 6-3. Figure 6-1 shows illustrated parts breakdowns showing the chassis mounted parts and assemblies for the **HP5501B**.

6-4. Exchange Assemblies

6-5. Table 6-1 lists assemblies within the **HP5501B** Laser Head that may be replaced on an exchange basis. Factory repaired and tested exchange assemblies are available on a trade-in basis; therefore the defective assemblies must be returned for credit. For this reason, assemblies required for on-site spare parts stock must be ordered by the "New Assembly" part number.

Assembly	HP Part No.	New Assembly HP Part No.	Exchange Assembly HP Part No.
Laser Assembly	05501-60102	05501-60202	05501-69102

6-6. ABBREVIATIONS AND REFERENCE DESIGNATIONS

6-7. Table 6-2 lists abbreviations used in the parts list, the schematics and throughout the manual. In some cases, two forms of the abbreviations are used, one in all capital letters, and one partial or no capital letters. This occurs because the abbreviations in the parts list are always all capital letters. However, in the schematics and the other parts of the manual, other abbreviation forms are used with both upper and lower case letters.

6-8. ORDERING INFORMATION

- 6-9. To order a part listed in the replaceable parts tables or figures, then quote the Hewlett-Packard part number, indicate the quantity required, and address the order to the nearest Hewlett-Packard office.
- 6-10. To order a part that is not listed in this section, include the instrument model number, instrument serial number, the description and function of the part, and the number of parts required. Address the order to the nearest Hewlett-Packard office.

6-11. DIRECT MAIL ORDER SYSTEM

- 6-12. Within the USA, Hewlett-Packard can supply parts through a direct mail order system. Advantages of using the system are as follows:
 - a. Direct ordering and shipment from the HP Parts Center in Mountain View, California.
 - b. No maximum or minimum on any mail order (there is a minimum order amount for parts ordered through a local HP office when the orders require billing and invoicing).
 - c. Prepaid transportation (there is a small handling charge for each order).
 - d. No invoices to provide these advantages, a check or money order must accompany each order.
- 6-13. Mail order forms and specific ordering information are available through your local HP office. Addresses and phone numbers are located at the back of this manual.

= thermocouple = test point = integrated circuit; microcircuit = electron tube = voltage regulator; breakdown diode = cable; transmission path; wire = socket = crystal unit-piezo-electric = tuned cavity; tuned circuit

Table 6-2. Reference Designations and Abbreviations

REFERENCE DESIGNATIONS

Α		
	= assembly	F
AT	= attenuator; isolator; termination	FL
B BT	= fan; motor = battery	H HY
C	= capacitor	J
CP	= coupler	-
CR	= diode: diode thyristor; varactor	DL
DC DL	 directional coupler delay line 	DS
DS	= annunciator; signaling device	к
	(audible or visual); lamp; LED	L
E	= miscellaneous electrical part	M
А	= ampere	h
ac	= alternating current	HET
ACCESS	= accessory	HEX
ADJ AID	= adjustment = analog-to-digital	HD HOW
AF	= audio frequency	HF
AFC	= automatic frequency control	HG
AGC	= automatic gain control	HI
AL ALC	 aluminum automatic level control 	HP HPF
AM	= amplitude modulation	HR
AMPL	= amplifier	HV
APC	= automatic phase control	Hz
ASSY AUX	= assembly = auxiliary	IC ID
AVG	= auxiliary = average	IF
AWG	= American wire gauge	IMPG
BAL	= balance	in
BCD BO	 binary coded decimal board 	INCD INCL
BE CU	= board = beryllium copper	INP
BFO	= beat frequency oscillator	INS
BH	= binder head	INT
BKDN BP	= breakdown = bandpass	kg kHz
BPF	= bandpass filter	kΩ
BRS	= brass	kV
BWO	= backward-wave oscillator	lb
CAL	= calibrate = counterclockwise	LC LED
CER	= ceramic	LF
CHAN	= channel	LG
cm	= centimeter	LH
CMO COEF	= coaxial = coefficient	UM UN
COM	= coemcient	lin
COMP	= composition	LK WASH
COMPL	= complete	LO
CONN CP	= connector = cadmium plate	LOG
CRT	= cathode-ray tube	log
CTL	= complementary transistor logic	LPF
	= continuous wave	
CW		LV
CW	= clockwise	m
cw O/A dB dBm	= clockwise = digital-to-analog = decibel = decibel referred to 1 mW	m mA MAX MΩ
cw O/A dB dBm dc	= clockwise = digital-to-analog = decibel = decibel referred to 1 mW = direct current	m mA MAX MΩ MEG
cw O/A dB dBm	= clockwise = digital-to-analog = decibel = decibel referred to 1 mW = direct current = degree (temperature interval or	m mA MAX MΩ MEG MET FLM
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cw O/A dB dBm dc deg °C	= clockwise = digital-to-analog = decibel = decibel referred to 1 mW = direct current = degree (temperature interval or difference = degree (plane angle) = degree Celsius (centigrade)	m mA MAX MΩ MEG MET FLM MET OX MF
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cw O/A dB dB dB dc dc dc dc dc dc dc CF °C °F °K OEPC OET diam OIA OIFF AMPL div DPDT DR DPDT DR DDDT DR DDDT DSB DTL DVM ECL EMPE ECN ECC ECC ECC SSB DTL DVM ECL ECT ECC ECC ECC ECC ECC ECC ECC ECC ECC	 clockwise digital-to-analog digital-to-analog decibel decibel referred to 1 mW decibel referred to 1 mW degree (temperature interval or difference degree (plane angle) degree Celsius (centigrade) degree Kelvin degree Kelvin degree Kelvin degree Kelvin detector diameter diameter (used in parts list) differential amplifier double-pole, double-throw drive double-pole, double-throw drive double-pole, double-throw e digital voltmeter e mitter coupled logic electronic data processing electrolic data processing electrolic data processing electrolic data processing electrolytic encapsulated external field-effect transistor 	m MAX MAX MEG MET FLM MET MF MF MHz mH mh mH mh MIN MIN MIN MIN MIN MIN MIN MOD MOM MOS MTR MTR MTG MTR MTR MTR MTR MTR MTR MTR MTR MTR MTR
cw O/A dB dB dB dc dc dc dc dc dc f °C °F °C °F °C OEPC OEFC OEFC OEFC OEFC OEFC OIA OIFAMPL div DOIA OIFAMPL div DDT DDT DVM ECL EMF EN CAP EN CAP E	 clockwise clockwise digital-to-analog digital-to-analog decibel decibel referred to 1 mW direct current degree (temperature interval or difference degree (plane angle) degree (cloius (centigrade) degree Kelvin degree Kelvin detector diameter diameter diverse double-pole, double-throw double sideband diouble sideband diouble sideband eldetromitter eldigital voltmeter eldital voltmeter electronitve force 	m mA MAX MQ MEG MET FLM MF MF MHz mH mh MIN MIN MIN MIN MIN MIN MIN MOD MOS MTG MTR mV MVc mV MVc
CW O/A dB dB dB dc dc dc dc dc dc dc dc dc dc dc dc dc	 clockwise clockwise digital-to-analog digital-to-analog dicet current degree (temperature interval or difference degree (plane angle) dedector diameter (used in parts list) differential amplifier didreferatian amplifier didreferatian amplifier didreferatian amplifier didref transistor (pgic) electromotive force electromotive force electronic data processing electronic data processing electronic (plane angle) external farad field-effect transistor filp-flop fillat head fillsten head 	m mA MAX MQ MEG MET FLM MF MFR mg MHz mH MHz mho MIN MM MM MM MM MM MM MM MM MOD MM MM MM MM MM MM MM MM MM MM MM MM MM
CW O/A dB dB dB dC de de g °F °F °F °C OEFC OEFC OEFC OEFC OEFC OEFC OIA OIFAMPL div DPDT DR DSB DTL DR DSB DTL DVM ECL EMF ENCAP E	 clockwise clockwise digital-to-analog decibel decibel referred to 1 mW cloccibel referred to 1 mW cloccibel referred to 1 mW clocet clock degree (lemperature interval or difference degree (plane angle) degree Celsius (centigrade) degree Kelvin degree Kelvin dedector diameter diameter diameter double-pole, double-throw diote transistor logic digital voltmeter electronytic electronytic electronytic electronytic electronytic encapsulated farad filel-defect transistor filip-top flat head filister head filerency modulation 	m mA MAX MQ MEG MET FLM MF MHZ MH MHZ MHZ MHZ MHZ MHZ MHZ MIN MIN MIN MIN MIN MIN MIN MIN MIN MOD MOS MTG MTG MTG MTG MTG MTG MTG MTG MV MV MV MV MV MV MV MV MV MV MV MV MV
CW O/A dB dB dB dc dc dc dc dc dc dc dc dc dc dc dc dc	 clockwise digital-to-analog decibel decibel decibel referred to 1 mW decibel referred to 1 mW degree (temperature interval or difference degree (plane angle) degree Celsius (centigrade) degree Kelvin degree Kelvin degree Kelvin degree Kelvin degree Kelvin dedector diameter diameter (used in parts list) differential amplifier double-pole, double-throw drive double-pole, double-throw e drive double-pole, double-throw e digital voltmeter e mitter coupled logic e lectronic data processing e lectrolytic encapsulated external field-effect transistor field-effect transistor field-effect transistor field-effect transistor field-effect transistor fillister head fillister head fillister head find anel 	m MAX MAX MEG MET FLM MET TLM MF MHZ MHZ MHZ MHZ MHZ MIN MIN MIN MIN MIN MIN MIN MIN MIN MIN
cw O/A dB dB dB dc dc dc dc dc dc fc °F °K OEPC OET diam OIA OIFF AMPL div DPDT DR DPDT DR DPDT DR DPDT DR DPDT DR DECL EMF ECL ECL EMF ECL ECL EMF ECL ENCAP ENCO	 clockwise digital-to-analog digital-to-analog decibel decibel decibel referred to 1 mW decibel referred to 1 mW edegree (temperature interval or difference degree Celsius (centigrade) degree Alarvenheit degree Kelvin degree Kelvin detector diameter diameter (used in parts list) differential amplifier double-pole, double-throw drive double-pole, double-throw edirite edigtes Voltmeter encapsulated electronic data processing electrolytic encapsulated field-effect transistor 	m mA MAX MAX MEG MET FLM MET OX MF MH MH mh mh mH mh mh mh mh mh mh mh mh mh mh mh mh mh
CW O/A dB dB dB dC deg °C °C °F °C °F °C OEPC OETC OETC OETC OETC OETC OETC OETC OET	 clockwise clockwise decibel decibel referred to 1 mW clicet current degree (temperature interval or difference degree (lane angle) degree Celsius (centigrade) degree Kelvin degree Kelvin dedgree Kelvin dedreet Carbon detector diameter diameter (used in parts list) dicherential amplifier double-pole, double-throw drick dicital voltmeter elocuble sideband diode transistor logic electrontive force electrontive force electronic data processing electronic external final-flop filiet head fing-hop fillster head frequency modulation frequency gram 	m mA mAX mAX mAX MAX MCG MET FLM MEG MET FLM MF mHz mHn mho MIN min min min mon MOD mMO MOS ms mVrm MAC mVpk mVpk mVpk mVpk mV mVac mVm MUX MY μ A μ F μ F μ H mho
CW O/A dB dB dB dC deg °F °F °K OEFC OEFC OET OIA OIFFAMPL div DPDT DR DSB DTL DSB DTL DSB DTL DSB DTL DSB DTL DSB DTL DSB DTL DSB DTL DSB DTL F F F F F F F F F F F F F F F F F F F	 clockwise digital-to-analog digital-to-analog decibel decibel referred to 1 mW decibel referred to 1 mW degree (temperature interval or difference degree (plane angle) degree Celsius (centigrade) degree Abrenheit degree Kelvin dedector diameter diameter double-pole, double-throw double-pole, double-throw diote transistor logic electrolytic electrolytic electrolytic electrolytic electrolytic electrolytic electrolytic electrolytic fished fisher head germanium 	m mA MAX MQ MEG MET FLM MF MF MH mh mh mh mh mh MIN min min min MIN MIN MIN MIN MIN MIN MIN MIN MIN MOD MOS MTG MTG MTG MTG MTG MY MV MV MV MV MV MV MV MV MV MV MV MV MV
CW O/A dB dB dB dC deg °C °C °F °C °F °C OEPC OETC OETC OETC OETC OETC OETC OETC OET	 clockwise clockwise decibel decibel referred to 1 mW clicet current degree (temperature interval or difference degree (lane angle) degree Celsius (centigrade) degree Kelvin degree Kelvin dedgree Kelvin dedreet Carbon detector diameter diameter (used in parts list) dicherential amplifier double-pole, double-throw drick dicital voltmeter elocuble sideband diode transistor logic electrontive force electrontive force electronic data processing electronic external final-flop filiet head fing-hop fillster head frequency modulation frequency gram 	m mA mAX mAX mAX MAX MCG MET FLM MEG MET FLM MF mHz mHn mho MIN min min min mon MOD mMO MOS ms mVrm MAC mVpk mVpk mVpk mVpk mV mVac mVm MUX MY μ A μ F μ F μ H mho
cw O/A dB dB dB dc dc deg °C °F °F °K OEFC OET diam OIA OIFF AMPL div DPDT DR DTL DVM EOL EMF EOP ELECT ENCAP EXT F F F F F F F F F F F F F F F F F F F	 clockwise digital-to-analog decibel decibel decibel referred to 1 mW eldecibel referred to 1 mW elderet current degree (lemperature interval or difference degree (plane angle) degree Celsius (centigrade) degree Kelvin degree Kelvin degree Kelvin detector diameter diameter (used in parts list) eldifferential amplifier double-pole, double-throw drive double-pole, double-throw eldivies double-pole, double-throw eldivies eldigtes values eldigtes values eldicter elditerential amplifier elditerential amplifi	m MAX MAX MAX MEG MET FLM MF MF MH MH MH MH MH MIN MIN MIN MIN MIN MIN MIN MIN MIN MOD MOM MOD MOM MOS MOD MOM MOS MTR mVpp mVrms mVpp mV mV MY MY μ H μ H μ H μ H μ H N F N S MTS MTS MTS MTS MTS MTS MTS MTS MTS M
CW O/A dB dB dB db dc de de g °C °F °C °F °C °F °C °F °C OEPC OETC OETC OETC OETC OETC OETC OETC OET	 clockwise digital-to-analog digital-to-analog decibel decibel referred to 1 mW direct current degree (temperature interval or difference degree (plane angle) degree Celsius (centigrade) degree Kelvin degree Kelvin dedector diameter diameter distrete double-pole, double-throw double-pole, double-throw double sideband diouble sideband diouble sideband electronite data processing electronite data processing electronite data filister head filister head filister head finequery modulation froquency modulation fort panel firequency ggram ggram gighartz glass 	m mA MAX MAX MAX MET MET MET MET MF MF MHZ MHZ MHZ MHZ MHZ MMN MOD MOD MOD MOD MOD MOD MTG MTG MTG MTG MTG MTG MTG MTG

	DESIG
= fuse = filter	MP P
= hardware	
 = circulator = electrical connector (stationary 	Q B
portion); jack	RT
= delay line	S T
 annunciator; signaling device (audible or visual); lamp; LED 	ТВ
= relay	TC
= coil; inductor = meter	T TB
ABBRE\	
= hour = heterodyne	NORM
= hexagonal	NPN
= head = hardware	NPO
= high frequency	NRFR
= mercury	ns
= high = Hewlett-Packard	NSR
= high pass filter	nW
= hour (used in parts list) = high voltage	OBD OD
= hertz	OH
= integrated circuit	OP AMPL OPT
 inside diameter intermediate frequency 	OSC
= impregnated	OX
= inch = incandescent	oz O
= include(s)	P
= input	PAM
= insulation = internal	PC PCM
= kilogram	1 0111
= kilohertz	PDM
= kilohm = kilovolt	pF PH BAZ
= pound	PHL
inductance-capacitancelight-emitting diode	PIN PIV
= low frequency	pk
= long	PL
= left hand = limit	PLO PM
= linear taper (used in parts list)	PNP
= linear = lockwasher	P/O POLY
= lockwasher = low; local oscillator	PORC
= logarithmic taper (used in parts	POS
list) = logarithm(ic)	POSN
= low pass filter	POT
= low voltage = meter (distance)	p-p PP
= milliampere	PPM
= maximum	PREAMPL PRF
= megohm = meg (106) (used in parts list)	PRR
= metal film	ps
= metal oxide = medium frequency; microfarad	PT PTM
(used in parts list)	PWM
= manufacturer	PWV
= milligram = megahertz	RC RECT
= millihenry	REF
= conductance = minimum	REG REPL
= minute (time)	RF
= minute (plane angle)	RFI
= miniature = millimeter	RH RLC
= modulator	
= momentary = metal-oxide semiconductor	RMO rms
= millisecond	RND
= mounting	ROM
= meter (indicating device) = millivolt	R&P RWV
= millivolt, ac	S
= millivolt, dc = millivolt, peak	s •••"
 millivolt, peak-to-peak 	S-B
= millivolt, rms	SCR
= milliwatt = multiplex	SE SECT
= mylar	SEMICON
= microampere	SHF SI
= microfarad = microhenry	SIL
= micromho	SL
= neon = negative	SNR SPOT
= nanofarad	SPG
= nickel plate	SR
= normally open	μS

NATIONS	
 miscellaneous mechanical part electrical connector (movable 	TC TP
portion); plug	U
= transistor: SCR, triode, thyristor	V VR
= resistor = thermistor	
= switch	W X
= transformer = terminal board	Ŷ
= thermocouple	Z
= transformer = terminal board	
NS	
= nominal	μV
= normal	μVac
 negative-positive-negative negative-positive zero (zero 	μVdc μVpk
temperature coefficient)	μр-р
= not recommended for field replacement	μVrms μW
= nanosecond	nA
 not separately replaceable nanowatt 	NC N/C
= order by description	SPST
 outside diameter oval head 	SSB SST
= operational amplifier	STL
= option = oscillator	SQ SWR
= oxide	SYNC
= ounce = ohm	T TA
= peak (used in parts list)	тс
 pulse-amplitude modulation printed circuit 	TO TERM
= pulse-code modulation; pulse-	TFT
count modulation = pulse-duration modulation	TGL THO
= picofarad	THRU
 phosphor bronze phillips 	TI TOL
= positive-intrinsic-negative	TRIM
= peak inverse voltage = peak	TSTR TTL
= phase lock	TV
 phase lock oscillator phase modulation 	TVI TWT
= positive-negative-positive	U
= part of = polystyrene	UF UHF
= porcelain	UNREG
 positive; position(s) (used in parts list) 	V VA
= position	Vac VAR
= potentiometer = peak-to-peak	VAR
 peak-to-peak (used in parts list) pulse-position modulation 	Vdc VDCW
= preamplifier	
 pulse-repetition frequency pulse repetition rate 	V(F) VFO
= picosecond	VHF
= point = pulse-time modulation	Vpk Vp-p
= pulse-width modulation	Vrms
= peak working voltage	VSWR VTO
 resistance capacitance rectifier 	VTVM
= reference = regulated	V(X) W
= replaceable	W/
 radio frequency radio frequency interference 	WIV
= round head; right hand	W/O
= resistance-inductance-	YIG Zo
	20
capacitance = rack mount only	
rack mount onlyroot-mean-square	All abbreviatio
= rack mount only = root-mean-square = round = read-only memory	case.
= rack mount only = root-mean-square = round = read-only memory = rack and panel	case.
= rack mount only = root-mean-square = round = read-only memory = rack and panel = reverse working voltage = scattering parameter	case. Abbreviation T
= rack mount only = root-mean-square = round = read-only memory = rack and panel = reverse working voltage = scattering parameter = second (time)	case. Abbreviation
= rack mount only = root-mean-square = round = read-only memory = rack and panel = reverse working voltage = scattering parameter = second (time) = second (bane angle) = slow-blow fuse (used in parts list)	case. Abbreviation T G M k
= rack mount only = root-mean-square = round = read-only memory = rack and panel = reverse working voltage = scattering parameter = second (itime) = second (plane angle)	case. Abbreviation T G M
= rack mount only = root-mean-square = round = read-only memory = rack and panel = reverse working voltage = scattering parameter = second (time) = second (plane angle) = slow-blow fuse (used in parts list) = silicon controlled rectifier; screw = selenium = secions	case. Abbreviation T G M k k da d c
= rack mount only = root-mean-square = round = read-only memory = rack and panel = reverse working voltage = scattering parameter = second (time) = second (time) = silow-blow fuse (used in parts list) = silow controlled rectifier; screw = selenium = sections = semiconductor	case. Abbreviation T G M k da d d c m
= rack mount only = root-mean-square = round = read-only memory = rack and panel = reverse working voltage = scattering parameter = second (time) = slow-blow fuse (used in parts list) = silicon controlled rectifier; screw = selenium = selenium = sections = semiconductor = superhigh frequency = silicon	case. Abbreviation T G M k da d c c m µ n
= rack mount only = root-mean-square = round = read-only memory = rack and panel = reverse working voltage = scattering parameter = second (time) = slow-blow fuse (used in parts list) = slicon controlled rectifier; screw = seltions = sections = sections = semptigh frequency = slicer	case. Abbreviation T G k da d c c m µ n p
= rack mount only = root-mean-square = round = read-only memory = rack and panel = reverse working voltage = scattering parameter = second (time) = second (time) = slicon controlled rectifier; screw = selicons = sections = sections = sections = setions = setions = setions = setions = setions = setions = setions = silcer = silcer = silcer = silcer = silcer	case. Abbreviation T G M k da d c c m µ n
 rack mount only root-mean-square round read-only memory rack and panel reverse working voltage scattering parameter second (time) second (plane angle) slicon controlled rectifier; screw selicon controlled rectifier; screw selenium sections semiconductor superhigh frequency silver slide signal to-noise ratio sigle-pole, double-throw 	case. Abbreviation T G M k d d d c m t P f
= rack mount only = root-mean-square = round = read-only memory = rack and panel = reverse working voltage = scattering parameter = second (time) = second (time) = slicon controlled rectifier; screw = selicons = sections = sections = sections = setions = setions = setions = setions = setions = setions = setions = silcer = silcer = silcer = silcer = silcer	case. Abbreviation T G M k d d d c m t P f

= microvolt	
= microvolt,	
= microvolt,	
= microvolt,	
= microvolt,	peak-to-peak
= microvolt,	rms
= microwatt	
= nanoamp	
= no conne	
= normally o	
= single-pol = single side	e, single-throw
= stainless	
= steel	sieer
= square	
= standing-v	wave ratio
= synchroni	
	w-blow fuse)
= tantalum	,
	ire compensating
= time delay	
= terminal	
= thin-film tr	ansistor
= toggle	
= thread	
= through	
= titanium	
= tolerance	
= trimmer	
= transistor	
	transistor logic
= television	:
= television	
= traveling v	6 used in parts list)
	d (used in parts list)
= ultrahigh f	
= unregulate	
= volt	
= voltamper	e
= volts ac	
= variable	
	ontrolled oscillator
= volts dc	
= volts, dc,	working (used in parts
list)	
= volts, filter	
	equency oscillator
= very-high	
= volts peak	
= volts peak	to-peak
= volts rms	
	anding wave ratio
	ned oscillator ube voltmeter
= vacuum-ti = volts, swit	
= watt	cheu
= with	
	verse voltage
= wirewoun	
= without	-
= yttrium-iro	n-garnet
= characteri	stic impedance
NOTE	

NOTE Abbreviations in the parts list will be in upper

MULTIPLIERS

Prefix	Multiple
era	1012
giga	108
nega	106
kilo	103
deka	10
deci	10-1
centi	10-2
milli	10-3
nicro	10-6
nano	10-9
oico	10-12
emto	10-15
atto	10 ⁻¹⁸

Reference Designation	HP Part Number	C D	Qty	Description	Mfr Code	Mfr Part Number
A1	05501-60028	0	1	CONNECTOR BOARD ASSEMBLY SERIES 2632, REVISION A	28480	05501-60028
A1C1	0160-4557	0	2	CAPACITOR-FXD .1UF ±20% 50VDC CER	16299	CAC04X7R104M050A
A1C2	0160-4557	0		CAPACITOR-FXD .1UF ±20% 50VDC CER	16299	CAC04X7R104M050A
A1C3	0180-2867	3	2	CAPACITOR-FXD 390UF+100-10% 40VDC AL	28480	0180-2867
A1C4	0180-2867	3		CAPACITOR-FXD 390UF+100-10% 40VDC AL	28480	0180-2867
A1C5	0160-4535	4	1	CAPACITOR-FXD 1UF ±10% 50VDC CER	28480	0160-4535
A1C6	0180-3196	3 3	2	CAPACITOR-FXD 120UF+50 -10% 40VDC AL	28480	0180-3196
A1C7	0180-3196	3		CAPACITOR-FXD 120UF +50 -10% 40VDC AL	28480	0180-3196
A1C8	0160-4822	2	1	CAPACITOR-FXD 1000PF ±5% 100VDC CER		0160-4822
A1C9	0160-0576	5 5	4	CAPACITOR-FXD .1UF ±20% 50VDC CER	28480	0160-0576
A1C10	0160-0576	5		CAPACITOR-FXD .1UF ±20% 50VDC CER	28480	0160-0576
A1C11	0160-0576	5		CAPACITOR-FXD .1UF ±20% 50VDC CER	28480	0160-0576
A1C12	0160-0576	5		CAPACITOR-FXD .1UF ±20% 50VDC CER	28480	0160-0576
A1CR1	1901-0731	7	2	DIODE-PWR RECT 400V 1 A	14433	1N4004G
A1CR2	1901-0731	7		DIODE-PWR RECT 400V 1 A	14433	1N4004G
A1CR3	1902-0945	7	1	DIODE-ZNR 3V 5% DO-35 PD=.4W TC043%		1902-0945
A1DS1	1990-0486	6	4	LED-LAMP LUM-INT 2MCD IF=25MA-MAX BVR=5V	28480	HLMP-1301
A1DS2	1990-0486	6	.	LED-LAMP LUM-INT 2MCD IF=25MA-MAX BVR=5V		HLMP-1301
A1DS3	1990-0485	5	3	LED-LAMP LUM-INT 2MCD IF=30MA-MAX BVR=5V		HLMP-1503
A1DS4	1990-0485	5	-	LED-LAMP LUM-INT 2MCD IF=30MA-MAX BVR=5V		HLMP-1503
A1DS5	1990-0486	6		LED-LAMP LUM-INT 2MCD IF=25MA-MAX BVR=5V		HLMP-1301
A1DS6	1990-0486	6		LED-LAMP LUM-INT 2MCD IF=25MA-MAX BVR=5V		HLMP-1301
A1DS7	1990-0487	7	1	LED-LAMP LUM-INT 2MCD BVR=5V		HLMP-1401
A1DS8	1990-0485	5	-	LED-LAMP LUM-INT 2MCD BVR=30 LED-LAMP LUM-INT 2MCD IF=30MA-MAX BVR=5V		HLMP-1503
A1-1	2110-0695	6	2		20400	2110-0695
A1F1	2110-0691	2		FUSE-8IPIN 1.5A 125V NTD .348X.25 UL FUSEHOLDER-8IPIN SKT 5A 125 V		2110-0691
A1F2	2110-0695	6	2	FUSE-8IPIN 1.5A 125V NTD .348X.25 UL		2110-0695
ATEZ	2110-0695	2		FUSEHOLDER-8IPIN SKT 5A 125 V		2110-0691
A1J1	1251-8494	6	1	CONN-POST TYPE .100-PIN-SPCG 24-CONT	28480	1251-8494
A1J2				NOT ASSIGNED		
A1J3	1251-6010	8	1	CONNECTOR 3-PIN M POST TYPE	28480	1251-6010
A1J4	1251-5170	9	1	CONNECTOR 2-PIN M POST TYPE	28480	1251-5170
A1J5	1251-3448	0	1	CONNECTOR 4-PIN F CIRCULAR	28480	1251-3448
A1J6	1251-3449	1	1	CONNECTOR 4-PIN F CIRCULAR 45	28480	1251-3449
A1L1	9140-0171	3	2	INDUCTOR RF-CH-MLD 40UH 10%	28480	9140-0171
A1L2	9140-0171	3		INDUCTOR RF-CH-MLD 40UH 10%		9140-0171
A1Q1	1854-0215	1	2	TRANSISTOR NPN SI TO-92 PD,350MW	04713	2N3904
A1Q2	1853-0058	8	4	TRANSISTOR PNP SI PD=300MW FT=200MHZ		\$32248
A1Q3	1854-0635	9		TRANSISTOR NPN SI PD=50W FT=20MHZ		D44H5
A1Q4	1853-0058	8		TRANSISTOR PNP SI PD=300MW FT=200MHZ		\$32248
A1Q5	1853-0058	8		TRANSISTOR PNP SI PD=300MW FT=200MHZ		\$32248
A1Q6	1853-0363	8	1	TRANSISTOR PNP SI PD=50W FT=20MHZ		x45H281
A1Q7	1854-0635	9		TRANSISTOR NPN SI PD=50W FT=20MHZ	03508	
A1Q8	1853-0058	8		TRANSISTOR PNP SI PD=300MW FT=200MHZ		\$32248
A1Q9	1854-0215	1		TRANSISTOR NPN SI TO-92 PD=350MW		2N3904
A1R1	0757-0278	9	11	RESISTOR 1.78K 1% 1/8W F TC=0±100	24546	СТ4-1/8-Т0-1781-F
AIRI A1R2	0757-0278	9		RESISTOR 1.78K 1% 1/8W F TC=0±100		CT4-1/8-T0-1781-F
AIR2 AIR3	0757-0278	9		RESISTOR 1.78K 1% 1/8W F TC=0±100 RESISTOR 1.78K 1% 1/8W F TC=0±100		CT4-1/8-T0-1781-F
	0757-0278	9		RESISTOR 1.78K 1% 1/8W F TC=0±100 RESISTOR 1.78K 1% 1/8W F TC=0±100		CT4-1/8-T0-1781-F
Δ1R4	0698-3156	2	6	RESISTOR 14.7K 1% 1/8W F TC=0±100		CT4-1/8-T0-1472-F
A1R4 A1R5		2		RESISTOR 14.7K 1% 1/8W F TC=0±100 RESISTOR 14.7K 1% 1/8W F TC=0±100		CT4-1/8-T0-1472-F
A1R5						
A1R5 A1R6	0698-3156			RESTSTOR 1 78K 1% 1/8W F TC-0+100	14546	CT4-1/8-T0-1781-F
A1R5 A1R6 A1R7	0698-3156 0757-0278	9		RESISTOR 1.78K 1% 1/8W F TC=0±100 RESISTOR 1 78K 1% 1/8W F TC=0+100		CT4-1/8-T0-1781-F
A1R5 A1R6 A1R7 A1R8	0698-3156 0757-0278 0757-0278	9 9		RESISTOR 1.78K 1% 1/8W F TC=0±100	24546	СТ4-1/8-ТО-1781-F
A1R5 A1R6 A1R7 A1R8 A1R9	0698-3156 0757-0278 0757-0278 0757-0278	9 9 9		RESISTOR 1.78K 1% 1/8W F TC=0±100 RESISTOR 1.78K 1% 1/8W F TC=0±100	24546 24546	СТ4-1/8-ТО-1781-F СТ4-1/8-ТО-1781-F
A1R5 A1R6 A1R7 A1R8 A1R9 A1R10	0698-3156 0757-0278 0757-0278 0757-0278 0757-0278 0757-0278	9 9 9 9		RESISTOR 1.78K 1% 1/8W F TC=0±100 RESISTOR 1.78K 1% 1/8W F TC=0±100 RESISTOR 1.78K 1% 1/8W F TC=0±100	24546 24546 24546	CT4-1/8-TO-1781-F CT4-1/8-TO-1781-F CT4-1/8-TO-1781-F
A1R5 A1R6 A1R7 A1R8 A1R9 A1R10 A1R11	0698-3156 0757-0278 0757-0278 0757-0278 0757-0278 0757-0278 0757-0279	9 9 9 9 0	1	RESISTOR 1.78K 1% 1/8W F TC=0±100 RESISTOR 1.78K 1% 1/8W F TC=0±100 RESISTOR 1.78K 1% 1/8W F TC=0±100 RESISTOR 3.16K 1% 1/8W F TC=0±100	24546 24546 24546 24546	CT4-1/8-T0-1781-F CT4-1/8-T0-1781-F CT4-1/8-T0-1781-F CT4-1/8-T0-1781-F CT4-1/8-T0-3161-F
A1R5 A1R6 A1R7 A1R8 A1R9 A1R10 A1R11 A1R12	0698-3156 0757-0278 0757-0278 0757-0278 0757-0278 0757-0279 2100-3274	9 9 9 0 2	1 1	RESISTOR 1.78K 1% 1/8W F TC=0±100 RESISTOR 1.78K 1% 1/8W F TC=0±100 RESISTOR 1.78K 1% 1/8W F TC=0±100 RESISTOR 3.16K 1% 1/8W F TC=0±100 RESISTOR-TRMR 10K 10% C SIDE-ADJ 1-TRN	24546 24546 24546 24546 28480	CT4-1/8-T0-1781-F CT4-1/8-T0-1781-F CT4-1/8-T0-1781-F CT4-1/8-T0-3161-F 2100-3274
A1R5 A1R6 A1R7 A1R8 A1R9 A1R10 A1R11	0698-3156 0757-0278 0757-0278 0757-0278 0757-0278 0757-0278 0757-0279	9 9 9 9 0	1 1 1	RESISTOR 1.78K 1% 1/8W F TC=0±100 RESISTOR 1.78K 1% 1/8W F TC=0±100 RESISTOR 1.78K 1% 1/8W F TC=0±100 RESISTOR 3.16K 1% 1/8W F TC=0±100	24546 24546 24546 24546 28480 24546	CT4-1/8-T0-1781-F CT4-1/8-T0-1781-F CT4-1/8-T0-1781-F CT4-1/8-T0-1781-F CT4-1/8-T0-3161-F

 6
 1
 RESISTOR 500
 1%
 3w
 PW
 TC=0±20
 28450
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 See introduction to this section for ordering information

†Backdating information in Section 7

					1	
Reference Designation	HP Part Number	C D	Qty	Description	Mfr Code	Mfr Part Number
A1R16 A1R17 A1R18 A1R19 A1R20 A1R21 A1R21 A1R22 A1R23 A1R24	0757-0278 0757-0278 0698-0082 0698-0082 0698-0082 0698-3156 0698-3156 0757-0278 0698-3156	9 7 7 2 9 2		RESISTOR 1.78K 1% 1/8W F TC=0±100 RESISTOR 1.78K 1% 1/8W F TC=0±100 RESISTOR 464 1% 1/8W F TC=0±100 RESISTOR 464 1% 1/8W F TC=0±100 RESISTOR 464 1% 1/8W F TC=0±100 RESISTOR 14.7K 1% 1/8W F TC=0±100 RESISTOR 14.7K 1% 1/8W F TC=0±100 RESISTOR 1.78K 1% 1/8W F TC=0±100 RESISTOR 14.7K 1% 1/8W F TC=0±100	24546 24546 24546 24546 24546 24546 24546	CT4-1/8-T0-1781-F CT4-1/8-T0-1781-F CT4-1/8-T0-4640-F CT4-1/8-T0-4640-F CT4-1/8-T0-4640-F CT4-1/8-T0-4640-F CT4-1/8-T0-1472-F CT4-1/8-T0-1472-F CT4-1/8-T0-1781-F CT4-1/8-T0-1472-F
A1S1 A1S2	3101-2878 3101-2334	3 6		SWITCH-PB DPDT MOM .5A 60 VAC/VDC SWITCH-SL DPDT SUBMIN .5A 125VAC/DC PC	31918 28480	мр 3101-2334
A1TP1 A1TP2 A1TP3	0360-0535 0360-0535 0360-0535	0 0 0	3	TERMINAL-TEST POINT .330IN ABOVE TERMINAL-TEST POINT .330IN ABOVE TERMINAL-TEST POINT .330IN ABOVE	28480	0360-0535 0360-0535 0360-0535
	0380-1512 0380-1548 4040-1617	7 9 7	4	A1 MISCELLANEOUS PARTS AND HARDWARE STANDOFF-RIVET-ON 9-MM-LG M3.0 X 0.5-THD STANDOFF-RIVET 10 LM 2.5 STANDOFF-LED .196-IN-WD .196-IN-LG BLK	28480	0380-1512 0380-1548 4040-1617
				REFERENCE DESIGNATORS NOT USED: A3J2		
A2	05518-60303	3	1	HIGH VOLTAGE POWER SUPPLY ASSEMBLY	28480	05518-60303
			e in	troduction to this section for ordering infor	matio	n

Table 6-3. HP5501B Board Assemblies Replaceable Parts (Continued)

Table 6-3. HP5501B Board Assemblies Replaceable Parts (Contin	ued)

Reference Designation	HP Part Number	C D	()tv	Description	Mfr Code	Mfr Part Number
A3	05501-60027	9	1	CONTROLLER/REFERENCE BOARD ASSEMBLY SERIES 2632. REVISION A	28480	05501-60027
A3C1	0180-2929	8	1	CAPACITOR-FXD 68UF±10% 10VDC TA	28480	0180-2929
A3C2	0160-4554	7		CAPACITOR-FXD .01UF ±20% 50VDC CER	28480	0160-4554
A3C3	0160-4808	4	5	CAPACITOR-FXD 470PF ±5% 100VDC CER	28480	0160-4808
A3C4	0180-1746	5	1	CAPACITOR-FXD 15UF ±10% 20VDC TA		150D156X9020B2
A3C5	0180-0291	3	1	CAPACITOR-FXD 15UF $\pm 10\%$ 20VDC TA CAPACITOR-FXD 1UF $\pm 10\%$ 35VDC TA CAPACITOR-FXD .01UF $\pm 20\%$ 50VDC CER CAPACITOR-FXD .22UF $\pm 10\%$ 35VDC TA CAPACITOR-FXD .022UF $\pm 10\%$ 100VDC CER CAPACITOR-FXD .01UF $\pm 20\%$ 50VDC CER CAPACITOR-FXD .01UF $\pm 20\%$ 50VDC CER CAPACITOR-FXD 20UF $\pm 75-10\%$ 50VDC AL CAPACITOR-FXD 20UF $\pm 75-10\%$ 50VDC AL CAPACITOR-FXD 1UF $\pm 10\%$ 100VDC MET-POLYE CAPACITOR-FXD 1UE $\pm 10\%$ 100VDC MET-POLYE		150D105X9035A2
A3C6	0160-4554	7		CAPACITOR-FXD .01UF ±20% 50VDC CER		0160-4554
A3C7	0180-1735	2	1	CAPACITOR-FXD .22UF ±10% 35VDC TA		150D224X9035A2
A3C8	0160-4824	4	1	CAPACITOR-FXD .022UF ±10% 100VDC CER		0160-4824
A3C9	0160-4554	7		CAPACITOR-FXD .01UF ±20% 50VDC CER		0160-4554
A3C10	0160-4554	7	2	CAPACITOR-FXD .010F $\pm 20\%$ SOVDC CER		0160-4554
A3C11	0180-0049	9	2	CAPACITOR-FXD 200F +75-10% SOVDC AL		30D206G050CC2
A3C12	0180-0049	9	h	CAPACITOR-FXD 200F +75-10% 50VDC AL		30D206G050CC2
A3C13	0160-3072	2	2	CAPACITOR-FXD IUF ±10% 100VDC MET-POLYE		0160-3072
A3C14	0160-3072	2 7		CAPACITOR FXD $101 \pm 10\%$ 100 VDC MET-FOLTE		0160-3072
A3C15	0160-4554	7		CAPACITOR-FXD .01UF $\pm 20\%$ 50VDC CER		0160-4554
A3C16	0160-4554	7		CAPACITOR-FXD .010F ±20% 50VDC CER CAPACITOR-FXD .010F ±20% 50VDC CER CAPACITOR-FXD .010F ±20% 50VDC CER CAPACITOR-FXD .220F ±10% 80VDC POLYE CAPACITOR-FXD .010F ±20% 50VDC CER CAPACITOR-FXD .010F ±20% 50VDC CER		0160-4554 0160-4554
A3C17 A3C18	0160-4554 0160-2453	1'	1	CAPACITOR-FAD JULUF $\pm 20\%$ SUVUL LEK		0160-2453
A3C18	0160-4554	7	т	CAPACITOR-FXD .220F $\pm 10\%$ 60VDC POLTE		0160-4554
A3C20	0160-5237	5	1	CAPACITOR-FXD .010F $\pm 20\%$ JUVDC CER		0160-5237
A3C21	0160-4554	7	т	CAPACITOR-FXD JUF $\pm 10\%$		0160-4554
A3C22	0160-0576	5	3	CAPACITOR-FXD .01UF ±20% 50VDC CER CAPACITOR-FXD .1UF ±20% 50VDC CER CAPACITOR-FXD .1UF ±20% 50VDC CER		0160-0576
A3C22	0160-4557	0	7	CAPACITOR-FXD 10F $\pm 20\%$ 50VDC CER		CAC04X7R104M050A
A3C24	0160-4557	0	'	CAPACITOR-FXD .10F ±20% 50VDC CER	16299	CAC04X7R104M050A
A3C25	0160-4554	7		CAPACITOR-FXD .01UF ±20% 50VDC CER		0160-4554
A3C26	0160-0576	5		CAPACITOR-FXD .1UF ±20% 50VDC CER		0160-0576
A3C27	0160-0576	5		CARACTTOR-EVE 1UE $\pm 20\%$ 50VDC CER		0160-0576
A3C28	0180-0309	4	1	CAPACITOR - EXD 4.7 μ F+20% 10VDC TA	56289	150D475x0010A2
A3C29	0160-4557	0	-	CAPACITOR-EXD $.10E +20\%$ 50VDC CFR		CAC04X7R104M050A
A3C30	0160-4554	7		CAPACITOR-FXD $4.70\pm 20\%$ JOVDC TA CAPACITOR-FXD $4.70\pm 20\%$ JOVDC TA CAPACITOR-FXD $.10F \pm 20\%$ SOVDC CER CAPACITOR-FXD $.010F \pm 20\%$ SOVDC CER CAPACITOR-FXD $.10F \pm 20\%$ SOVDC CER CAPACITOR-FXD $.10F \pm 20\%$ JOVDC CER CAPACITOR-FXD $470PF \pm 5\%$ JOVDC CER CAPACITOR FXD $.10F \pm 20\%$ SOVDC CER		0160-4554
A3C31	0160-4824	4	1	CAPACITOR-FXD $680PF \pm 5\%$ 100VDC CER		0160-4824
A3C32	0160-4557	0		CAPACITOR-FXD .1UF ±20% 50VDC CER		CAC04X7R104M050A
A3C33	0160-4808	4		CAPACITOR-FXD 470PF ±5% 100VDC CER		0160-4808
A3C34	0160-4557	0		CAPACITOR-FXD .1UF ±20% 50VDC CER		CAC04X7R104M050A
A3C35	0160-4808	4		CAPACITOR-FXD 470PF ±5% 100VDC CER		0160-4808
A3C36	0160-4809	5	1	CAPACITOR-FXD 390PF ±5% 100VDC CER		0160-4809
A3C37	0160-4557	0		CAPACITOR-FXD .1UF ±20% 50VDC CER	16299	CAC04X7R104M050A
A3C38	0160-4554	7		CAPACITOR-FXD .01UF ±20% 50VDC CER		0160-4554
A3C39	0160-4554	7		CAPACITOR-FXD .01UF ±20% 50VDC CER	28480	0160-4554
A3C40	0160-4557	0		CAPACITOR-FXD .1UF ±20% 50VDC CER		CAC04X7R104M050A
A3C41	0160-4554	7		CAPACITOR-FXD 470PF ±5% 100VDC CER CAPACITOR-FXD 390PF ±5% 100VDC CER CAPACITOR-FXD .1UF ±20% 50VDC CER CAPACITOR-FXD .01UF ±20% 50VDC CER CAPACITOR-FXD .01UF ±20% 50VDC CER CAPACITOR-FXD .1UF ±20% 50VDC CER CAPACITOR-FXD .01UF ±20% 50VDC CER		0160-4554
A3C42	1810-0768	7	1	NETWORK-CAPACITOR SIP NETWORK CAPACITOR		470C7C0G471K5DG
A3C43	0160-4808	4		CAPACITOR-FXD 470PF ±5% 100VDC CER		0160-4808
A3C44	0160-4554	7		CAPACITOR-FXD .01UF ±20% 50VDC CER		0160-4554
A3C45	0160-4808	4		CAPACITOR-FXD 470PF ±5% 100VDC CER	28480	0160-4808
A3CR1	1901-0050	3	3	DIODE-SWITCHING 80V 200MA 2NS DO-35	9N171	1N4150
A3CR2	1901-0731	7		DIODE-POWER RECT 400V 1A		1N4004G
A3CR5	1990-0770	1		PHOTODIODE ID=30NA-MAX		OP 913 (SELECTED)
A3CR6	1901-0518	8		DIODE-SM SIG SCHOTTKY		1901-0518
A3CR7	1901-0050	3		DIODE-SWITCHING 80V 200MA 2NS DO-35		1N4150
A3CR8	1901-0050	3		DIODE-SWITCHING 80V 200MA 2NS DO-35	9N171	1N4150
A3DS1	1990-0485	5		LED-LAMP LUM-INT=2MCD IF=30MA-MAX BVR=5V		HLMP-1503
A3DS2	1990-0487	7		LED-LAMP LUM-INT=2MCD BVR=5V	28480	HLMP-1401
A3J1	1251-8603	9		CONN-POST TYPE. 100-PIN-SPCG 24-CONT		1251-8603
A3J2	1251-5801	3		CONNECTOR 4-PIN M POST TYPE	28480	1251-5801
A3JMP1	1251-4047	7	4	CONNECTOR 3-PIN M POST TYPE	28480	1251-4047
A3JMP2	1251-4813	5		CONNECTOR 5-PIN M POST TYPE		1251-4813
A3JMP3	1251-6957	2		CONNECTOR 4-PIN M POST TYPE		1251-6957
A3JMP4	1251-4813	5		CONNECTOR 5-PIN M POST TYPE		1251-4813
A3JMP5	1251-4047	7		CONNECTOR 3-PIN M POST TYPE		1251-4047

Table 6-3. HP5501B Board Assemblies Replaceable Parts (Contine	ued)
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Reference	HP Part	С		Description	Mfr	Mfr Davit Niumahar
Designation	Number	C D	Qty	Description	Code	Mfr Part Number
A3JMP6	1251-4813	5		CONNECTOR 5-PIN M POST TYPE	28480	1251 4813
АЗЈМР7	1251-4047	7		CONNECTOR 3-PIN M POST TYPE	28480	1251-4047
АЗЈМР8	1251-4047	7		CONNECTOR 3-PIN M POST TYPE		1251-4047
A3L1	9100-2558	0		INDUCTOR RF-CH-MLD 47UH 5%		9100-2558
A3L2	9100-2558	0		INDUCTOR RF-CH-MLD 47UH 5%		9100-2558
A3L3	9140-0531	9		INDUCTOR RF-CH-MLD 1UH 5% .105DX.26LG		9140-0531
A3L4	9140-0537	5	2	INDUCTOR RF-CH-MLD 2.2UH 5% .105DX.26LG		9140-0537
A3L5	9140-0537	5		INDUCTOR RF-CH-MLD 2.2UH 5% .105DX,26LG	28480	9140-0537
A3Q1 A3Q5				NOT ASSIGNED		
A3Q5	1854-0215	I	2	TRANSISTOR NPN SI TO-92 PD-350MW	04713	2N3904
A3Q7	1854-0215	1		TRANSISTOR NPN SI TO-92 PD-350MW		2N3904
A3R1	1051 0215	-		NOT ASSIGNED	01715	210501
A3R2	0698-0084	9	6	RESISTOR 2.15K 1% 1/8W F TC=0±100	24546	СТ4-1/8-Т0-2151-F
A3R3	0698-0084	9		RESISTOR 2.15K 1% 1/8W F TC=0±100		СТ4-1/8-Т0-2151-F
A3R4	1810-0367	2	2	NETWORK-RES 6-SIP 4.7K OHM X 5	11236	750-61-R4.7K
A3R5	1810-0279	5	1	NETWORK-RES 10-SIP 4.7K OHM X 9	91637	CSC10A01-472G/MSP10A01-
						472G
A3R6	0699-0069	2		RESISTOR 2.15M 1% 1/8W F TC=0±100		0699-0069
A3R7	0757-0458	7 7	1	RESISTOR 51.1K 1% 1/8W F TC=0±100		CT4-1/8-T0-5112-F
A3R8 A3R9	0757-0440	1	1	RESISTOR 7.5K 1% 1/8W F TC=0±100 NOT ASSIGNED	24546	СТ4-1/8-Т0-7501-F
	0608 6360	6	4	RESISTOR 10K .1% 1/8W F TC=0±25	28480	0698-6360
A3R10 A3R11	0698-6360 0698-6360	6 6		RESISTOR 10K .1% 1/8W F TC=0±25 RESISTOR 10K .1% 1/8W F TC=0±25		0698-6360
A3R12	0000-0000	0		NOT ASSIGNED	20400	0000-0000
A3R13				NOT ASSIGNED		
A3R14	0698-6360	6		RESISTOR 10K .1% 1/8W F TC=0±25	28480	0698-6360
A3R15	0698-6360	6		RESISTOR 10K .1% 1/8W F TC=0±25		0698-6360
A3R16	2100-3161	6	1	RESISTOR-TRMR 20K 10% C SIDE-ADJ 17-TRN		89PR20K
A3R17	0698-3457	6	2	RESISTOR 316K 1% 1/8W F TC=0±100	28480	0698-3457
A3R18	0698-3156	2	1	RESISTOR 14.7K 1% 1/8W F TC=0±100	24546	СТ4-1/8-ТО-1472-F
A3R19	0757-0416	7	4	RESISTOR 511 1% 1/8W F TC=0±100		CT4-1/8-T0-511R-F
A3R20	0757-0280	3	5	RESISTOR 1K 1% 1/8W F TC=0±100		СТ4-1/8-ТО-1001-F
A3R21	0757-0280	3		RESISTOR 1K 1% 1/8W F TC=0±100		СТ4-1/8-ТО-1001-F
A3R22	0757-0438	3		RESISTOR 5.11K 1% 1/8W F TC=0±100		СТ4-1/8-ТО-5111-F
A3R23	0698-3457	6		RESISTOR 316K 1% 1/8W F TC=0±100		0698-3457
A3R24	0757-0438	3	-	RESISTOR 5.11K 1% 1/8W F TC=0±100		СТ4-1/8-ТО-5111-F
A3R25	0757-0442	9	5	RESISTOR 10K 1% 1/8W F TC=0±100		CT4-1/8-T0-1002-F
A3R26	0757-0442	9 2		RESISTOR 10K 1% 1/8W F TC=0±100		СТ4-1/8-ТО-1002-F
A3R27 A3R28	0699-0069 0757-0443	2	2	RESISTOR 2.15M 1% 1/8W F TC=0±100 RESISTOR 11K 1% 1/8W F TC=0±100		0699-0069 CT4-1/8-T0-1102-F
A3R29	0757-0280	3	2	RESISTOR 1K 1% 1/8W F TC=0±100		CT4-1/8-T0-1001-F
A3R30	0698-3453	2	1	RESISTOR 196K 1% 1/8W F TC=0±100		CT4-1/8-TO-1963-F
A3R31	0698-3454	3		RESISTOR 215K .1% 1/8W F TC=0±100		CT4-1/8-T0-2153-F
A3R32	0699-0069	2	_	RESISTOR 2.15M 1% 1/8W F TC=±100		0699-0069
A3R33	0698-3454	3		RESISTOR 215K 1% 1/8W F TC=0±100		СТ4-1/8-ТО-2153-F
A3R34	0757-0394	0		RESISTOR 51.1 1% 1/8W F TC=0±100	24546	CT4-1/8-T0-51R1-F
A3R35	0757-0394	0		RESISTOR 51.1 1% 1/8W F TC=0±100	24546	CT4-1/8-T0-51R1-F
A3R36	0757-0442	9		RESISTOR 10K 1% 1/8W F TC=0±100	24546	СТ4-1/8-ТО-1002-F
A3R37				NOT ASSIGNED		
A3R38			_	NOT ASSIGNED		
A3R39	0698-3153	9	1	RESISTOR 3.83K 1% 1/8W F TC=0±100	24546	СТ4-1/8-ТО-3831-F
A3R40				NOT ASSIGNED		
A3R42	0608 0083	0	1	NOT ASSIGNED	24546	
A3R43	0698-0083	8 3	1	RESISTOR 1.96K 1% 1/8W F TC=0±100		CT4-1/8-T0-1961-F
A3R44 A3R45	0757-0438 0757-0416	3 7		RESISTOR 5.11K 1% 1/8W F TC=0±100 RESISTOR 511 1% 1/8W F TC=0±100		CT4-1/8-T0-5111-F CT4-1/8-T0-511R-F
A3R46	0698-3155	1		RESISTOR 311 1% 1/8W F TC=0±100 RESISTOR 4.64K 1% 1/8W F TC=0±100		CT4-1/8-T0-4641-F
A3R40	5556 JTJJ	1		NOT ASSIGNED	27370	
A3R48	1810-0374	1	3	NETWORK-RES 8-SIP 1.0K OHM X 4	11236	750-83-R1K
A3R49	0699-0071	6		RESISTOR 4.64M 1% 1/8W F TC=0±100		0699-0071
A3R50	0699-0069	2	-	RESISTOR 2.15M 1% 1/8W F TC=0±100		0699-0069
A3R51	0699-0071	6		RESISTOR 4.64M 1% 1/8W F TC=0±100	28480	0699-0071
A3R52	0757-0276	7		RESISTOR 61.9 1% 1/8W F TC=0±100		СТ4-1/8-Т0-6192-F
A3R53				NOT ASSIGNED		
A3R60						
	0757 0462	4		RESISTOR 82.5K 1% 1/8W F TC=0±100	24546	СТ4-1/8-ТО-8252-F
A3R61 A3R67	0757-0463 0698-0084	4		RESISTOR 2.15K 1% 1/8W F TC=0±100		CT4-1/8-T0-2151-F

Table 6-3. HP5501B Board Assemblies Replaceable Parts (Continued)

Reference Designation	HP Part Number	C D	Qty	Description	Mfr Code	Mfr Part Number
A3R63	0698-0084	9		RESISTOR 2.15K 1% 1/8W F TC=0±100	24546	СТ4-1/8-Т0-2151-F
A3R64	1810-0374	1		NETWORK-RES 8-SIP 1. OK OHM X 4	11236	
A3R65	1810-0374	1		NETWORK-RES 8-SIP 1 .OK OHM X 4		750-83-R1K
A3R66	0757-0416	7		RESISTOR 511 1% 1/8W F TC=0±100		
A3R67	1810-0367	2		NETWORK-RES 6-SIP 4.7K OHM X 5	11236	
A3R68	0698-0084	9		RESISTOR 2.15K 1% 1/8W F TC=0±100	24546	CT4-1/8-T0-2151-F
A3R69	0757-0443	0		RESISTOR 11K 1% 1/8W F TC=0±100	24546	
A3R70	0757-0280	3		RESISTOR 1K 1% 1/8W F TC=0±100		CT4-1/8-T0-1001-F
A3R71	0757-0442	9		RESISTOR 10K 1% 1/8W F TC=0±100		CT4-1/8-T0-1002-F
A3R72	0698-0084	9		RESISTOR 2.15K 1% 1/8W F TC=0±100		CT4-1/8-T0-2151-F
A3R72	0757-0442	9		RESISTOR 10K 1% 1/8W F TC=0±100	24546	CT4-1/8-T0-1002-F
A3R74	0757-0280	3		RESISTOR 1K 1% 1/8W F TC=0±100	24546	CT4-1/8-T0-1001-F
A3R75	0757-0230	7		RESISTOR 1/ 1/8W F TC=0±100		CT4-1/8-T0-511R-F
A3TP1	1251-5177	6	22	CONNECTOR-SGL CONT PIN .031-IN-BSC-SZ	28460	1251-5177
A3TP2	1251-5177	6		CONNECTOR-SGL CONT PIN .031-IN-BSC-SZ		1251-5177
A3TP3	1251-5177	6		CONNECTOR-SGL CONT PIN .031-IN-BSC-SZ		1251-5177
A3TP4	1251-5177	6		CONNECTOR-SGL CONT PIN .031-IN-BSC-SZ		1251-5177
A3TP5	1251-5177	6		CONNECTOR-SGL CONT PIN .031-IN-BSC-SZ		
A3TP6	1251-5177	6		CONNECTOR-SGL CONT PIN .031-IN-BSC-SZ		1251-5177
A3TP7	1251-5177	6		CONNECTOR-SGL CONT PIN .031-IN-BSC-SZ CONNECTOR-SGL CONT PIN .031-IN-BSC-SZ		1251-5177
A3TP8	1251-5177	6		CONNECTOR-SGL CONT PIN .031-IN-BSC-SZ		1251-5177
A3TP8 A3TP9	1251-5177	6		CONNECTOR-SGL CONT PIN .031-IN-BSC-SZ CONNECTOR-SGL CONT PIN .031-IN-BSC-SZ		1251-5177
		6				
A3TP10	1251-5177	-		CONNECTOR-SGL CONT PIN .031-IN-BSC-SZ		
A3TP11	1251-5177	6		CONNECTOR-SGL CONT PIN .031-IN-BSC-SZ		1251-5177
A3TP12	1251-5177	6		CONNECTOR-SGL CONT PIN .031-IN-BSC-SZ		1251-5177
A3TP13	1251-5177	6		CONNECTOR-SGL CONT PIN .031-IN-BSC-SZ		1251-5177
A3TP14	1251-5177	6		CONNECTOR-SGL CONT PIN .031-IN-BSC-SZ		1251-5177
A3TP15	1251-5177	6		CONNECTOR-SGL CONT PIN .031-IN-BSC-SZ		1251-5177
A3TP16	1251-5177	6		CONNECTOR-SGL CONT PIN .031-IN-BSC-SZ		1251-5177
АЗТР17	1251-5177	6		CONNECTOR-SGL CONT PIN .031-IN-BSC-SZ		1251-5177
A3TP18	1251-5177	6		CONNECTOR-SGL CONT PIN .031-IN-BSC-SZ	28460	1251-5177
АЗТР19	1251-5177	6		CONNECTOR-SGL CONT PIN. 031-IN-BSC-SZ		1251-5177
А3ТР20	1251-5177	6		CONNECTOR-SGL CONT PIN. 031-IN-BSC-SZ	28460	1251-5177
A3TP21	1251-5177	6		CONNECTOR-SGL CONT PIN .031-IN-BSC-SZ	28460	1251-5177
АЗТР22	1251-5177	6		CONNECTOR-SGL CONT PIN .031-IN-BSC-SZ	28460	1251-5177
A3U1	1820-1416	5		IC SCHMITT-TRIG TTL LS INV HEX 1-INP		SN74LS14N
A3U2	1820-2889	8	1	IC GATE TTL ALS AND TPL 3-INP	01295	SN74ALS11N
A3U3	1820-2468	3	2	IC FF TTL ALS D- TYPE POS-EDGE-TRIG	01295	SN74ALS74AN
A3U4	1820-2078	7	1	IC CNTR TTL LS DECD DUAL 4-BIT	01295	SN74LS490N
A3U5	1820-2635	2	1	IC GATE TTL ALS AND QUAD 2-INP	01295	SN74ALS08N
A3U6	1820-2096	9	1	IC CNTR TTL LS BIN DUAL 4-BIT	01295	SN74LS393N
A3U7	1826-0122	0		IC 7805 V RGLTR TO-220	07263	7805UC
A3U8	1820-2468	3		IC FF TTL ALS D-TYPE POS-EDGE-TRIG	01295	SN74ALS74AN
A3U9	1260-0510	0		TEST IC PACKAGE	28460	1260-0510
A3U10	1820-2466	7		IC TIMER CMOS	32293	ICM7555IPA
A3U11	1826-0753	3		IC OP AMP LOW-BIAS-H-IMPD QUAD 14-DIP-C		MC340048L
A3U12	1826-0416	5		IC SWITCH ANLG QUAD 16-DIP-C PKG		LF13331D
A3012 A3013	1826-0410	8		IC OP AMP LOW-BIAS-H-IMPD 8-DIP-P PKG		MLM308AP1
A3013 A3014	1826-0493	9		IC OP AMP LOW-BIAS-H-IMPD 8-DIP-P PKG IC OP AMP LOW-BIAS-H-IMPD 8-DIP-P PKG		TL071CP
A3U15	1826-0065	0		IC COMPARATOR PRCN 8-DIP-P PKG	27014	LM311N
						-
A3U16	1820-2668	1		IC DRVR TTL LINE DRVR DUAL 3 - INP		SN75114N
A3U17	1826-0775	9		IC 16-DIP-P PKG	28460	IDATQ
A3U18	1020 2502	~		NOT ASSIGNED	01205	
A3U19	1820-3562	6		IC BFR TTL ALS INV HEX		SN74ALS1005N
A3U20	1826-0428	9		IC 3524 MODULATOR 16-DIP-C	01295	SG3524J
A3U21	1820-1272	1	1	IC BFR TTL LS NOR QUAD 2-INP	01295	SN74LS33N
	0240 0007	0		A3 MISCELLANEOUS PARTS AND HARDWARE	20400	0240 0007
	0340-0907	8	1	INSULATOR-XSTR NYLON JUMPER-REMOVABLE FOR 0.025 IN SQUARE PINS	20480	0340-0907
	1258-0141	8	8	REFERENCE DESIGNATORS NOT USED: A3CR3-4, Q1-5, R1, R12-13, R37-38, R40-42, R47, and U18.	28480	1258-0141

Reference Designation	HP Part Number	C D	Qty	Description	Mfr Code	Mfr Part Number
A4	05501-60029	1	1	SAMPLER BOARD ASSEMBLY	28480	05501-60029
				SERIES 2632. REVISION B		
A4CR1	1990-0770	1	1	PHOTODIODE ID=30NA-MAX	32694	OP 913 (SELECTED)
A4P1	1251-6778	5	1	CONNECTOR 4-PIN F POST TYPE	28480	1251-6778
				A4 MISCELLANEOUS PARTS AND HARDWARE		
	0340-0907	8	1	INSULATOR-XSTR NYLON	28480	0340-0907
A5	05501-60102	1	1	LASER TUBE ASSEMBLY	28480	05501-60102
				NOT FIELD REPAIRABLE		
				SEE TABLE 6-1 FOR LASER TUBE REPLACEMENT PART NUMBERS.		
A6	05501-60101	0	1	SAMPLER ASSEMBLY	28480	05501-60101
	1990-0768	7	1	LIQUID CRYSTAL SWITCH	28480	1990-0768
	8160-0530	9	2	ELASTOMERIC CONNECTOR	28480	8160-0530

Table 6-3. HP5501B Board Assemblies Replaceable Parts (Continued)

Table 6-3. HP5501B Miscellaneous Chassis Parts (Continued)

Reference Designation	HP Part Number	C D	Qty	Description	Mfr Code	Mfr Part Number
A1	05501-60028	0	1	LASER HEAD MISCELLANEOUS CHASSIS CONNECTOR BD ASSEMBLY	28480	05501-60028
A2	None		1	Laser Drive Inc. <u>www.laserdrive.com</u> Cross referenced 11/2006		040-17075-00 101⊤-1500-3.5-1 HP1 15∨
A2	0950-4459	3	1	HIGH VOLTAGE POWER SUPPLY ASSEMBLY	28480	0950-4459
A3	05501-60027	9 1	1	CONTROL/REFERENCE BD ASSEMBLY	28480 28480	05501-60027
A4	05501-60029 05501-60102		1	SAMPLER BOARD ASSEMBLY		05501-60029 05501-60102
A5	05501-69202	1	1	LASER TUBE ASSEMBLY	28480	05501-69202
A6	05501-60101	0	1	SAMPLER ASSEMBLY	28480	05501-60101
H1	0510-0054	7	1	RETAINER-RING GRPR EXT .25-IN-DIA STL		0510-0054
H2 H3	0510-0252 0515-0490	7 5	2 2	ER DIVISION SCREW-SKT-HD-CAP M4 X 0.7 12MM-LG		0510-0252 0515-0490
H4	0515-0530	4	6	SCREW-SET M4 X 0.7 5MM-LG PLAIN-CUP-PT	00000	ORDER BY DESCRIPTION
н5	0515-0886	3	7	SCREW-MACH M3 X 0.5 6MM-LG PAN-HD	28480	0515-0886
н6	0515-0890	9	2	SCREW-MACH M3 X 0.5 6MM-LG 90-DEG-FLH-HD		0515-0890
H7	0515-0896	5	2	SCREW-MACH M4 X 0.7 10MM-LG		0515-0896
H8	0515-1129 0515-1322	9 4	8 2	SCREW-MACH M4 X 0.7 16MM-LG SCREW-MACH M3 X 0.5 30MM-LG		0515-1129 0515-1322
Н9 H10	0515-1322	4	4	SCREW-MACH M3 X 0.3 SOMM-LG SCREW-MACH M2.5 X 0.45 8MM-LG		0515-1351
H11	1390-0314	7	1	FASTENER-1/4-TURN ASSY PANEL THKNS		1390-0314
н12	2190-0584	0	2	WASHER-LK HLCL 3.0 MM 3.1-MM-ID		2190-0584
н13	2190-0586	2	2	WASHER-LK HLCL 4.0 MM 4.1-MM-ID	28480	2190-0586
н14	3050-0891	7	7	WASHER-FL MTLC 3.0 MM 3.3-MM-ID		3050-0891
н15	3050-0893	9	2	WASHER-FL MTLC 4.0 MM 4.4-MM-ID	28480	3050-0893
MP1	05501-00008	0	1	SAMPLER MOUNT	28480	05501-00008
MP2	05501-20215	3	1	LASER BASE		05501-20215
MP3	05501-20219	7	1	FRONT PANEL		05501-20219
MP4	05501-20221	1	1	REAR PANEL		05501-20221
MP5 MP6	05501-20222 05501-40003	2	3 1	FOOT SHUTTER MOUNT		05501-20222 05501-40003
MP0 MP7	05501-40004	0	1	SHUTTER		05501-40004
MP8	05501-60007	5	1	LEFT COVER (AS VIEWED FROM FRONT PANEL)		05501-60007
мр9	05501-00003	5	1	RIGHT COVER (AS VIEWED FROM FRONT PANEL)	28480	05501-00003
мр10	05501-00007	9	1	SHIELD	28480	05501-00007
P1 P2	1251-3450 1251-3447	4 9	1 1	CONNECTOR 4-PIN M CIRCULAR 45 (REFERENCE) CONNECTOR 4-PIN M CIRCULAR (POWER)	28480 28480	1251-3450 1251-3447
	5030-6770 1000-0616	2	1 1	WINDOWS-1.0 AIR TEST POLARIZER	28480 28480	5030-6770 1000-0616
	1000-0010	ĺ	Т		20400	1000-0010
	05501-80011	3	1	LABELS AND NAMEPLATES NAMEPLATE	28480	05501-80011
	5080-0098	1	1	LABEL-SERIAL NO.		5080-0098
	7120-2444 7120-3731	3 3	1 2	LABEL-5501B LASER LABEL-HIGH VOLTAGE WARNING		7120-2444 7120-3731
	7120-5731	0		LABEL-HIGH VOLTAGE WARNING		7120-5180
	7121-1650	3		LABEL-MFG DATE		7121-1650
	9320-1744	0		LABEL-MAGNETIC		9320-1744
	05500-80007	6	2	LABEL-CAUTION	28480	05500-80007
	05500-80008	7	1	LABEL-REGULATION	28480	05500-80008
1						

6-14. Exploded View

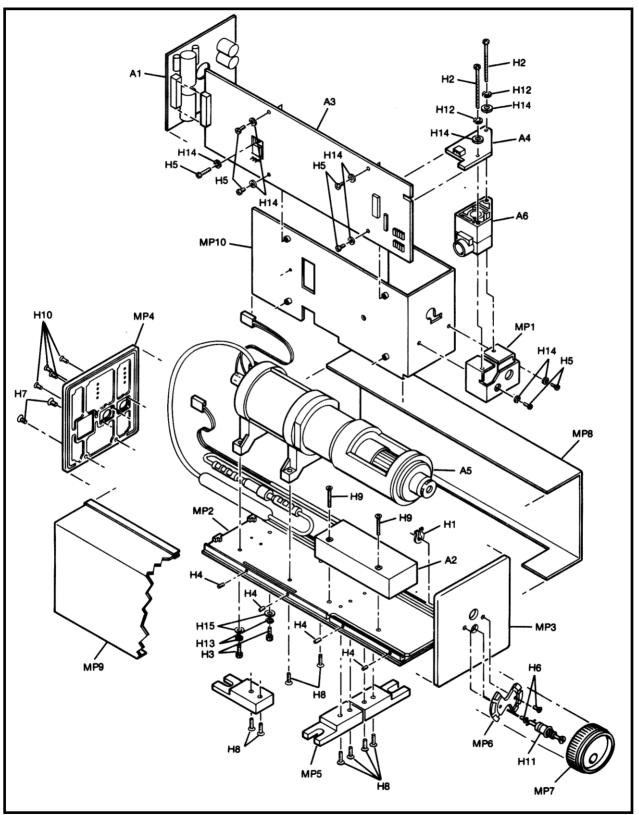


Figure 6-1. HP5501B Laser Head Exploded View

Mfr Code	Manufacturer Name	Address	Address				
00000	ANY SATISFACTORY SUPPLIER						
01295	TEXAS INSTRUMENTS INC	DALLAS	TX US	75265			
03508	GE CO SEMICONDUCTOR PROD DEPT	AUBURN	NY US	13201			
04713	MOTOROLA INC SEMI-COND PROD	PHOENIX	AZ US	85008			
07263	FAIRCHILD CORP	MOUNTAIN VIEW	CA US	94042			
11236	CTS CORP BERNE DIV	BERNE	IN US	46711			
14433	ITT SEMICONDUCTORS DIV	TUSTIN	CA US	92680			
16299	CORNING ELECTRONICS	RALEIGH	NC US	27604			
24546	CORNING ELECTRONICS	SANTA CLARA	CA US	95050			
27014	NATIONAL SEMICONDUCTOR CORP	SANTA CLARA	CA US	95052			
28480	HEWLETT-PACKARD CO CORPORATE HQ	PALO ALTO	CA US	94304			
31918	ITT SHADOW INC	EDEN PRAIRIE	MN US	55344			
32293	INTERSIL INC	CUPERTINO	CA US	95014			
32694	TRW OPTOELECTRONICS DIV	CARROLLTON	TX US	75006			
32997	BOURNS INC	RIVERSIDE	CA US	92507			
56289	SPRAGUE ELECTRIC CO	NORTH ADAMS	MA US	01247			
73138	BECKMAN INDUSTRIAL CORP	FULLERTON	CA US	92632			
9N171	UNIT RODE CORP	LEXINGTON	MA US	02173			
91637	DALE ELECTRONICS INC	EL PASO	TX US	79936			

Table 6-4. Manufacturer's Code List

7 MANUAL CHANGES

7-1. Introduction

7-2. This section normally contains information required to update or backdate this manual to cover newer or older instruments with serial prefixes different than those shown on the title page. Since this manual applies directly to new **HP5501B** units having the serial number prefix listed on the title page, no change information is given here. Refer to <u>INSTRUMENTS COVERED BY THIS MANUAL</u> in Section 1 for additional important information about serial number coverage.

7-3. Newer Instruments

7-4. As engineering changes are made, newer instruments may have a higher serial number prefix than that listed for the particular instrument. The manual shipped with a **HP5501B** Laser Head will include a "Manual Changes" sheet that describes all required changes to update the manual. If any of the instruments shipped with the system have a higher serial number than those listed on the title page and the" Manual Changes" sheet does not cover the prefix, contact your local HP Sales and Service Office for information.

8 SERVICE

8-1. Introduction

8-2. This section contains service information for the **HP5501B** Laser Head. Also included are safety considerations, theory of operation, block diagrams, schematic diagrams, component locators, and troubleshooting and repair procedures. Other useful service information also provided in other sections of this manual include: performance tests in <u>Section 4</u>, adjustments in <u>Section 5</u>, and exploded view illustrations and parts lists in <u>Section 6</u>.

8-3. Theory of Operation

- 8-4. The theory of operation is presented at two levels:
 - Block Diagram Description. These paragraphs describe the laser head's major functional blocks and modes of operation. The description references the HP5501B Laser Head Block Diagram, Figure 8-2.
 - Board Level Theory of Operation. These paragraphs are arranged by assembly number order and describe the circuitry at the component level. The descriptions are used with schematic diagrams for A1, A2, and A3.

8-5. Recommended Test Equipment

8-6. Table 1-2 in Section 1 lists the test equipment required for service. Any equipment that satisfies the critical specifications given in the table may be substituted for the recommended model (s).

8-7. Service Aids

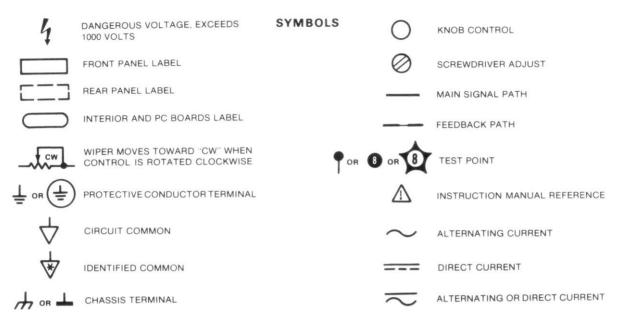
8-8. This system uses both Metric and English hardware. Figure 6-1 should be used to determine the correct hardware descriptions, part numbers and the proper tools to employ for assembly and disassembly.

8-9. Schematic Diagram Symbols and Reference Designations

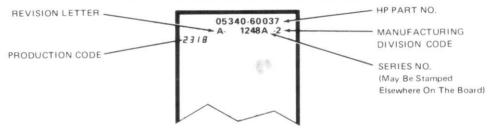
- 8-10. The logic symbology used on the schematic diagrams conforms to American National Standard (ANSI/IEEE Std. 91-1984). This standard supersedes MIL-STD-806B.
- 8-11. Figure 8-1 shows some of the symbols used on the schematic diagrams. In the center of this figure, the scheme for printed circuit board identification is presented. Also shown at the bottom of Figure 8-1 is the method used to identify reference designators, assemblies, and subassemblies.

NOTE

A TILDE ("~") PRECEDING A SIGNAL NAME (I.E., \sim REF ON) INDICATES NEGATIVE-TRUE LOGIC.



PRINTED CIRCUIT BOARD IDENTIFICATION



REFERENCE DESIGNATIONS

REFERENCE DESIGNATIONS WITHIN ASSEMBLIES ARE ABBREVI-ATED. ADD ASSEMBLY NUMBER TO ABBREVIATION FOR COM-PLETE DESCRIPTION. JACKS ARE THE STATIONARY CONNECTORS AND PLUGS ARE THE MORE MOVEABLE OF TWO CONNECTORS.

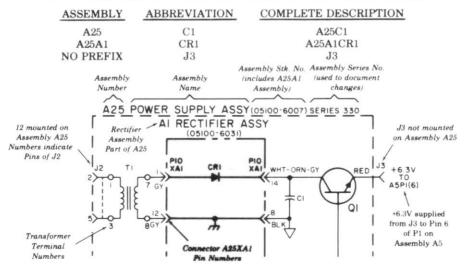


Figure 8-1. Schematic Diagram Notes

8-12. Safety Considerations

8-13. The following paragraphs contain warnings and cautions that must be followed for your protection and to avoid damage to the equipment.

WARNING

MAINTENANCE DESCRIBED HEREIN IS PERFORMED WITH POWER SUPPLIED TO THE EQUIPMENT AND WITH THE PROTECTIVE COVERS REMOVED. SUCH MAINTENANCE SHOULD BE PERFORMED ONLY BY SERVICE-TRAINED PERSONNEL WHO ARE AWARE OF THE HAZARDS INVOLVED (FOR EXAMPLE, FIRE AND ELECTRIC SHOCK). WHERE MAINTENANCE CAN BE PERFORMED WITHOUT POWER APPLIED, THE POWER TO THE EQUIPMENT SHOULD BE REMOVED.

WARNING

BEFORE ANY REPAIR IS COMPLETED, ENSURE THAT ALL SAFETY FEATURES ARE INTACT AND FUNCTIONING, AND THAT ALL NECESSARY PARTS ARE CONNECTED TO THEIR PROTECTIVE GROUNDING MEANS.

FROM 1.2 KILOVOLTS TO 12 KILOVOLTS DC IS PRESENT ON THE ANODE OF THE LASER TUBE IN THE HP5501B. EXERCISE EXTREME CAUTION WHEN WORKING INSIDE THE INSTRUMENT. THE HIGH VOLTAGE COULD CAUSE SERIOUS PERSONAL INJURY IF CONTACTED. THE INSTRUMENT SERVICE SHOULD BE PERFORMED BY SERVICE-TRAINED PERSONNEL ONLY.

NOTE

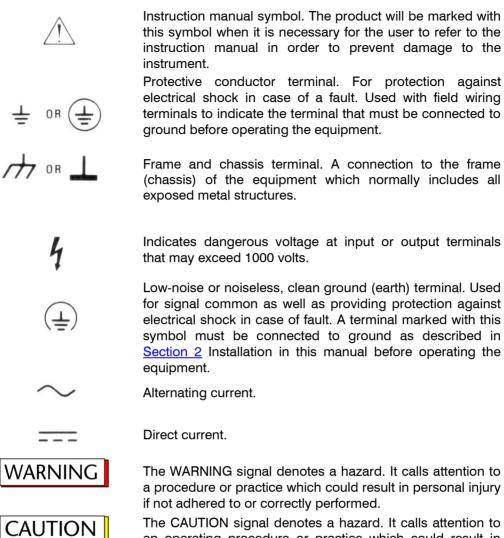
When the HP5501B covers are removed, the High Voltage Power Supply (HVPS), A2, is disconnected automatically by A1S1. For adjustments and servicing purposes, the High Voltage Power Supply can be reenabled by setting the TEST-NORM switch, A1S2; to TEST after the HP5501B covers are removed.

WARNING

LASER RADIATION IS ACCESSIBLE WHEN THE HP5501B COVERS ARE REMOVED AND THE TEST-NORM SWITCH, A1S2, IS IN THE TEST POSITION. AVOID EXPOSURE TO THE EYES.

8-14. Safety Symbols

8-15. The following safety symbols are used on the instrument or in this manual.



an operating procedure or practice which could result in damage or destruction to part of or the entire product if not adhered to or correctly performed.

8-16. Before and After Service Product Safety Checks

8-17. Visually inspect the interior of the serviced instrument for any signs of abnormal internally generated heat, such as discolored printed circuit boards or components, damaged insulation, or evidence of electrical arcing. Determine and remedy the cause of any such condition.

8-18. LASER HEAD BLOCK DIAGRAM DESCRIPTION

- 8-19. The major structures of the HP 5501B are shown on the HP 5501B Laser Head Block Diagram in Figure 82 and include the control electronics, laser assembly, sampler assembly, reference receiver, and the high voltage power supply. All of the necessary control signals for the operation of the HP 5501B are generated internally. Power requirements are ±15 Volts DC from external system power supplies.
- 8-20. Overall, the purpose of the laser head is to emit a collimated, dual frequency laser beam with a high degree of stability. A portion of the emitted beam (about 10%) is directed to the sampler assembly to establish a reference frequency while the main portion of the beam is directed to external optics and returned to an external measurement receiver to develop a measurement frequency. The system electronics compare the reference and measurement frequencies to calculate the relative displacement of the optics.
- 8-21. The control electronics determine the tuning of the laser assembly to ensure an accurate laser wavelength for making measurements. Two phases of tuning are used, warmup mode and optical mode. When the desired characteristics of the laser beam are obtained during the optical mode, the system is ready to make measurements.
- 8-22. The laser assembly optics ensures correct laser frequency polarizations and also collimates the laser beam. Collimating minimizes variations in the diameter of the beam as it travels away from the laser head. Laser frequency F2 is polarized in a plane parallel to the base of the HP 5501B chassis. The other laser frequency F1 is polarized perpendicular to F2. The difference between the two laser frequencies F1 and F2 is small compared to their optical frequencies. The exit aperture shutter of the turret assembly has three positions. The first blocks the laser beam entirely; the second allows a small diameter laser beam to exit for optical alignment purposes; and the third passes the entire laser beam.
- 8-23. Before the laser light is emitted from the HP 5501B, a portion of it is sampled by the sampler assembly. Most of this sample feeds into the reference receiver while the remainder is used to control laser tuning. The reference receiver generates the reference frequency signal by mixing the two laser frequencies. The reference frequency is a 1.5 to 2.0 MHz, TTL level square wave. When the laser tuning stabilizes, the reference frequency is sent to the system electronics.
- 8-24. During a measurement, the laser beam follows a path through external measurement optics and to the HP 10780A Receiver. If the optics remain stationary, the measurement frequency and the reference frequency are the same. Relative motion between the measurement optics result in a change of the measurement frequency. The electronics compare the measurement frequency to the reference frequency and calculate the displacement of the optics. The measurement frequency output from the HP 10780A system receiver requires proper alignment of measurement optics in addition to stable laser tuning.
- 8-25. The High Voltage Power Supply (HVPS) requires -15 Vdc as input. This supply generates up to 12 kilovolts DC at power-on. After the laser emission starts, the power supply output drops to approximately 1.2 kilovolts DC.

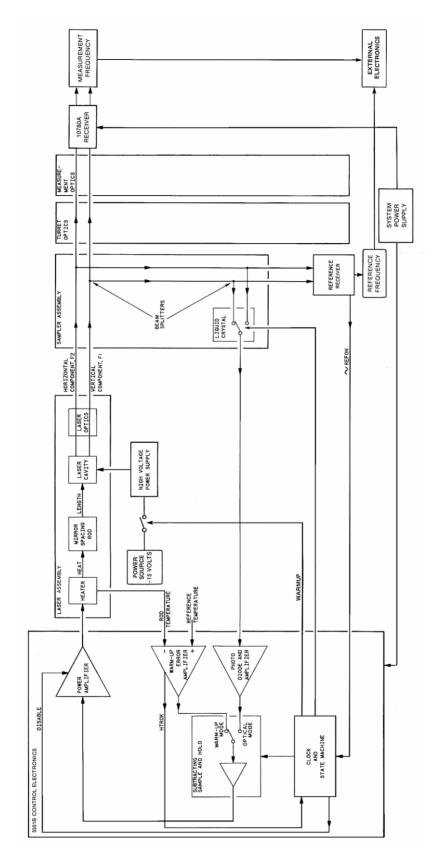


Figure 8-2.HP5501B Laser Head Block Diagram

8-26. Laser Tuning

- 8-27. The laser assembly produces stable frequency components only when the laser assembly cavity length is properly controlled. The cavity length is determined by the separation of two mirrors that are held against the ends of a glass rod. The HP 55018 uses a thermal tuning technique to control the cavity length. Cavity length increases when the rod is heated and decreases when it cools.
- 8-28. A heater coil wrapped around the glass rod is used to increase the cavity length. Rod cooling by conduction to surrounding material is used to decrease cavity length. To properly control the rod temperature, the rate at which it cools should approximate the rate at which it is heated. The HP 55018 raises the cooling rate by maintaining the rod at an elevated temperature.

8-29. Warmup Mode Tuning

8-30. One of two feedback loops used to control the laser assembly establishes the initial operating temperature of the glass rod. When power is first applied to the HP 55018, the state machine (see Figure 8-3) resets to its warmup mode. In the warmup mode, the state machine controls the subtracting sample and hold so that the feedback is as shown in Figure 8-4. The warmup error amplifier produces an error signal that is proportional to the difference between the rod temperature and a reference temperature. The warmup mode feedback loop controls the rod temperature until it equals the reference temperature. The reference temperature is adjustable and factory set to be higher than the hottest expected ambient temperature.

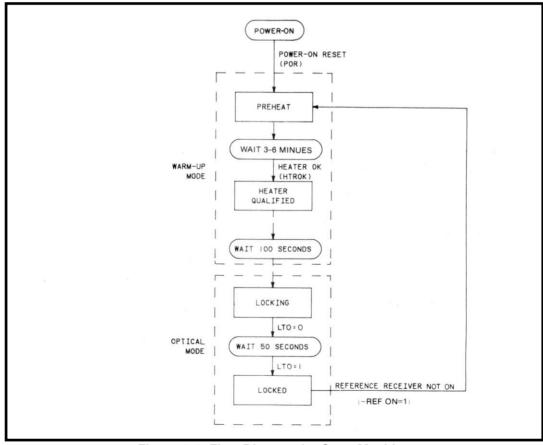


Figure 8-3. Flow Diagram for State Machine

8-31. The heater coil is used both to heat the rod and to sense its temperature. For 2.56 seconds (nominal) out of every 25.6 seconds (nominal) of the warmup cycle (see Figure 8-5), the state machine disables the power amplifier and the heater allowing the heater coil to stabilize to the rod temperature. The heater coil and a resistor in the power amplifier (A1R15) form a voltage divider. As the heater resistance increases with rising temperature, the divider voltage increases. The difference between this voltage and the reference voltage is amplified to provide the warmup mode error signal.

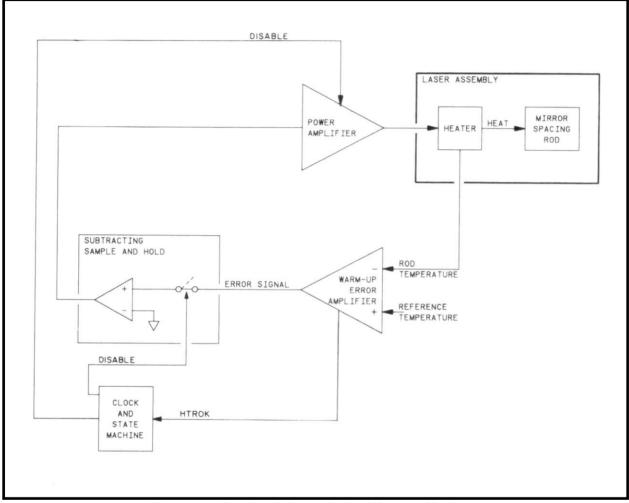


Figure 8-4. Feedback Loop during Warmup Mode

- 8-32. At the end of the 2.56 second disable period, the heater coil temperature has settled to the rod temperature. The error signal is sampled and held and the power amplifier is enabled. During the remainder of the 25.6 second period, the power amplifier, re-enabled and under control of the sampled error signal, drives the heater.
- 8-33. When the error signal gets close to zero, the warmup error amplifier sends a digital signal called HEATER OK (HTR OK) to the state machine. HTR OK is sampled by the state machine whenever the error signal is sampled. After HTR OK is sampled true, the state machine waits 100 seconds before switching to optical mode.

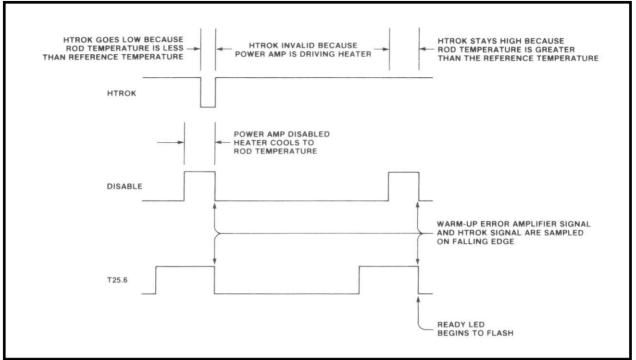


Figure 8-5. Warmup Mode Timing Diagram

8-34. Optical Mode Tuning

8-35. In optical mode, the state machine switches the subtracting sample and hold inputs from warmup feedback to optical feedback as shown in Figure 8-6. The optical mode feedback controls the laser cavity length by measuring and comparing the power of the two laser frequency components. Cavity length is controlled such that the difference in power is zero. When the difference is maintained at zero, the desired characteristics of the laser beam are established and a measurement can be performed.

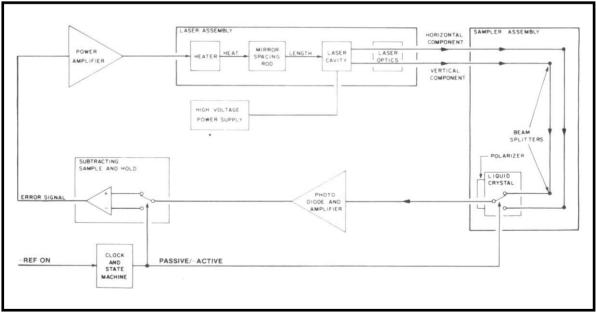


Figure 8-6. Feedback Loop During Optical Mode

8-36. The power in each laser frequency component is measured by sampling some of the laser light with a pair of non-polarizing beam splitters (see Figure 8-7) and passing one of the laser frequency components, then the other, through an optical switch and onto a photodiode. The beam splitters are part of the A6 Sampler Assembly and the photodiode is mounted on the A4 Sampler Board. A liquid crystal and a polarizer comprise the optical switch.

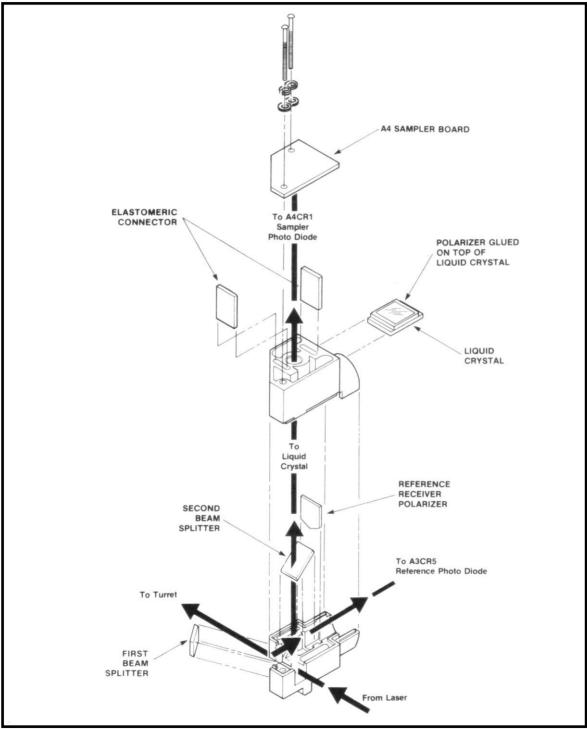


Figure 8-7. A6 Sampler Assembly, Exploded View

- 8-37. When the state machine excites the liquid crystal into its active state (see Figure 8-8), the laser beam passes through the liquid crystal unaltered. The polarizer blocks the horizontal component and passes the vertical component onto the photodiode. The photodiode current is proportional to the power in the vertical component and is amplified and converted to a voltage by the photodiode amplifier. The voltage is held on the positive input of the subtracting sample and hold circuit.
- 8-38. When the state machine places the liquid crystal in its passive state, the liquid crystal rotates the polarization of both components by 90 degrees. In this state, the polarizer blocks the vertical component and passes the horizontal component. The voltage out of the photodiode amplifier is proportional to the horizontal component and is held by the negative input of the subtracting sample and hold circuit. The error signal output of the subtracting sample and hold circuit is proportional to any difference in power between the two components.

NOTE

A TILDE ("~") PRECEDING ALL SIGNALS INDICATES NEGATIVE-TRUE LOGIC.

8-39. After the optical mode tuning has stabilized; LOCKED TUNED OPTICAL (LTO) signal is held true enabling the reference frequency output. Proper laser tuning and reference receiver operation is indicated by ~REF ON true. ~REF ON false will cause the state machine to reset to the warmup mode.

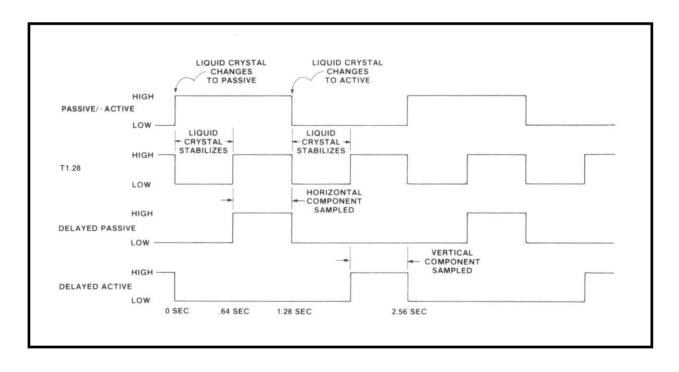


Figure 8-8. Liquid Crystal Timing Diagram (Optical Mode)

8-40. Laser Assembly Optics

8-41. The laser assembly optics ensures correct laser frequency polarizations and also collimates the laser beam. When the laser beam leaves the laser assembly, the horizontal component is polarized parallel to the base of the **HP5501B**. The vertical component is polarized perpendicular to the horizontal component. The laser beam is collimated to minimize variations in beam diameter as it travels away from the laser head.

8-42. Reference Receiver

8-43. The beam splitters of the A6 Sampler Assembly direct some of the laser light through a second 45° polarizer and onto another photodiode. Because of the polarization orientation, the beam power after this polarizer varies sinusoidally at the difference frequency of the two laser frequency components. The beam power at the difference frequency is converted to current by the photodiode and amplified to TTL levels. The frequency of the TTL output is the reference frequency. The reference receiver electronics also provide a digital signal called REFERENCE RECEIVER ON (REF ON) that tells the state machine the laser is working properly

8-44. Shutter Mechanism

8-45. The exit aperture shutter of the shutter (turret) assembly has three positions. The first blocks the laser beam entirely; the second allows a small diameter laser beam to exit for optical alignment purposes; and the third passes the entire laser beam.

8-46. ASSEMBLY/SCHEMATIC LOCATIONS OF HP5501B BLOCK DIAGRAM ELEMENTS

ELEMENT	HP5501B ASSEMBLY
Control Electronics	A3 and A4
Power Amplifier Warmup Error Amplifier Subtracting Sample & Hold Photodiode & Amplifier Clock and State Machine	A1 and A3 A3 A3 A4 and A3 A3
Laser Assembly	A5
Sampler Assembly	A6
Reference Receiver	A3 and A6

8-47. REAR PANEL LED INDICATORS

8-48. The diagnostic LED's, mounted on the **HP5501B**'s rear panel, provide status information on power supply input (±15 Volts), fuses, laser output and tuning, and the reference frequency output. See Figure 3-2 for a more detailed description of the LED's.

8-49. BUILT-IN TEST AIDS

8-50. Several jumpers are included to aid in testing. The RESET jumper, JMP1, places the state machine in a repetitive mode to allow signature measurements. The ~REF ON jumper, JMP2, sets the ~REF ON signal so that U17 cannot influence the state machine. LIQ CRYS jumper, JMP3, places the liquid crystal in either the active or passive state. The HTR OK jumper, JMP4, sets the HTR OK signal so that U15 cannot influence the state machine. JMP5, PHOTO DIODE, substitutes a known current for the photodiode and is used for testing the photodiode amplifier and the subtracting sample and hold circuits. JMP6, POWER AMP, supplies ±100 mV to U13 (Pin 3) to test the power amplifier. JMP7, HEATER, disables the power amplifier. The CLK FREQ, JMP8, allows the clock circuitry to generate either of the following three clock rates: NRM = 100 Hz, HI = 1000 Hz, and with the jumper removed completely =75 kHz. Test IC U9 is dummy 16-pin DIP package with no integrated circuit. All of the important digital signals connect to U9 so that a logic clip can be used for monitoring.

NOTE

There are two "LO" positions for the REF ON jumper, and two "UP" positions for the POWER AMP jumper. For proper placement, refer to the schematics for A3 when using these jumpers.

8-51. The following is a summary of the signal functions on U9:

Table 8-1.	A3U9	Test	IC	Signal	Summary

PIN	PURPOSE
1, 2, 3, 4	Timing of sample and hold during optical mode.
5,6	Timing of sample and hold during warmup mode.
7, 10	Liquid crystal drive
9	Presets digital circuitry
11, 12, 13	Indicates state of the state machine
14, 15	Inputs to the state machine

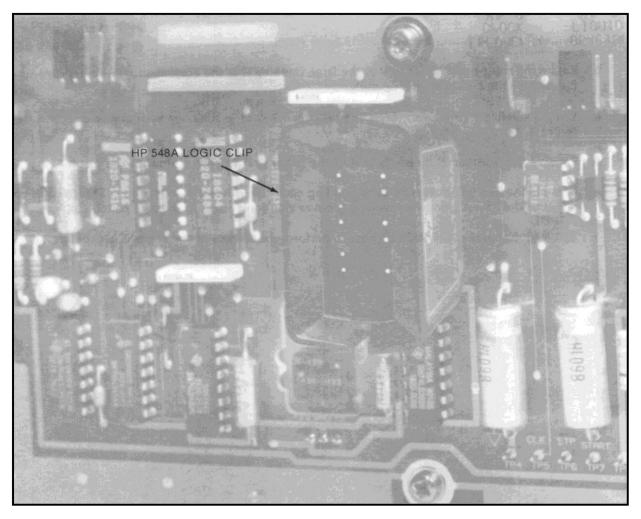


Figure 8-9. Logic Clip Monitoring of Test IC U9

8-52. ASSEMBLY REMOVAL INSTRUCTIONS

- 8-53. Figure 6-1, the exploded view diagram in <u>Section 6</u>, shows the **HP5501B** assembly locations, provides access and removal information, and gives assembly part number references.
- 8-54. Access to the assemblies within the laser head is required to troubleshoot or adjust the laser head circuits. The following paragraphs describe how to remove the laser head covers and how to remove and reinstall the major assemblies.

WARNING

HIGH VOLTAGES ARE GENERATED WITHIN THE LASER HEAD HOUSING. THE COVERS OF THE LASER HEAD CONTROL A SAFETY INTERLOCK SWITCH (A1S1) TO PREVENT ACCIDENTAL ACCESS TO THESE VOLTAGES. TO ENSURE SAFETY AND POSSIBLE EQUIPMENT DAMAGE, HOWEVER, ALWAYS DISCONNECT THE POWER SOURCE FROM THE LASER HEAD BEFORE REMOVING THE COVERS.

- 8-55. To remove the front panel and side covers from the laser head, perform the following procedure:
 - a. Remove ±15 Volt power from **HP5501B** Laser Head.
 - b. Rotate the front-panel turret so that the large opening is at the bottom and the slotted, 1/4-turn fastener is visible through the opening.
 - c. Using a suitable screwdriver, rotate the fastener 1/4-turn in the counterclockwise direction (see *Figure 8-10*).
 - d. Remove the front panel by gently pulling the panel straight away from the laser head.
 - e. Remove the two half-covers by gently pulling each cover outward and forward. This releases the edges of the covers from the retaining grooves along the edges of the rear panel.
 - f. To install the front panel and side covers, perform the reverse of the removal procedure.



Figure 8-10. HP5501B Front Panel and Side Cover Removal

- 8-56. To remove the A1 Connector Board Assembly from the **HP5501B** chassis, perform the following procedure.
 - a. Remove ±15 Volt power from **HP5501B** Laser Head.
 - b. Remove front panel and side covers as described in paragraph 8-55.
 - c. Remove two Pozidriv screws (H7) that secure rear panel (MP4) to laser base (MP2).
 - d. Remove four Pozidriv screws (H10) that secure A1 Connector board to rear panel assembly (MP4).
 - e. Remove A3 Reference/Controller Board Assembly as described in paragraph 8-58.

- f. Disconnect A2 High Voltage Power Supply and A5 Laser Assembly cabling from A1 Connector Board. These wires connect to A1J3 and A1J4 respectively.
- g. Remove A1 Connector Board Assembly.
- h. To install the A1 Connector board Assembly, perform the reverse of the removal procedure.
- 8-57. To remove the A2 High Voltage Power Supply from the **HP5501B** chassis, perform the following procedure.
 - a. Remove ±15 Volt power from **HP5501B** Laser Head.
 - b. Remove front panel and side covers as described in paragraph 8-55. e. Remove the A5 Laser Assembly as described in paragraph 8-60.
 - c. Disconnect A2 High Voltage Power Supply cable connector A2P1 from connector A1J3.
 - d. Remove two Pozidriv screws (H9) that fasten the A2 assembly to the laser base (MP2).
 - e. Remove A2 High Voltage Power Supply from laser head chassis.
 - f. To install the laser assembly, perform the reverse of the removal procedure.
- 8-58. To remove the A3 Reference/Controller Board Assembly from the **HP5501B** chassis, perform the following procedure.
 - a. Remove ±15 Volts from **HP5501B** Laser Head.
 - b. Remove front panel and side covers as described in paragraph 8-55.
 - c. Remove Pozidriv screw (H5) and flat washer (H14) that secures voltage regulator A3U7to the shield.
 - d. Remove four Pozidriv screws (H5) with flat washers (H14) that secures A3 assembly to the shield.
 - e. Gently extend front-panel end of A3 away from shield in order to disengage A3J2 from A4P1 and also for A3 to clear the A4 Sampler Board tab. Disengage A3J1 from A1J1 and remove A3 from **HP5501B** chassis.
 - f. To install the laser assembly, perform the reverse of the removal procedure.
- 8-59. To remove the A4 Sampler Board and/or the A6 Sampler Assembly from the **HP5501B** chassis, perform the following procedure.
 - a. Remove ±15 Volt power from **HP5501B** Laser Head.
 - b. Remove front panel and side covers as described in paragraph 8-55.
 - c. Remove A3 Reference/Controller Board Assembly as described in paragraph 8-58.
 - d. Remove two Pozidriv screws (H2), lock washers (H12), and flat washers (H14) that fasten the A4 Sampler board and Sampler Assembly to the sampler mount (MP1).
 - e. Gently remove the A4 Sampler board and sampler assembly.
 - f. To install the A4 Sampler board and/or the sampler assembly, perform the reverse of the removal procedure.

NOTE

Sampler Mount (MP1) is adjusted at the factory to ensure that the laser beam is not truncated as it exits the laser head. Two screws (H5) secure the Sampler Mount to the shield (MP10).

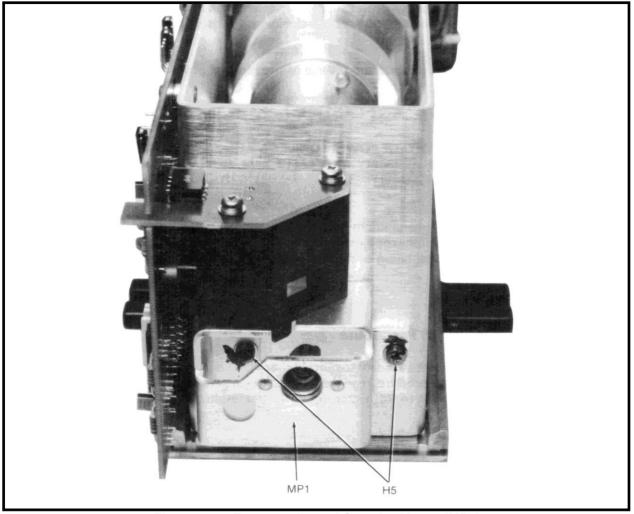


Figure 8-11. Factory-adjusted Sampler Mount (MP1)

- 8-60. To remove the A5 Laser Assembly (HP Part No. 05501-60102) from the **HP5501B** chassis, perform the following procedure.
 - a. Remove ±15 Volt power from **HP5501B** Laser Head.
 - b. Remove front panel and side covers as described in paragraph 8-55.
 - c. Disconnect laser assembly connector A5P1 from A1J4.
 - d. Remove two Pozidriv screws (H7) that secures rear panel (MP4) to laser base (MP2).

- e. Remove four Pozidriv screws (H10) that secure A1 Connector board to rear panel assembly (MP4).
- f. With rear of laser head facing you, tilt the top edge of the A1 assembly toward you. This will give ample clearance to remove the laser assembly.
- g. Remove two Pozidriv screws (H8) from laser base. Secure the laser assembly to ensure that it doesn't move. Remove two set screws (H3), associated lock washers (H13), and flat washers (H15) using a 3.0 mm Allen wrench.
- h. Remove laser assembly from laser head chassis.
- i. Disconnect the tube's high voltage power supply lead from the A2 High Voltage Power Supply by rotating the black, knurled fastener in the counterclockwise direction; prevent the wire's rotation as you unscrew the fastener.
- j. To install the laser assembly, perform the reverse of the removal procedure.



ENSURE A2 HIGH VOLTAGE POWER SUPPLY CABLES ARE NOT PINCHED BETWEEN A5 LASER ASSEMBLY AND LASER BASE DURING REINSTALLATION OF LASER ASSEMBLY.

8-61. The laser assembly consists of an aluminum housing, laser tube, magnets, telescope and the quarterwave/half-wave plate assembly. The telescope expands and collimates the beam. The quarter-wave plate and half-wave plate establish the orientation of the two laser beam components.

8-62. TROUBLE ISOLATION

8-63. Quick Tuning Checkout Procedure

8-64. The following procedure provides a means to quickly check the entire optical tuning subsystem of the laser head. Before performing the procedure, read the information in paragraphs 8-26 through 8-39 to gain the necessary background information to aid in interpreting the test results. Figure 8-12 illustrates the effects of mirror spacing on F1 and F2.

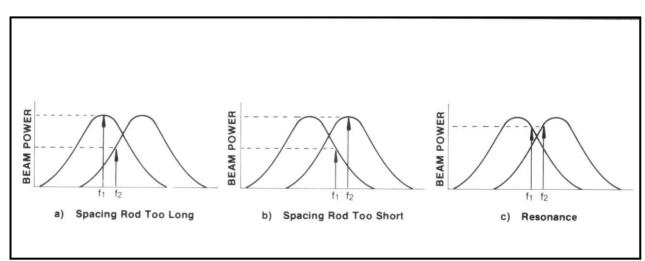


Figure 8-12. Laser Tube Tuning Characteristics

- 8-65. This procedure consists of monitoring test point TP16 on A3 with an oscilloscope to determine the relative amplitudes of F1 and F2 with the heater turned off. If the sampler, photodiode, and amplifier are functioning properly and the heater is turned off, the traces on the oscilloscope will show switching to different levels as it monitors the sampling of F1 and F2. With continued observation of the trace switching, these levels which correspond to F1 and F2 will change amplitudes since the tuning is uncontrolled.
- 8-66. To perform the quick isolation procedure, proceed as follows:
 - a. Observe the READY LED on the rear panel of the **HP5501B**. If after approximately 6 minutes from power-up (cold start), the LED begins flashing, you can assume that the clock, dividers, state machine, warmup and power amplifier stages are working properly.
 - b. Remove the **HP5501B** covers as described in paragraph 8-55.
 - c. Connect a dc-coupled oscilloscope to A3TP16 on A3 as shown in Figure 8-13. Also see Figure 8-24 (Component Locator) for test point locations.

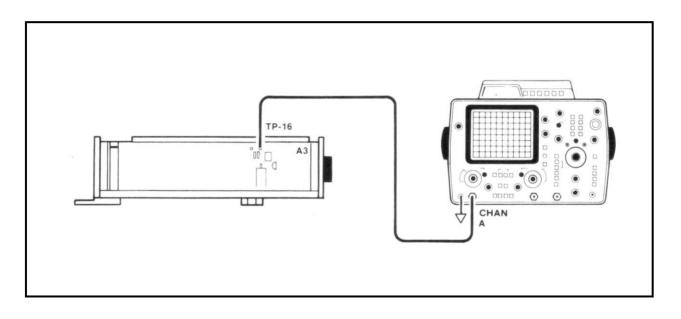


Figure 8-13. Quick Tuning Check Test Setup

- d. Enable the laser high voltage section by setting the TEST-NORMAL switch (A1S2) on A1 Connector board to TEST.
- e. On A3, change HEATER jumper, JMP 7 from NRM to OFF.
- f. Set oscilloscope controls as follows:
- g. Timebase to 2 milliseconds/division or faster.
- h. Trigger to normal. Adjust the triggering for minimum flickering of the trace.
- i. Vertical attenuator to 0.05V /division for X10 probe use or to 0.5V /division when using a direct probe. Set coupling to DC.
- j. To simulate a failure to observe how the waveforms at TP16 behave, move JMP 3 LIQ CRYS jumper to ACT. Note that the scope trace wanders up and down in a very smooth continuous manner with varying speed. If this occurs in step h, the liquid crystal switch or A3U11 is defective. Return JMP 3 LIQ CRYS jumper to original position.

k. If the sampler, photodiode, and amplifier are working properly, the oscilloscope display will show the trace switch between two distinct levels. See Figure 8-14 below. With continued observation these levels, which correspond to F1 and F2, will change amplitudes since the tuning is uncontrolled. The difference between the levels varies with time between a maximum difference and a minimum difference.

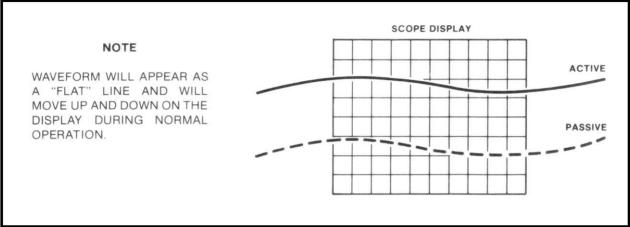


Figure 8-14. Quick Tuning Check Waveform Display

I. Disconnect the test equipment and set HEATER jumper JMP7 to NRM. Set TEST-NORM switch to NORM and replace **HP5501B** covers.

8-67. Testing the Liquid Crystal Switch

- 8-68. The following material and test equipment is required for the test:
 - a. A white piece of cardboard.
 - b. 50 Hz Square Wave Generator (TTL Level)
 - c. Test Polarizer (HP Part Number 1000-0616)
- 8-69. To test the liquid crystal, proceed as follows:
 - a. Remove the liquid crystal from the sampler assembly as shown in Figure 8-15 below:

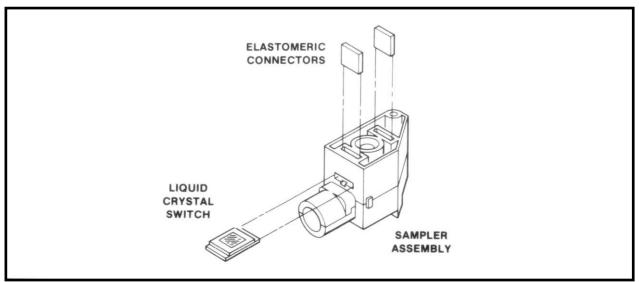
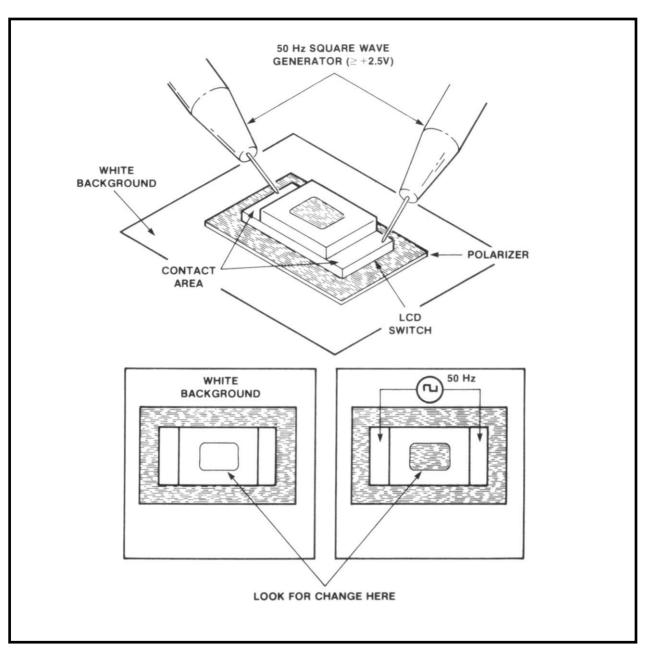


Figure 8-15. Liquid Crystal Removal



b. Place the liquid crystal in the test setup shown in Figure 8-16 below:

Figure 8-16. Liquid Crystal Test Setup

Do not apply DC voltages across the liquid crystal switch. Sustained dc current flow through the liquid crystal may damage the device.

c. Gently place the probes of the 50 Hz signal source on the end shoulders of the liquid crystal as shown in Figure 8-16 and observe the window area; it should go from light to dark while probing the device. A faint change of color or no change indicates a faulty liquid crystal. The replacement HP part number for the liquid crystal is 1990-0768.

8-70. HP5501B Trouble Isolation Procedures

8-71. Before **HP5501B** trouble isolation is attempted; the Laser Head Block Diagram Description (paragraphs 8-18 through 8-45) should be read. All electronic tests can be performed using an HP 5005A/B Signature Multimeter.



WITH THE HP5501B COVERS REMOVED AND A1S2 SET TO THE TEST POSITION, VOLTAGES OF UP TO 12 KV WILL BE PRESENT AT THE OUTPUT OF THE HIGH VOLTAGE POWER SUPPLY ASSEMBLY A2.

NOTE

After servicing the HP5501B, be sure to set A1S2 to the NORM position, otherwise power will be disconnected.

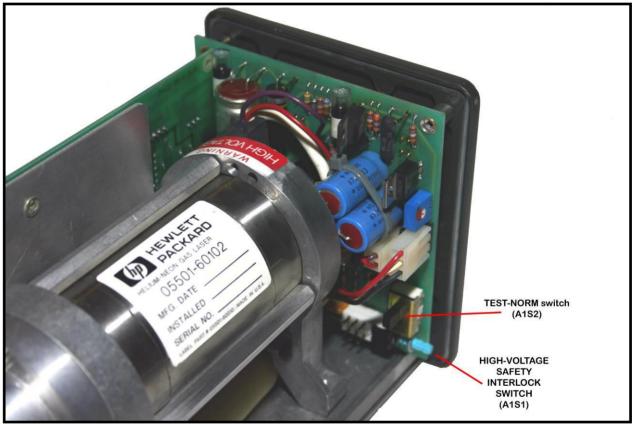


Figure 8-17. HP5501B TEST-NORM Switch A1S2

8-72. Procedure

- a. Apply power to the **HP5501B**.
- b. Wait until rear panel LED's finish sequencing (see *Table* 3-1). The LED's should reflect the following status.

+15V SUPPLY UNBALANCEOFF	+15V POWER ONON
-15V SUPPLY UNBALANCEOFF	-15V POWER ONON
+15V FUSEOFF	READY ON
-15V FUSEOFF	LASER ON ON

- c. If laser light is not emitted from the laser head, check that the exit shutter is open. Otherwise, see High Voltage Power Supply Troubleshooting in paragraph 8-89. Within 10 minutes of turn-on, the HP5501B's READY LED indicator should turn on continuously, and the REFerence frequency signal should have been applied to the rear panel REFERENCE SIGNAL connector. Otherwise proceed with step d of this procedure. If the failure mode occurs after the 5501B has reached the optical tuning mode (normal operation), skip steps d through k of this procedure. Steps d through k address failures that prevent the laser from reaching stable tuning.
- d. Disconnect power and remove the covers of the **HP5501B**. Set A1S2 to TEST and verify that all boards are seated correctly and all test jumpers on the A3 board are in the left-most position (NRM).
- e. Connect power. Check the following voltages. If any are incorrect, see Power Supply Troubleshooting in A3 Troubleshooting Procedures (paragraph 8-151 or see A1 Connector Board Troubleshooting Procedures (paragraph 8-84):

WARNING

WITH A1S2 IN THE TEST POSITION, THE HP5501B HIGH VOLTAGE POWER SUPPLY IS ENABLED WHEN THE LASER HEAD IS IN OPTICAL MODE.

A3TP8:	+14.7V to +15.3V
A3TP9:	+4.75V to +5.25V
A3TP10:	-14.7V to -15.3V

- f. Disconnect power for a few seconds, then reconnect. Observe READY LED on the **HP5501B**. Find the READY LED description in steps **g** through **j** that matches your observation and follow that step.
- g. READY LED (green) takes longer than 6 minutes to start to blink. Either the digital section is not working or the heater is not being heated properly. Check the following procedures:
 - A3 Digital Section
 - A3 Power Amplifier
 - A3 Warm-Up Error Amplifier
 - A3 Subtracting Sample and Hold

- h. READY LED (green) blinks within 6 minutes, blinks for less than approximately 150 seconds, goes off, and then repeats this action. This indicates that the warmup mode feedback is not properly controlling the heater voltage. Check the following procedures:
 - A3 Power Amplifier
 - A3 Warm-Up Error Amplifier
 - A3 Digital Section
 - A3 Subtracting Sample and Hold
- READY LED (green) blinks within 6 minutes, blinks for less than approximately 150 seconds, come on for one second (twice as long as when it is blinking) then goes off briefly. This action is then repeated. (An equivalent observation is LTO line [A3U9 (Pin 11)] comes on for 1 second every few minutes). Either the optical mode feedback is not working or the reference receiver is defective. See Quick Tuning Checkout Procedure, paragraph 8-64, and Reference Receiver Troubleshooting, paragraph 8-152.
- j. READY LED (green) blinks within 5 or 10 seconds, comes on for a few minutes after approximately 3 minutes, and then starts blinking again. Check A1/ A3 Power Amplifier section; especially A3U20 and A1Q5-9.
- k. Any other READY LED (green) observation indicates a defective digital section. See A3 Digital Section Troubleshooting, paragraph 8-138.
- Ι. If a REFerence frequency signal error is indicated after the laser has successfully reached normal operation (READY LED on continuously and REFerence frequency signal output) then make the following observation. Does the READY LED extinguish when the failure occurs? If so, the optical tuning may be failing or the reference receiver may be resetting the state machine due to marginal signal strength. Use the Laser Power Output Test (paragraph 4-11) as a check of the laser assembly and Quick Tuning Checkout Procedure to get an indication of the function of the optical tuning subsystem before proceeding with lower level testing. Use the Reference Receiver Troubleshooting Procedure, paragraph 8-152, to check signal level if the laser assembly and tuning circuits appear to be functioning properly. If the READY LED does not extinguish, spurious errors may be occurring on the REFerence frequency signal. Various internal and external noise or interference may be responsible. Check A3 ground connections and Vcc coupling capacitors. Check that the HP5501B covers are fastened securely. Marginal optical signal to the reference receiver may aggravate noise problems. Check for adequate signal according to Reference Receiver Troubleshooting, paragraph 8-152. Improper system grounding may also cause noise problems, see Section 2.

8-73. A1 CONNECTOR BOARD CIRCUIT THEORY

- 8-74. The A1 Connector Board interconnects the main laser cable, laser tube heater and power amp, laser power supply, and the A3 Controller/Reference Board. The schematic diagram for A1 is shown in Figure 8-23. Additional information covering heater power amp control circuitry can be found in paragraph 8-119.
- 8-75. Capacitors A1C1 through A1C4 serve to filter out noise on the ±15 Volt power supply lines. Capacitors A1C6 and A1C7 and inductors A1L1 and A1L2 filter current spikes created by the high voltage power supply and the switching power amplifier. Diodes A1CR1 and A1CR2 provide reverse voltage protection. Switch A1S1 is a safety interlock which removes power from the laser high voltage power supply when the **HP5501B** covers are removed. Switch A1S2 bypasses the interlock so that the laser can be serviced. A1S1 and A1S2 are wired in such a way that the interlock must be enabled before replacing the covers. A1F1 and A1F2 protect the system against laser power supply failures. A1J4 is the connector for the laser tube heater and cathode. A1DS3 and A1DS4, +15V POWER ON and -15V POWER ON LED's respectively, turn on when the power cable is connected to POWER connector A1J5. A1DS7 (LASER ON LED) lights when the high voltage supply is powered on, and A1DS8 (READY LED) lights when the **HP5501B** is ready for use. A1R12 is used to adjust laser current as per the adjustment procedures in <u>Section</u> 5.

8-76. High Voltage Power Supply Switch (A1Q3 and A1Q4)

- 8-77. When optical mode begins, the laser beam should be on. This is accomplished by applying the -WARMUP logic line through current limiting resistor A1R10 to the base of transistor A1Q4. A1Q4 saturates which, in turn causes A1Q3 to turn on and saturate. The high voltage power supply senses ground through saturated A1Q3, thus turns on.
- 8-78. If the **HP5501B** left and right covers are placed on the unit prior to resetting the TEST-NORM switch (A1S2) to NORM; both SUPPLY UNBALANCE LED's will turn on. When power is applied, A1 transistors Q1 and Q2 sample the heater switching voltage through ac voltage divider A1R23 and A1R24. A1C5 ensures that transistor bases of A1Q2 and A1Q2 remain at "virtual" dc ground so that the unbalance circuits operate normally.

8-79. Power Distribution

8-80. When +15 Vdc and -15 Vdc are applied to the laser head, the ±15V POWER ON light-emitting diode indicator (on the A1 Connector Board) are forward biased and illuminate. The dc input potentials also produce a virtual ground level at the junction of two 14.7K Ohm resistors. This balanced condition results in an open circuit at transistors A1Q1 and A1Q2. An unbalanced condition exists when either the positive or negative dc input deviates from 15 Volts by approximately 1 Volt or more. This offset causes a corresponding forward biasing of A1Q1 or A1Q2 thus placing the anode of LED DS5 or DS6 (±15V SUPPLY UNBALANCE) at "virtual" ground potential. Table 8-2 lists the unbalanced DC voltage conditions and the resulting unbalanced indications.

		UNBALANCED) INDICATORS
DC INPUT VOLTAGE	UNBALANCED CONDITION	+15V SUPPLY UNBALANCE	-15V SUPPLY UNBALANCE
+15 Vdc	High (more positive)	ON	OFF
	Low (less positive)	OFF	ON
-15 Vdc	High (more negative)	OFF	ON
	Low (less negative)	ON	OFF

Table 8-2.	. DC Unbalanced Failu	ires
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- 8-81. If either the +15 Vdc or -15 Vdc 1.5 Amp fuse opens, the difference in potential that results (across DS1 or DS2) will forward bias the associated LED indicator, turning that fuse indicator on.
- 8-82. System operating power is distributed to the laser head and other transducer units via the connector board. Safety switch A1S1 opens when the laser head covers are removed. This disconnects -15 Vdc from the high voltage power supply. As a result, this power supply becomes inoperative. The +15 Vdc input is applied to regulator A3U7 on the A3 Reference/Control Board. This regulator provides +5 Volts for use within the laser head. The +5 Volts is used to drive laser head's logic circuitry, READY LED (A1DS8), and as a reference for the high voltage power supply switch.

8-83. A1 CONNECTOR BOARD TROUBLESHOOTING

WARNING

HIGH VOLTAGE IS PRESENT ON A1J4 IF THE LASER IS ON AND THE TUBE CONNECTOR IS NOT CONNECTED TO A1J4.

8-84. Use the schematic diagram Figure 8-23, an ohmmeter, and a voltmeter to troubleshoot A1. Check to see if A1F1 is blown. Check for proper transmission of power supply voltages. Check for proper diode action across A1CR1 and A1CR2. Check A1C1 through A1C5 for shorts. Check switches A1S1 and A2S2. Check A1R3 and A1R4.

8-85. Rear Panel LED Operational Check

WARNING

MAINTENANCE DESCRIBED HEREIN IS PERFORMED WITH POWER SUPPLIED TO THE EQUIPMENT AND WITH THE PROTECTIVE COVERS REMOVED. SUCH MAINTENANCE SHOULD BE PERFORMED ONLY BY SERVICE- TRAINED PERSONNEL WHO ARE AWARE OF THE HAZARDS INVOLVED (FOR EXAMPLE, FIRE AND ELECTRIC SHOCK). WHERE MAINTENANCE CAN BE PERFORMED WITHOUT POWER APPLIED, THE POWER TO THE EQUIPMENT SHOULD BE REMOVED.

WARNING

FROM 1.2 KILOVOLTS TO 12 KILOVOLTS DC IS PRESENT ON THE ANODE OF THE LASER TUBE IN THE HP5501B. EXERCISE EXTREME CAUTION WHEN WORKING INSIDE THE INSTRUMENT. THE HIGH VOLTAGE COULD CAUSE SERIOUS PERSONAL INJURY IF CONTACTED. THE INSTRUMENT SERVICE SHOULD BE PERFORMED BY SERVICE-TRAINED PERSONNEL ONLY.

- 8-86. The following procedure can be used as an operational check of the rear panel LED's. Perform only if a problem is suspected.
 - a. Remove **HP5501B** instrument covers as described in paragraph 8-55.
 - b. Leave TEST-NORM switch (A1S2) set to NORM.
 - c. Apply power to laser head as per Figure 4-1. (Use HP 6255A Dual DC Power Supply or its equivalent.)

d. Within 10 minutes of applying power to the laser head, the rear panel LED's should reflect the following status.

+15V SUPPLY UNBALANCE	ON	+15V POWER ON	ON
-15V SUPPLY UNBALANCE	ON	-15V POWER ON	ON
+15V FUSE	OFF	READY	OFF or FLASHING
-15V FUSE	OFF	LASER ON	OFF

- e. Disconnect power from laser head.
- f. Using a pair of insulated long-nose pliers, CAREFULLY remove -15 Volt fuse from A1 board. Pull fuse straight out: DO NOT TWIST.
- g. Reapply power to laser head.
- h. The rear panel LED's should reflect the following status.

+15V SUPPLY UNBALANCE	ON	+15V POWER ON	ON
-15V SUPPLY UNBALANCE	OFF	-15V POWER ON	OFF
+15V FUSE	OFF	READY	OFF
-15V FUSE	ON	LASER ON	OFF

- i. Disconnect power from laser head.
- j. Using a pair of insulated long-nose pliers, CAREFULLY return -15V fuse to its A1 board location. Remove +15V fuse. Pull fuse straight out: DO NOT TWIST.
- k. Reapply power to laser head.
- I. The rear panel LED's should reflect the following status.

+15V SUPPLY UNBALANCE	OFF	+15V POWER ON	OFF
-15V SUPPLY UNBALANCE	ON	-15V POWER ON	OFF
+15V FUSE	OFF	READY	OFF
-15V FUSE	ON	LASER ON	OFF

- m. Disconnect power from laser head.
- n. Replace both fuses in A1 Connector board sockets.
- o. Reapply ± 15 Volts to rear panel POWER connector.
- p. Set TEST-NORM switch (A1S2) to TEST to re-enable the High Voltage Power Supply.
- q. Wait until the rear panel LED does reflect the following status.

+15V SUPPLY UNBALANCE	OFF	+15V POWER ON	ON
-15V SUPPLY UNBALANCE	OFF	-15V POWER ON	ON
+15V FUSE	OFF	READY	ON
-15V FUSE	OFF	LASER ON	ON

r. Adjust +15 Volt supply to +17 Volts.

- s. +15V SUPPLY UNBALANCE LED should turn on at a maximum of +16.6 Volts.
- t. Adjust +15 Volt supply to +13 Volts.
- u. -15V SUPPLY UNBALANCE should turn on at a maximum of +13.4 Volts.
- v. Readjust ± 15 Volt supplies to $15V \pm 0.3$ Volts.

8-87. A2 HIGH VOLTAGE POWER SUPPLY CIRCUIT THEORY

8-88. The High Voltage Power Supply (Figure 8-18) receives -15V from the system power supplies through A1F2 and A1Q3. A1R11 and A1R12 set the high voltage output current limit. The laser discharge current passes through the high-voltage connector and ballast resistor to the laser anode and from the laser cathode to A1J4 (Pin 1). The High Voltage Power Supply switch also requires the +5 Volt supply (see Figure 8-18).

WARNING

NEVER REMOVE A1J4 WITH THE HIGH VOLTAGE SUPPLY ON. DANGEROUS HIGH VOLTAGE EXISTS.

8-89. HIGH VOLTAGE POWER SUPPLY TROUBLESHOOTING

WARNING

LASER RADIATION IS ACCESSIBLE WHEN THE HP5501B COVERS ARE REMOVED AND THE TEST-NORM SWITCH A1S2 IN THE TEST POSITION.

FROM 1.2 KILOVOLTS TO 12 KILOVOLTS DC IS PRESENT ON THE ANODE OF THE LASER TUBE IN THE HP5501B. EXERCISE EXTREME CAUTION WHEN WORKING INSIDE THE INSTRUMENT. THE HIGH VOLTAGE COULD CAUSE SERIOUS PERSONAL INJURY IF CONTACTED. ANY MAINTENANCE SHOULD BE PERFORMED BY SERVICE TRAINED PERSONNEL ONLY.

- 8-90. Various conditions result from a faulty HV power supply.
 - a. No laser light is emitted.
 - 1. Check that A1S2 is set to NORM when **HP5501B** covers are on or TEST when the covers are off.
 - 2. Check high voltage connectors (A1J3 and A1J4).
 - 3. Check voltage at transistor A1Q3's emitter. With High Voltage Power Supply on, this voltage should approach zero.
 - Check that A1F1 and A1F2 are OK and that the voltages are +15V and -15V respectively.
 If rear panel LASER ON LED is on but the laser beam remains off, there is a high probability that the HVPS is defective.

- 5. Turn the power off and disconnect the high voltage connector. Carefully connect a high voltage probe, (you will need to make a jumper to extend the probe into the high voltage connector).
- 6. Turn power back on and perform an open circuit voltage test. Before performing the open circuit voltage test, wait until the laser is in optical mode. This is indicated when LED A3DS2 is on. If A3DS2 is off, check A3 logic circuitry. A3DS2 should turn off approximately 100 seconds after reapplying power. The voltage should be 10kV to 12kV. If not, replace the high voltage power supply. If the laser still doesn't work then replace the laser assembly.

WARNING

AFTER TESTING, THE POWER SUPPLY MAY TAKE UP TO 3 MINUTES FOR THE OPEN-CIRCUIT VOLTAGE TO DECAY. THEREFORE, SHORT ANODE TO GROUND IMMEDIATELY.

- b. Laser light is emitted but flashes or causes a REF Error.
 - 1. Turn power off and disconnect A1J4. Insert a 1K, 1%, 0.5 Watt resistor (Rt) between the J4 (pin 1) connector. [Leave J4 (Pin 2) disconnected].
 - 2. Connect an oscilloscope across Rt.
 - 3. Turn on power and allow the laser to warm up.
 - 4. Observe DC test voltage. It should be between 3 and 4 Volts. If not, perform the current adjustment procedure in <u>Section 5-17</u> of this manual.
 - 5. Set the oscilloscope to view the AC component and calculate the percent ripple. There should be less than 3% ripple in the test voltage. If not, replace the HV power supply. If the ballast resistor is bad, the test voltage might be an aperiodic intermittent voltage. If this is the case, replace laser tube assembly.
 - 6. Disconnect external ± 15 Volt power supplies from laser head.
 - 7. Remove resistor R_t and replace connector to A1J4.

NOTE

If a power supply problem seems intermittent, gently tapping the HVPS with a screwdriver will induce the problem for test purposes.

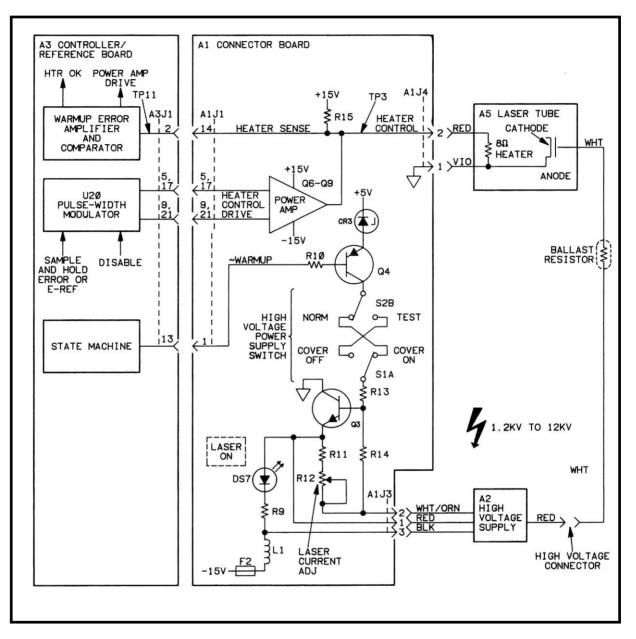


Figure 8-18. High Voltage Power Supply, Schematic Diagram

8-91. A3 CONTROLLER/REFERENCE BOARD AND A4 SAMPLER BOARD CIRCUIT THEORY

8-92. Introduction

- 8-93. Figure 8-18 (two sheets) shows the schematic diagram for the A3 Controller/Reference Board and the A4 Sampler Board.
- 8-94. The A1, A3, and A4 boards contain the electronics for the following portions of the Laser Head Block Diagram:
 - Power Amplifier
 - Warmup Error Amplifier
 - Photodiode and Amplifier
 - Liquid Crystal
 - Clock and State Machine
 - Subtracting Sample and Hold
 - Reference Receiver

8-95. Clock (A)

8-96. The frequency of oscillator U10 is determined by timing components R8, C3, C7, and C8. For normal operation, C7 gives an output frequency of approximately 100 Hz. For testing purposes capacitors C3, C7, and C8 can be configured so that the oscillator circuit generates a 1000 Hz output (JMP8 in HI position). To troubleshoot using signature analysis, the oscillator can be configured to run at 75 kHz (±20%) by removing the CLK FREQ jumper JMP8 completely.

8-97. Dividers B

8-98. The dividers, consisting of U4A and U6, convert the 100 Hz oscillator signal into the desired periods. The first stage of the divider is U6, a dual 4-bit counter, which divides the 100 Hz by 256. The last output of U6 at Pin 8 has a period of 2.56 seconds (nominal). The output of U4A at Pin 13 has a period of 5.12 seconds while the output at Pin 9 provides a period of 25.6 seconds. These two outputs are AND'ed by U2C to produce a signal called DISABLE which is high 2.56 seconds out of every 25.6 seconds. DISABLE is used by the subtracting sample and hold circuit and the power amplifier.

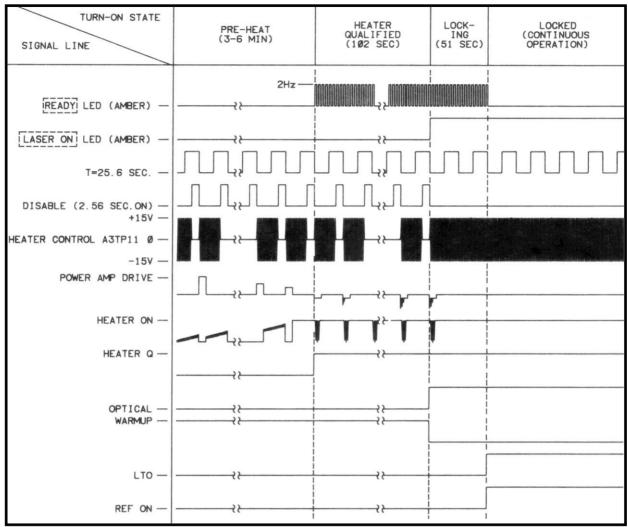


Figure 8-19. State Machine Timing Diagram

8-99. State Machine 🕞

- 8-100. The state machine, consisting of U3, U4B, and U8A, determines the four states of controller operation. The warmup mode is divided into two states, preheat and heater qualified. The optical mode is divided into locking and locked states (see Figure 8-3, Flow Diagram for State Machine). The sequence from preheat to locked is described in the following paragraphs.
- 8-101. Upon power-up, the power-on reset circuit places the state machine in the preheat state and the power amplifier turns the heater full on.
- 8-102. U8A samples the HTR OK signal on the falling edge of DISABLE to allow sufficient time for the heater coil to cool to the rod temperature. See Figure 8-5, Warmup Mode Timing Diagram. When the heater temperature rises to the proper value, the HTR OK signal from U15 causes the output of U8A, HTRQ, to go high. The state machine enters the heater qualified state and the READY LED blinks approximately twice per second. The rate of blinking is determined by the output of U6B which is gated through U2A and U19C to the READY LED. Blinking continues until the state machine enters the locked state.
- 8-103. When HTRQ goes high; U4B changes states from reset to count. Unless reset by HTR OK dropping low, U4B counts for 100 seconds and then clocks U3A. This sets OPTICAL high and locks HTRQ on. The 100 second period is sufficient to stabilize the heater temperature.

8-104. When OPTICAL goes high, the state machine enters the locking state and optical feedback controls the heater. After this state has been held for 50 seconds, LTO [U1F (Pin 12)] goes high and the controller enters the locked state. If REF ON (a signal from the Reference Receiver) is low, the entire circuit will be reset by the Power-On-Reset circuit. Otherwise U1F and U19E turn on the READY indicator LED indicating that the **HP5501B** is ready for use.

8-105. Liquid Crystal D

- 8-106. The liquid crystal, which is mounted within the A6 Sampler Assembly, connects to CMOS driver U8B via elastomeric connector strips.
- 8-107. When the PASSIVE/~ACTIVE signal at U6B (Pin 8) is high, both outputs of U8B are high, thereby placing zero potential across the liquid crystal. This is the passive state of the liquid crystal and causes the laser beam polarization to rotate by 90 degrees.
- 8-108. When PASSIVE/~ACTIVE is low, U8B produces a 50 Hz, symmetrical square wave output to configure the liquid crystal in the active state. During this state, the liquid crystal does NOT rotate the laser beam polarization.

8-109. Photodiode and Amplifier 🖲

8-110. The polarizing filter, which lies between the liquid crystal and the photodiode (A1CR1), allows only one of the two orthogonal components of the laser beam to strike the photodiode. During the passive state of the liquid crystal, the polarizing filter blocks the vertical component and the photodiode current is proportional to the horizontal component. During the active state, the photodiode current is proportional to the vertical component. The output of U11D (at TP16) is the photodiode current multiplied by an effective resistance of:

<u>(R20 + R22) R17</u> R20

8-111. Warmup Error Amplifier and Comparator \bigcirc

- 8-112. The bridge formed by A1R15 and the heater on one side, and A3R16, A3R18, and A3R19 on the other, generates an error signal on the order of 1 mV/deg C because the resistance of the heater increases with increasing temperature. The Warmup Error Amplifier, A3U14, amplifies this error.
- 8-113. The output of the HTR OK comparator, A3U15, goes high when the error voltage nears zero. The temperature at which HTR OK occurs is set by potentiometer A3R16 as described in the Reference Temperature Adjustment in <u>Section 5</u>. NOTE: See <u>Section 9.1 Service Note</u>

8-114. Subtracting Sample and Hold \oplus

- 8-115. During warmup mode, A3U2C output (DISABLE high) disables the heater (via the power amp) for 2.56 seconds out of every 25.6 seconds. During the 2.56 second disable, the heater temperature stabilizes and U12B samples the output of U14. When A3U12B opens, the sampled voltage is held on A3C13 and buffered by A3U11B. Switch A3U12C connects A3C14 and the input of A3U11C to ground.
- 8-116. During the optical mode, A3U11 0 alternately drives one of the sample and hold circuits, then the other. One sample and hold circuit (A3U12D, A3C14, and A3U11C) samples the output of A3U11D proportional to the horizontal component. The other sample and hold circuit (A3U12A, A3C13, and A3U11 B) is used for the vertical component.

8-117. The first counter (A3U6) in the divider section controls the liquid crystal and the sample and hold circuits. A sample and hold is performed once per cycle of n.28 alternating between the vertical and horizontal components [see Figure 8-8 (Optical Mode Timing Diagram)]. Thus each component is sampled once every 2.56 seconds. The liquid crystal is allowed to stabilize for 0.64 seconds before the switch to the sample and hold is closed. The hold cycle begins when the switch opens at the end of a cycle of n.28 and at the end of a half cycle of PASSIVE. The present half cycle of PASSIVE/- ACTIVE determines which component is sampled. Op-amp A3U11A computes the difference between the two sample and holds.

8-118. A1/A3 Power Amplifier ①

8-119. The output of A3U11A (from Subtracting Sample and Hold) drives the Power Amplifier section which in turn, drives the laser tube heater. The frequency response of the Power Amplifier is determined by both the input filter (A3R31, A3R27 and A3C18) and the A3U13 op-amp feedback filter (A3R32, A3R33, A3R39 and A3C20). Feedback is through A3R65B and A3C37, which integrates only the positive portion of the heater voltage. This integrated signal is proportional to heater power. A3U13 drives the input of A3U20, a switching regulator, which divides the heater power between the +15V and the -15V supplies, A3R36, A3CR7, and A3R61 form a current limiter and prevents applying a negative voltage to A3U20 (Pin 9). A3R63 and A3C38 determine the switching frequency (approximately 22 kHz or 46 microsecond period) and A3C36 controls the deadtime (off) to insure that the +15V and -15V outputs are not on at the same time. A1Q8 and A1Q6 form the positive Darlington that drives the heater to +15 Volts. A1Q9 and A1Q7 form the negative Darlington that drives the heater to -15 Volts. A1Q5 provides downshifting of negative-drive voltage level. A3U20 is disabled at Pin 10 by A3U2C when the heater error voltage is sampled during the warmup mode. The resistor networks (A3R54A, A3R54B, A3R54C, A3R65A, A3R65C, A3R65D, and A3R66) drive the output Darlington's and limit the A3U21 input voltage to +5 Volts.

NOTE

Positive and Negative Darlington-configured transistors are located on the A1 Connector board.

- 8-120. To maintain the +15V and -15V currents within maximum specified range and, because the High Voltage Power Supply (HVPS) turns on at the start of optical mode (using only the -15 Volt current supply), the maximum currents must be limited during each of the following three conditions:
 - 1. +15 Volt supply current during warmup and optical mode,
 - 2. -15 Volt supply current during warmup mode, and
 - 3. -15 Volt supply current during optical mode (-warmup mode).

The current used by each of the two Darlington's is proportional to the pulse length. The pulse begins at the fall of the positive rising sawtooth waveform (0.5V to 3.5V) at A3U20 (Pin 7) and, during the maximum current condition, is terminated when the sawtooth reaches the voltage at A3U20 (Pin 9), which is E REF at the base of Q7. A3CR8 provides temperature matching and separation between A3U13 and A3Q7when current limiting is off. E REF is the output of a multiple voltage divider network (A3R68, R69, R70, R71, R72, R73, R74) set by the open collector logic network of A3U21 which monitors the Darlington "ON" states and the warmup signal line. The voltage divider resistors are set sequentially. A3R73 and R74 are set first and limit the maximum current of the -15 Volt Darlington's during the optical mode. Next, A3R68 and R69 set the maximum current limit for the +15 Volt Darlington's during either warmup or optical mode. And last, A3R70 and R71 set the -15 Volt Darlington's to the maximum current limit during the warmup mode.

8-121. Reference Receiver (

NOTE

A TILDE ("~") PRECEDING ALL SIGNALS INDICATES NEGATIVE-TRUE LOGIC.

- 8-122. The reference receiver consists of photodiode A3CR5, an amplifier A3U17, a transistor level shifter A3Q6, and associated passive components. The receiver amplifies and converts the sinusoidal output from A3CR5 to a square wave. When ~LTO (LOCKED TUNED OPTICAL) goes low, and the receiver amplifier has adequate signal level input, the receiver is enabled and provides a low TTL signal ~REF ON. During the warmup and locking modes, the receiver supplies no useful information and is therefore disabled (~LTO high).
- 8-123. A3CR5 is reverse biased to reduce its capacitance. The +15V bias voltage is filtered by A3R46 and A3C27. A polarizer, oriented at 45 degrees to both optical frequency components, passes optical power at the reference frequency onto A3CR5. The reference frequency is the difference in frequency between the two optical frequency components of the laser beam.
- 8-124. A3U17 contains two amplifiers. The gain of the first amplifier is set by A3R44. The gain of the second amplifier is fixed. A peak detector circuit charges A3C28 to a DC value proportional to the output of A3U17. With no current from the photodiode, the voltage on A3C28 is approximately equal to the voltage on A3C24. When photodiode current is present, the change in voltage on A3C28 is the amplitude of the signal coming out of the second amplifier. When the amplitude exceeds 100 mV, the voltage at A3U17 Pin 2 (~REF ON) drops to TTL low. A3Q6, A3CR6 and A3R45 shift the output of A3U17 to TTL levels. A3 capacitors C22, C23, C24, C26 and C29 are used for coupling and bypass. A TTL high on A3U17 Pin 11 (~LTO) gates off the reference frequency output and raises A3U17 Pin 2 to Vcc.

8-125. Line Driver 🛞

8-126. A3U16 provides the necessary power to output the reference frequency signal to the system electronics. A3L3 limits the current spikes in A3U16. The special grounding and decoupling of the line drivers and receivers prevent crosstalk and oscillations.

8-127. Power-On Reset (POR) G

8-128. When power is turned on, or REF ON drops low during the locked state of the optical mode, the power-on reset circuit sets the state machine in preheat state.

8-129. Laser Head Power C

8-130. +15V and -15V are supplied by the system power supplies via the rear panel POWER connector A1J5. The +5V is generated by A3U7. A3CR2 protects A3U7. A3C5 stabilizes A3U7 and A3C4 filters A3U7 output. Output +15V is the supply after being filtered by A3L2 and A3C11. A3L1 and A3C12 filter -15V. A3 capacitors C2, C3, C6, C16, C17, and C21 provide local decoupling of the supplies.

8-131. A4 Sampler Board

8-132. The Sampler board connects to Controller/Reference board A3. The only active component on A4 is A4CR1, a photodiode that provides a signal to U11D (Pin 13) on A3. Pads on the underside of A4 connect to the liquid crystal via elastomeric connectors which project from the A6 Sampler Assembly. Liquid crystal operation is discussed in the A3 theory section.

8-133. A3 CONTROLLER/REFERENCE BOARD TROUBLESHOOTING

- 8-134. Service for A3 is divided into the following procedures, consult paragraph 8-64, **HP5501B** Trouble Isolation to determine which procedure to use.
 - a. Digital
 - b. Photodiode and Amplifier
 - c. Liquid Crystal
 - d. Subtracting Sample and Hold
 - e. Power Amplifier
 - f. Warmup Error Amplifier
 - g. Power Supplies
 - h. Reference Receiver

8-135. Standard Troubleshooting Procedures

- 8-136. In the following tests, reference is frequently made to "localize the defective element by standard troubleshooting procedures". This consists of the following:
 - a. The test procedure places a group of IC's in a definite state and:
 - 1. Provides the correct values of the input and output signals characteristics

OR

2. Implies use of the schematic to determine the signal characteristics

OR

- 3. Simply states a suspected component
- b. When the test procedure specifies a suspected component, replace it and run the test again.
- c. When signal characteristics are known, measure the signals until a component is found that has correct inputs but erroneous outputs. Most likely this component is defective. If not, check for:
 - 1. output loading such as a board short
 - 2. shorted input on a downstream circuit

If inputs are incorrect, check for open traces and faulty outputs from previous stages.

d. If an erroneous signal comes from another board, perform the test procedure for the suspected board.

8-137. Digital Troubleshooting

- 8-138. This procedure covers the clock, dividers, power-on-reset, and state machine blocks of the A3 board. The procedure assumes that the power supplies are functioning properly. The procedure requires use of standard troubleshooting procedures which are outlined in paragraph 8-136.
- 8-139. Troubleshooting Strategy: Signature analysis is used in this section to isolate faulty digital components. Malfunctions in the clock, dividers, or power-on-reset blocks will not allow the signature analyzer to operate properly. Proper clock operation is verified first, and then an attempt at verifying the state machine using signature analysis is made. If the signature analyzer doesn't work, the dividers and resets must be repaired and then the state machine can be



verified.

WHEN TAKING SIGNATURES, ENSURE THAT THE TEST-NORM SWITCH (A1S2) IS SET TO NORM AND THAT HEATER TEST JUMPER IS IN THE OFF POSITION. DAMAGE TO THE HIGH VOLTAGE POWER SUPPLY OR LASER ASSEMBLY COULD RESULT IF THESE INSTRUCTIONS ARE NOT ADHERED TO.

IMPORTANT NOTE

Upon successful completion of a check, unless otherwise specified, return all test jumpers to their original position [i.e., left-most NRM position)].

- a. With power disconnected, remove front panel and side covers as described in paragraph 8-55.
- b. Do not bypass high voltage interlock. Leave TEST-NORM A1S2 set to NORM. Set HEATER JMP7 to OFF. Turn power on. Position all jumpers to the left. Measure clock frequency at TP5 (CLK). If it is 100 Hz \pm 20% go to step **c**. If not, check clock section components.
- c. Remove CLK FREQ jumper completely. If clock frequency is now 75 kHz ±20%, go to step **d**. If not, check C3 and C7.
- d. Set HTR OK to HI and ~REF ON jumper to HI. Set up signature analysis clock, start, and stop signals for falling edge detection as indicated in the lower center portion of A3. Take signatures on U9.

Pin 16 (+5 V Test Signature)	104C
Pin 2	
Pin 3	2333
Pin 5	
Pin 7	U8PU
Pin 10	F103
Pin 11	6PCP
Pin 12	0148
Pin 13	A10H

Check signature at U19 (Pin 10) = A957

If these are OK, go to step **n**.

If the signature analyzer will not take signatures, then there is a malfunction in the dividers or power on-reset sections go to step \mathbf{e} .

If the signature analyzer works, but one or more signatures are wrong, go to step f.

e. Set HTR OK to HI, REF ON to HI, and RESET to TEST. ConnectTP2, TP3, and pin X of HTR OK jumper to ground (TP1 or TP18). Verify the dividers by measuring the frequencies at the IC pins indicated in Table 8-3 and determine if they are equal to the indicated ratios, i.e. the frequency at U6 (Pin 13) should be equal to the frequency at TP5 divided by 16. Note: The counter function of the signature analyzer may not work so a dedicated counter might be needed.

Meas IC	ure Freq at Pin	luency	Frequency should be equal to ratio of	If Incorrect, faulty part is:
U6	13	=	F (TP5/16) or ~ 4.8 kHz	U6
U4	15	=	F(U6 pin 13/16) or 300 Hz	U4 or U6
U4	1	=	F(U4 pin 15/10) or ~ 30 Hz	U4
U4	7	=	f(U4 pin 1/10) or ~ 3 Hz	U4

Table 8-3. IC A3U4 and A3U6 Divider Check

If no problem is found, proceed to step f.

- f. Set HTR OK to HI, ~REF ON to HI, RESET to TEST. Connect TP2, TP3, and Pin "X" of HTR OK jumper to ground. (TP1 or TP18). Set up the signature analysis clock, start, and stop signals for falling edge detection. Using the signatures listed in step **t**; localize the defective element by using standard signature analysis troubleshooting. Begin with U9 and use the schematic to trace back faulty signals. Check U1 (Pin 6), U19 (Pin 10), and U2 (Pin 6) right away, they are critical points. If no trouble is found, go to step **g**.
- g. Remove ground connection on HTR OK jumper. Is U8 (Pin 6) signature 05C5? If not, U8A or R48B is faulty. If so, go to step **h** or see Warm-Up Error Amplifier Troubleshooting.
- h. Remove the ground connection on TP3 and leave off. Is the +5V signature (TP9) CP5P? If not, go to step **i**. If so go to step **k**.
- i. Set HTR OK to LO. Is U8 (Pin 5) low? If not, U8 is bad. If yes, go to j.
- j. Is TP3 high? If yes, go to k. If no, check U4B, U5D, U19D, and R5D.
- k. Remove ground connection on TP2 and leave off. Set HTR OK to HI. Is +5V signature AF7A? If yes, go to step **n**. If no, go to step **I**.
- I. Remove RESET jumper. Tie center pin to +5 V. Is TP2 high? If not, replace U1, U19, or R5. If so, go to **m**.

- m. With settings same as step I, check that U4 pins 1, 2, 9, 12, 13, and 16 are all high. If not, U4 is bad. At this point, the digital section should be OK.
- n. Set REF ON to HI, HTR OK to "X", and ALL other jumpers to left. U9 (Pin 13) (HTRQ) should be high. If not, check U8A. If so go to step **o**.
- Keep ~REF ON to HI, set HTR OK to LO. U9 (Pin 13) (HTRQ) should be low. If not, U8A is bad. If so, go to step p.
- p. Set ~REF ON to LO. U9 (Pin 9) (POR) should be low. If not, U2B is bad. If so, go to step **q**.
- q. Turn the power off. Set ~REF ON to HI, HTR OK to HI, HEATER to NRM. Check that U9 (Pin 9) comes on then blinks at a few Hz or so at power on. If OK go to step r. If not, replace C1 and check CR1, R5A, R51, and R48A.
- r. Return HTR OK and ~REF ON jumpers to NRM. The READY LED should start blinking in a minute or two. If yes, go to step **s**. If no, check A1R18 and A1DS8.
- Turn power off. Set ~REF ON to HI. Set POWER AMP jumper to UP. Turn power on and s. allow the laser to run for five minutes. Observe the voltage level at U2C Pin 8 with an oscilloscope. Pin 8 will be at TTL low and will periodically go high (>2.4 Vdc) for a few seconds (approximately 2seconds). The laser head will go through the following cycle and can be monitored by observing the rear panel READY and LASER ON (or the corresponding LED's mounted on A3) and the oscilloscope display. The cycle begins with both LED's off and the voltage at U2C (Pin 8) at TTL low. The READY LED begins flashing and continues to do so for approximately 150 seconds. About 100 seconds into the cycle the laser beam and the LASER ON LED turn on. The READY LED continues to flash. After 150 seconds, the READY LED stops flashing and remains on steady. Both LED's remain on only momentarily. At this point, the DISABLE line goes high, and the laser beam and both LEDS turn off. This cycle is repetitive with the test jumpers set as they are. If the cycle occurs as described, remove power return all jumpers to their NRM position. The Digital section is OK. If Pin 8 doesn't go high, check divider and state machine circuitry. See A3 Power Amp section for additional information.
- t. Signature Analysis:

CAUTION

WHEN TAKING SIGNATURES, ENSURE THAT THE TEST-NORM SWITCH (A1S2) IS SET TO NORM AND THAT HEATER TEST JUMPER IS IN THE OFF POSITION. DAMAGE TO THE HIGH VOLTAGE POWER SUPPLY OR LASER ASSEMBLY COULD RESULT IF THESE INSTRUCTIONS ARE NOT ADHERED TO.

With the power (\pm 15 Vdc) disconnected, set the HP5501B switches and test jumpers as follows:

TEST-NORM = NORM, HTR OK = HI, \sim REF ON =HI, RESET=TEST, CLK FREQ = Remove, HEATER = OFF; TP2, TP3, and Pin "X" of HTR OK jumper to ground.

Connect the signature analyzer (HP5005A/B) test pod leads as follows:

START = A3TP7, STOP = A3TP6, CLOCK = A3TP5, GND = A3TP4

Set signature analyzer front panel controls as follows:

CLOCK, START, and STOP Polarity set for falling edge.

Pin	U1	U2	U3	U4	US	U6	U8	U9	U19	
1	41A5	4UHP	CCPC	6678	4CCA	41A5	CCPC	4CCA	F9C3	
2	0000	7U30	41A5	0000	FP96	0000	41A5	4H86	8816	
3	8816	41A5	FP96	8A5F	P861	FO9F	27HH	A5P7	41A5	
4	F9C3	4A39	41A5	0000	4UHP	CU8C	0000	4UHP	0000	
5	UA4P	41A5	FP96	20H3	P861	267H	41A5	7130	4A39	
6	CCPC	4A39	8U33	FP96	4H86	9CHA	UA4P	6678	3721	
7	0000	0000	0000	UA4P	0000	0000	0000	7C10	0000	
8	27HH	7130	3P9S	0000	41A5	4UHP	34FP	0000	0000	
9	6678	8U33	7U30	6678	41A5	4CCA	7C10	UA4P	41A5	
10	OP7C	6678	41A5	AOHO	41A5	4A39	4UHP	34FP	3721	
11	4UHP	538U	20H3	88F5	A5P7	FF57	41A5	7U30	7U30	
12	7U30	F9C3	FP96	0000	P861	0000	34FP	FP96	0000	
13	3P9S	41A5	CCPC	538U	OP7C	9CHA	4UHP	41A5	CCPC	
14	41A5	41A5	41A5	0000	41A5	41A5	41A5	0000	41A5	
15	NC	NC	NC	4UHP	NC	NC	NC	XXXX	NC	
16	NC	NC	NC	41A5	NC	NC	NC	41A5	NC	
NC = /	NC = A3U1-3, A3U5-6, and A3U19 are 14-pin package Configuration.									

Table 8-4. Signature Table

8-140. Photodiode and Amplifier Troubleshooting

- 8-141. This procedure assumes that the power supplies are functioning properly. Use a dedicated digital voltmeter, not the signature analyzer voltmeter function.
 - a. Bypass high-voltage interlock by setting A1S2 to TEST. Set HTR OK jumper to LO, PHOTO DIODE jumper to TEST, LIQ CRYS jumper to PASS. Is voltage at TP16 more negative than -4V? If no, go to step **e**. If yes, go to step **b**.
 - b. Set LIQ CRYS jumper to ACT. Is voltage at TP16 more positive than -1V? If no, go to step **e**. If yes, go to step **d**.
 - verify U11 (Pin 13) is 0 V ±10 m V. If not, replace U11. Verify voltage atTP16 is 6/11 of that at U11 D pin 14 and voltage at junction of R20 R22 is 1/11 of that at U11D (Pin 14). If not, check A3R6, R17, R20, R22, and R24. Also U12A or U12D may be incorrectly loading this node.
 - d. Amplifier is OK. Check photodiode. Verify laser is on. Set PHOTO DIODE jumper to NRM. Measure TP16 voltage. If it is >=+0.5V then photodiode A4CR1 is good. If it is approximately -6V then either the photodiode is shorted or U11 is bad. If it is -0.5V to +0.5V go to step **e**.
 - e. Remove PHOTO DIODE jumper and check for diode action between the left hand pin of the jumper and ground. If no diode action is observed, replace A4CR1. Otherwise, not enough light is reaching the photodiode. Remove the A6 Sampler Assembly and inspect the liquid crystal, beam splitters and A4CR1 for dirt, scratches, etc. If OK, see Liquid Crystal Troubleshooting.

8-142. Liquid Crystal Troubleshooting

- 8-143. This procedure assumes the digital circuits and the photodiode and amplifier circuit are functioning properly.
 - a. Set A1S2 to TEST. Verify laser is on. Set all jumpers on A3 to left except LIQ CRYS to PASS. Insert test polarizer (HP Part Number 1000-0616) between laser assembly and sampler assembly. The bottom edge of the polarizer should be parallel to the base of the **HP5501B**. Measure TP16 voltage. Is it <0.2V? If yes, go to step **c**. If not, go to step **b**.
 - B. Rotate polarizer 90 degrees. Is TP16 voltage <0.2V? If yes, go to step c. If no, go to step f.
 - c. Rotate polarizer 90 degrees. Is TP16 voltage >0.5V? If yes, go to step **d**. If not, go to step **f**.
 - d. Set LIQ CRYS jumper to ACT. Is TP16 voltage <0.2V? If yes, go to step **e**. If not, go to step **f**.
 - e. Rotate polarizer 90 degrees. Is TP16 voltage >0.5V? If yes, the liquid crystal is OK. If no, go to step **f**.
 - f. Liquid crystal may not be working. See paragraph 8-61, Liquid Crystal Test. Check that the elastomeric connectors are connecting A4 and liquid crystal.

NOTE

If contact problems develop, remove elastomeric connectors and clean both sets of contacts at A4 and the liquid crystal with isopropyl alcohol. Reinstall the elastomeric connectors (HP Part Number 8160-0530) in A4 Assembly.

8-144. Subtracting Sample and Hold Troubleshooting

- 8-145. This procedure assumes the digital circuit and photodiode and amplifier are functioning properly.
 - a. Set ~REF ON jumper to LO and HTR OK to HI. Wait for READY LED to remain on. Set HTR OK to NRM. Set PHOTO DIODE jumper to TEST, and LIQ CRYS jumper to ACT. Using a dedicated DC voltmeter, check that the voltage at TP16 is -50 mV to +50 mV? If yes, go to step c. If no, go to step b.
 - b. The circuitry connected to Pin 2 or Pin 15 (outputs) of U12 is incorrectly loading photodiode amp when switch U12A or U12D is closed. Check U11, C13, and C14.
 - c. Is voltage at TP13 equal to voltage at TP16 within 10 mV? If no, go to step **d**. If yes, go to step **e**.
 - d. Verify U12 (Pin 8) is low. Measure voltage from U11B (Pin 5) to TP13.ls it -10 mV to +10 mV? If yes, go to step i. If no, U11 B is defective or its output is incorrectly loaded.
 - e. Is voltage at TP14 equal to voltage at TP16 within 10 mV? If yes, go to step **g**. If no, go to step **f**.
 - f. Verify U12 (Pin 9) is low. Measure voltage from U11 C (Pin 10) to TP14. Is it -10 mV to +10 mV? If yes, go to step i. If no, U11C is defective or its output is incorrectly loaded.
 - g. Set POWER AMP jumper to UP. Is voltage at TP12 between -20 mV and +20 mV? If yes, go to step i.1f no, go to step h.
 - h. Verify U11A (Pin 3) voltage is about 1/2that of TP13 voltage. Verify U11A (Pin 2) voltage = U11A (Pin 3) voltage. If not, U11A, R10, R12, R14, or R15 may be bad.

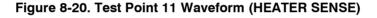
- i. Place LIQ CRYS jumper to NRM. TP16 will alternate between about 0 V to about -5 V. Record these voltages (the 11 V function of the HP 5005A/B is useful here). Measure *voltage* atTP13. It should be the same 0 V reading as at TP16, within 20 mV. If OK, go to step **k**. If not, go to step **j**.
- j. Measure the *voltage* on C13. During and just after the switch (U12A) is closed (DELAYED ACTIVE signal on Test IC U9 (Pin 3)), the voltage should equal the approximate zero voltage at TP16. If it is not, or if the *voltage* rapidly goes to zero, then C13 is shorted or the switch U12A does not work. Also check that U12B is open and U11B is not shorting this node.
- k. Is the voltage at TP14 within 20 m V of the approximate -5V voltage at TP16. If yes, go to step **m**. If not, go to step **I**.
- I. Measure the *voltage* on C14. During and just after the switch (U12D) is closed (DELAYED PASSIVE signal on Test IC U9 (Pin 2)), the voltage should equal the approximate -5V at TP16. If it is not, or the *voltage* rapidly goes to zero, then C14 is shorted or U12D is faulty. Also check that U12C is open and U11C is not shorting this node.
- m. Set PHOTO DIODE jumper to TEST, LIQ CRYS to PASS, POWER AMP to UP. Verify TP16 voltage is approximately -5V. Measure voltage at TP14 and record as V14.
 Measure voltage at U11A (Pin 3) and record as V3. Measure voltage atTP12. Is it equal to [2 X V3] V14 within 30 mV? If yes, go to step **o**. If no, go to step **n**.
- n. Verify U11A (Pin 2) is at the same voltage as U11A pin 3.lf not, U11A or R15 bad. Also check R14, R10, and R11.
- o. This procedure thus far has shown that the Subtracting Sample and Hold circuitry works during optical mode. Next the operation during warmup is checked. *Remove* power from HP5501B. Move all A3 jumpers to NRM except ~REF ON to HI. Connect an ohmmeter between Pins 6 and 7 of U12B. Turn HP5501B on. Meter should read open-circuit when the DISABLE signal [Test IC U9 (Pin 5)] is low. Meter should read less than 250 Ohms when DISABLE is high. (The HP 5005A/B measures Ohms to ground, therefore Pin 6 or Pin 7 of U12B will have to be grounded for this test). If the result is satisfactory, go to step p. If not, U12B is defective.
- p. Connect an ohmmeter between U12 (Pin 10) and ground. Ohmmeter should read less than 250 Ohms while OPTICAL (U9, pin 12) is low. If it does, go to step q. If not, U12C is faulty.
- q. Set ~REF ON to LO, HTR OK to HI and wait for ready LED to stay on. Ohmmeter should read open. If not, U12C is bad or the node is shorted. If it reads open, the Sample and Hold is OK.

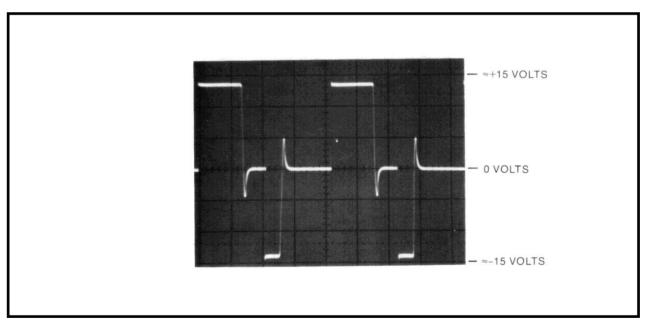
8-146. Power Amplifier Troubleshooting

- 8-147. The heart of the power amplifier is A3U20, a fixed-frequency pulse-width-modulator control unit. The IC operates at a fixed frequency set by A3R63 and C38. The outputs are used to control the amount of ±1SV current supplied to the laser assembly during the warmup and optical modes of operation. To troubleshoot the power amp, theory of operation, schematics diagrams and waveforms, and the following procedure have been provided.
 - a. Set HTR OK jumper to HI, ~REF ON to La and wait for READY LED to stay on. Set POWER AMP jumper to UP. Remove HEATER jumper. Is voltage at U13 (Pin 3) approximately 0.1V? If not, check A3R27, R31, R49, R50, R51, C18, and U13. If so, go to step b.
 - b. Within 1 minute of setting POWER AMP to UP, is voltage at A3TP11 a nonsymmetrical square wave with ±peak voltages >13 Volts? (See *Figure* 8-20.) If yes, go to step d. If not, go to step c.

NOTE

Figure 8-20 oscilloscope settings are as follows: Time/Division: 10 microseconds/division Volts/Division: 5 Volts/division Coupling: DC





- c. Is U13 (Pin 6) > +13 Vdc? If yes, go to step j. If no, check feedback path through R6SB, C20, and R32, or replace U13.
- d. Set POWER AMP jumper to DWN. Is voltage at A3TP11 <0.6 Vdc within 1 minute? If yes, go to step g. If no, go to step e.

- e. Is U13 (Pin 6) < -10 Vdc (i.e., more negative)? If yes, go to step I. If no, go to step f.
- f. Is U13 (Pin 3) approximately -0.1 Vdc? If yes, check R33 or U13. If no, check R49, R50, R51, and U13.
- g. While observing voltage at A3TP11, move POWER AMP jumper from DWN to UP. TP11 voltage should change from 0 Vdc to waveform of *Figure 8-20*. If OK, go to step h. If not, check U20 (Pins 11, 12, 13, and 14) for activity (see A3 schematic for waveforms). If waveform activity is not present, check U20 (Pins 3 and 7) for clock activity (see A3 schematic for waveforms). If waveforms and clock activity are OK, check A1 power amp transistors for (A1Q5-9) proper operation. Check E-REF input to U20 (Pin 9). Waveform should be as in *Figure 8-21*.

NOTE

Figure 8-21 oscilloscope settings are as follows:Time/Division:20 microseconds/divisionVolts/Division:1 Volt divisionCoupling:DC

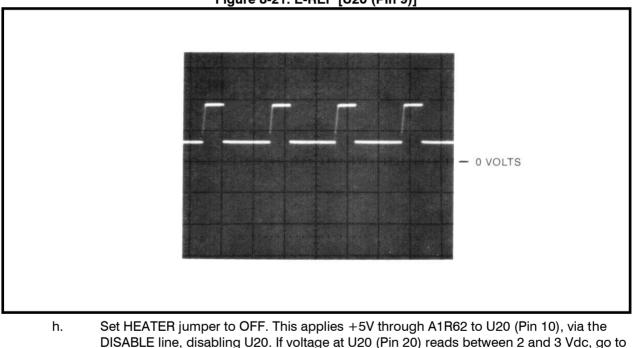


Figure 8-21. E-REF [U20 (Pin 9)]

- step i. If voltage is < 2 Vdc, U20 (Pin 10) could be shorted. If U20 (pin 10) measures approximately +5 Vdc, that input is open.
- i. Set POWER AMP to UP, HEATER jumper to NRM. U13 (Pin 6) should read> +13 Vdc.

8-148. Warm-Up Error Amplifier Troubleshooting

- 8-149. This procedure assumes the power amplifier is functioning properly.
 - a. Set HEATER jumper to OFF. A3TP11 waveform (see Figure 8-20) changes to 0 Vdc. If yes, go to step b. If no, go to power amplifier servicing.
 - b. Is A3TP15 voltage +0.2 to +0.6 Vdc? If yes, go to step c. If no, A3R18, R19 or U14 is faulty.
 - c. Check A3R16 (SET TEMP potentiometer) to see if it is shorted. Short A3TP15 to TP11. Measure U14 (Pin 6). Does the voltage stabilize between -1.5 V and +1.5 Vdc? If yes, go to step d. If no, A3R21, R23 or U14 is faulty. Remove short.
 - d. Short A3TP15 to ground (TP18). Is A3U14 (Pin 6) more negative than -12 V? If yes, go to step e. If no, U14 is faulty. Remove short.
 - e. Is voltage at A3U15 (Pin 3) approximately half of U14 (Pin 6) voltage? If yes, go to step f. If no, A3R25, R26, U12 or U15 is faulty.
 - f. Is voltage at A3U15 (Pin 2) between +1.2 Vdc and +1.3 Vdc? If yes, go to step g. If no, A3R28, R29, R30 or U15 is faulty.
 - g. Is A3U15 (Pin 7) > +3 Vdc? If yes, go to step h. If no, A3R5E, R48D, U8A, or U15 is bad.
 - h. Remove TP15 short and short TP11 to ground. Is A3U14 (Pin 6) voltage> +12 Vdc? If yes, go to step i. If not, U14 is bad.
 - i. Is A3U15 (Pin 7) between 0.05 and 0.15? If yes, the warmup error amplifier is OK. If no, A3R5E, R48D, U8A or U15 is faulty.

8-150. Power Supply Troubleshooting

8-151. If the correct voltage is not observed on A3TP8, 9, or 10, typical power supply troubleshooting should be followed. +15 V, -15V, and +5V test points must meet the limits listed in Table 8-5.

A3 Test Points	Voltage Limits			
TP8	$+14V \pm 0.3$ Vdc			
TP9	$-15V \pm 0.3$ Vdc			
TP10	+5V ± 0.25 Vdc			

Table 8-5. Voltage Testpoints and Limits

The following are suggested points to check:

- a. External system power source.
- b. A3L 1 and A3L2 are in series with the $\pm 15V$ power supplies.
- c. There should be >200 Ohms from +15V to ground.
- If A1F2 blows (-15V line, 1.5A), check for open in A1R11, A1R12, or thermally caused damage to WHT/ORN wire lead to [A1J3 (Pin 2)], or excessive current being drawn by the High Voltage Power Supply. (See High Voltage Power Supply Troubleshooting in paragraph 8-89.)
- e. Power supply components are located on both A1 and A3.

8-152. Reference Receiver Troubleshooting

- a. With power removed from the HP5501B, set the REF ON jumper on A3 to LO and HTR OK to HI. Apply power to 55018. Does the READY LED eventually start blinking then remain on continuously? If no, see HP5501B Trouble Isolation Procedure, paragraph 8-72 and procedures recommended therein.
- b. Are TTL level signals present at A3U16 (Pins 1 and 3) at a frequency between 1.5 and 2.0 MHz? If so the reference receiver may be working properly. If not, trace the signal path from U17 (Pin 16), through A3Q6, to U16 (Pins 5, 6, and 7 (TP22) and check for the following:
 - U17 (Pin 16): 0.3 to 0.7 Volt square wave at the Reference frequency of 1.5 to 2.0 MHz.
 - TP22: TTL level square wave at the REFerence frequency of 1.5 to 2.0 MHz.
 - A5J6 Rear Panel Monitor Pins C and D with an oscilloscope. Waveforms should Connector: be similar to those in Figure 8-22.

NOTE

Figure 8-22 oscilloscope settings are as follows:

Time/Division:	0.2 microseconds/division
Volts/Division:	2 Volts/division
Coupling:	DC

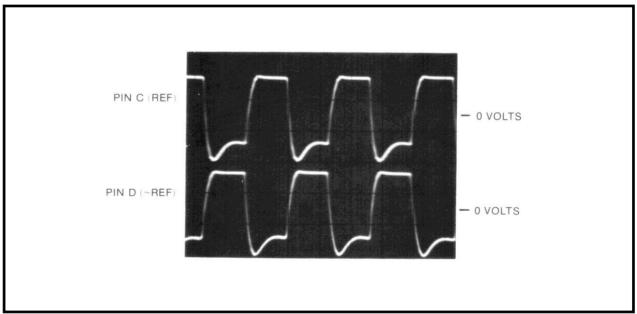


Figure 8-22. REFerence Signal Waveforms

If no activity is found, check U17 (Pin 2). If Pin 2 is at a TTL high level or changing states, then either the laser is not tuned properly, the Reference Receiver is failing or not receiving adequate signal. Verify laser tuning according to step c before continuing with step d. If U17 Pin 2 is at a TTL low level and there is no output activity as described above, then U17 may be bad or its output may be shorted. Go to step d.

- c. Align an HP10780A Receiver so that the laser beam is incident on the photodiode lens. If the laser is properly tuned, the LED on top of the HP10780A should light and the HP10780A should output a square wave at the REFerence frequency. This test can be performed with the laser installed using one of the axes' receivers. In this case, if the axis interferometer is installed, vibration (etc.) will modulate the REFerence frequency but a frequency in the range of 1.5 to 2.0 MHz should still be present. If a steady REFerence frequency signal is not detected by the HP10780A Receiver, then a laser tuning failure is indicated which is independent of the Reference Receiver. See HP5501B Trouble Isolation Procedure, paragraph 8-72. Otherwise proceed with step d.
- d. Measure and record the DC voltages at A3U17 (Pin 10) and the ACR5-R46 node. With ~REF ON jumper still set to la, place a piece of paper between the laser assembly and the sampler assembly to block the laser beam. The voltage at U17 (Pin 10) should drop by 250 mV or more, indicating adequate signal, and the DC voltages listed in *Table* 8-6 should be measured on the pins of A3U17 with the beam blocked:

PIN	DC VOLTAGE	POSSIBLE TROUBLE
9 , 12, 14	Vcc (+5 Vdc)	+15V External Power Source, +5 Volt Regulator (A3U7).
1, 15	GRD	Ground
11	TTL HIGH	A3U17, A3U1F, A3U3B, or Digital Circuits
8	+0.7 Vdc ±0.1V	A3CR5, A3U17, or associated passive components.
7	+4.8 Vdc ±0.1V	A3C22 or A3U17
6	+0.7 Vdc ±0.1V [2 mVp-p noise (nominal)]	A3U17 or associated passive components (A3R43, A3R44, A3C23 etc.).
5	+2.3 Vdc ±0.2V	A3C24 or A3U17
4	+0.8 Vdc ±0.1V	A3C23 or A3U17
10	+1.6 Vdc ±0.2V	A3C28 or A3U17
3	Vcc +0/-0.1V	A3U17
2	V cc +0/ -0.1V	A3U17
13	<80 mVdc	A3U17
16	+0.7 Vdc ±0.1V	A3Q6 or A3U17

Table 8-6. /	431117	Reference	Receiver	Test	Voltages
1 able 0-0. /	43017	neierence	Neceivei	IESL	vonayes

If any voltage is incorrect, check or replace the part listed.

If the voltage at Pin 10 does not drop according to the above, measure the DC voltage at the CR5-R46 node with the beam blocked. It should be approximately 15 Volts and should have increased at least 6 mV above the value measured and recorded previously when the laser beam was unblocked. If not, check R46, C27, or CR5. CR5 can be checked by removing power from the **HP5501B** and checking for diode action of CR5 using a DC ohmmeter. Resistance measured in the reverse direction should be much larger than the resistance measured in the forward direction. If CR5 is OK replace U17.

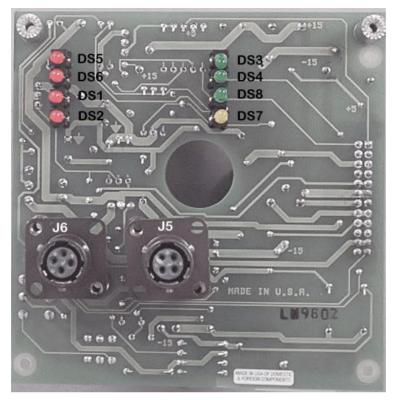
- e. In cases of marginal signal strength, the following factors should be checked:
 - Laser assembly output power
 - Sampler assembly function

The laser assembly output power should be checked according to Laser Power Output Test, paragraph 4-12.

The sampler assembly can be checked as follows:

- 1. Remove power from the HP5501B.
- 2. Remove A4.
- 3. Rest the test polarizer, HP Part Number 1000-0616 (supplied with the HP5501B), against the exposed Reference Receiver exit port of the sampler. The test polarizer will serve as a viewing screen in order to examine the laser beam which is normally incident on the Reference Receiver photodiode. Apply power to the HP5501B. Examine the laser beam cross section illuminating the polarizer. It should be circular and centered within a few millimeters with respect to the exit port. Slight eclipsing is normal. If any intensity variations are visible across the beam diameter they should be straight, regularly spaced lines of high and low intensity, not spots or irregular shapes. Rotate the polarizer 90 degrees and repeat the above observations. The sampler can be removed and the internal beam splitters and polarizer's examined for scratches dirt or cloudiness. Check the A3CR5 lens for scratches, dirt, or cloudiness. Also, see Liquid Crystal Troubleshooting, step f.

COMPONENT SIDE



CIRCUIT SIDE SERIES 2632, REV A

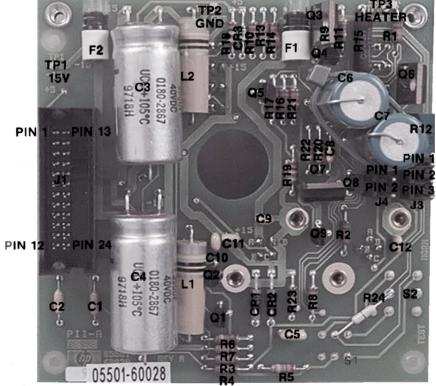


Figure 8-23. A1 Connector Board Component Locator

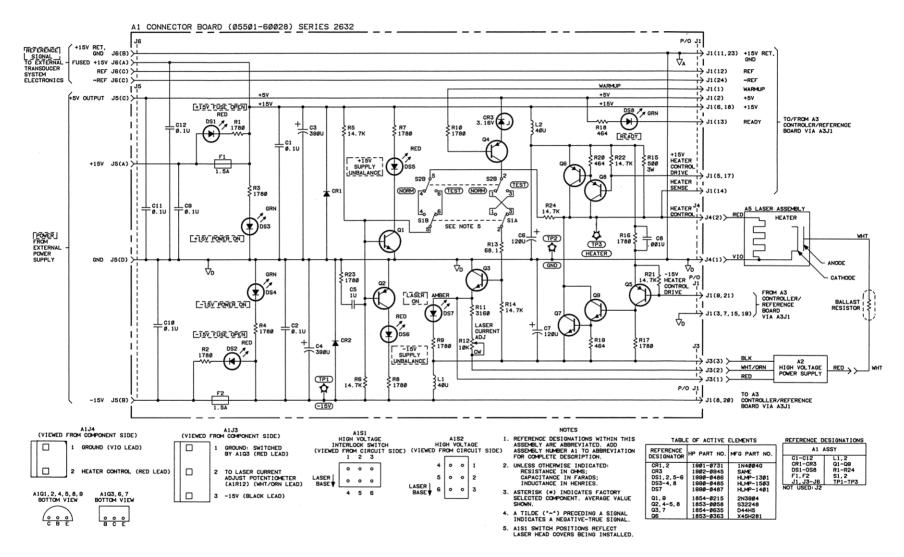
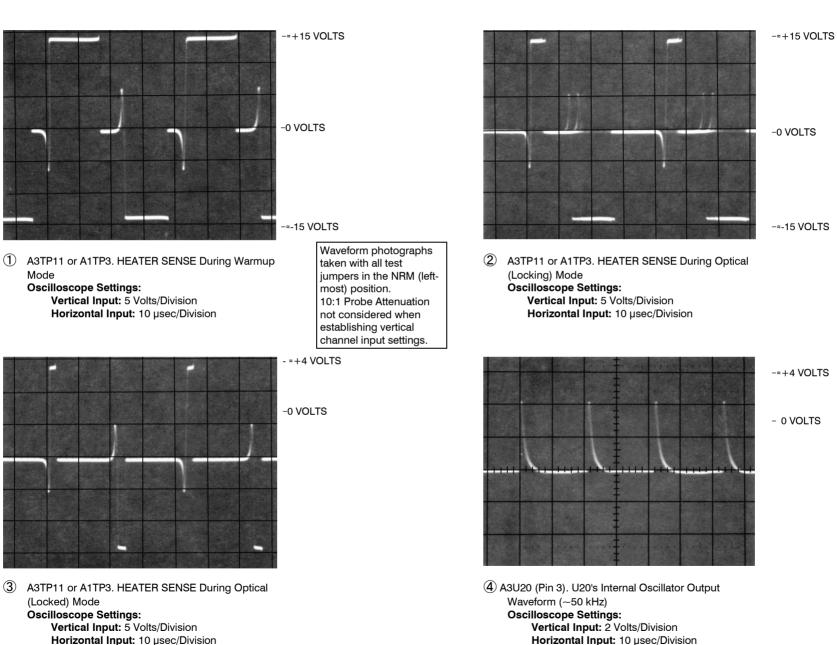


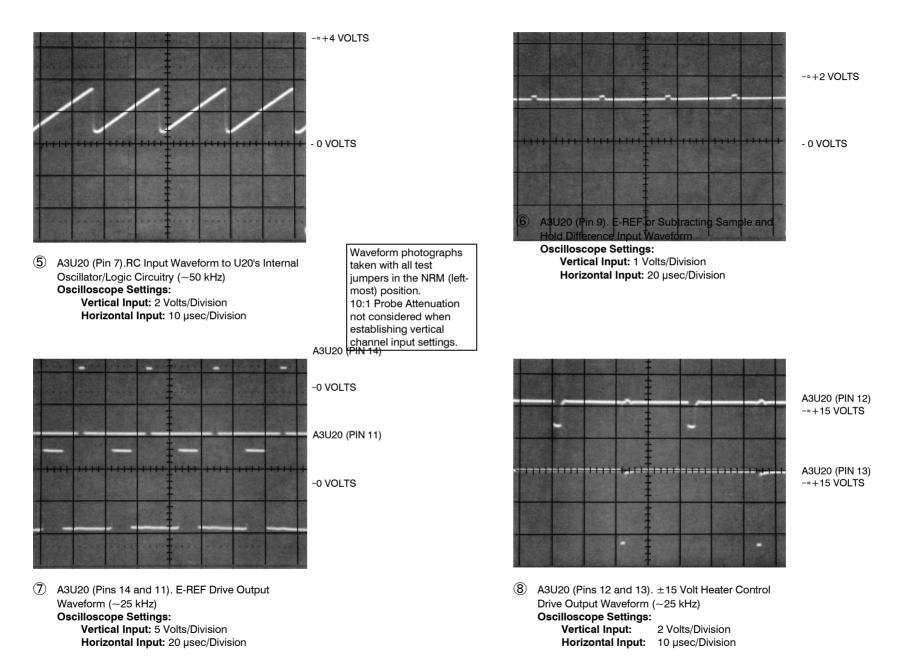
Figure 8-23. A1 Connector Board Component Schematic Diagram

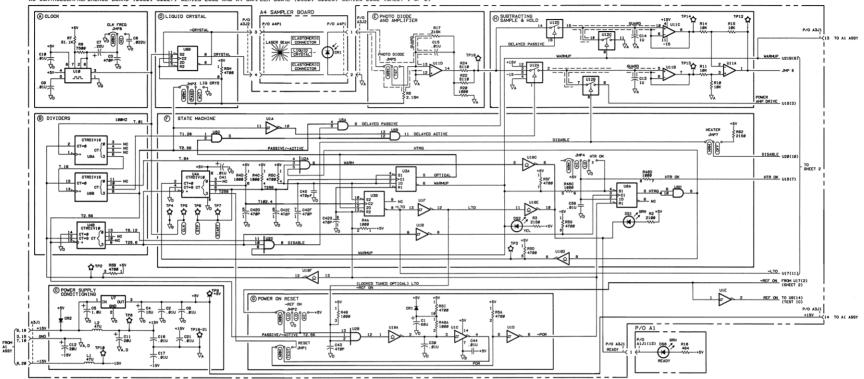
A1 \leftrightarrow A3 Connections

A1J1 PIN	A3J1 PIN	DESCRIPTION	то	FROM	BLOCK
1	13	Warmup	Through A1R10 to A1Q4	A3U3B(6)	Ð
2	14	+5V	Through A1R18 to A1CR3, and A1J5(C)	A3U7(3)	C
3	15	Digital Ground	5501B Circuitry	A1J5(D)	C
4	16			—	-
5	17	+15V Heater Control Drive	A1Q8	A3U20(12)	
6	18	+15V	5501B Circuitry	A1J5(A)	C
7	19	Digital Ground	5501B Circuitry	A1J5(D)	C
8	20	-15V	5501B Circuitry	A1J5(B)	©
9	21	-15V Heater Control Drive	A1Q5	A3U20(13)	Ū
10	22				-
11	23	+15V Signal Return Ground (Analog)	A5 Cathode, Line Driver Analog Ground	A1J6(B)	K
12	24	REF	Through A3C34, A3L5, to A3U16(1,2)	A1J6(C)	K
13	1	READY	READY LED A1DS8 and A3DS1	Flashing: A3U19(6) On Steady: A3U19(10)	Ē
14	2	HEATER SENSE	Through A3R21 to A3U14(2)	A5 Heater Control (A1TP3 or A3TP11)	J
15	3	Digital Ground	5501B Circuitry	A1J5(D)	C
16	4			—	
17	5	+15V Heater Control Drive	A1Q8	A3U20(12)	I
18	6	+15V	5501B Circuitry	A1J5(A)	Ô
19	7	Digital Ground	5501B Circuitry	A1J5(D)	C
20	8	-15V	5501B Circuitry	A1J5(B)	Ô
21	9	-15V Heater Control Drive	A1Q5	A3U20(13)	I
22	10				-
23	11	+15V Signal Return Ground (Analog)	A5 Cathode, Line Driver Analog Ground	A1J6(B)	K
24	12	~REF	Through A3C32, A3L4 to A3U16(3,4)	A1J6(D)	K

HP5501B Service

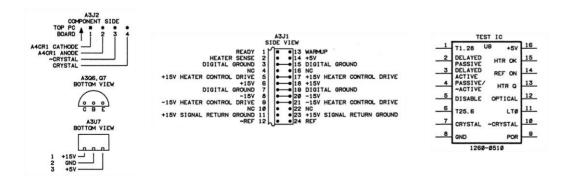






A3 CONTROLLER/REFERENCE BOARD (05501-60027) SERIES 2632 AND A4 SAMPLER BOARD (05501-60029) SERIES 2632 (SHEET 1 OF 2)

Figure 8-24. A3 Controller/Reference Board (05501-60027) and A4 Sampler Board (05501-60029) Schematic Diagram (Sheet 1 of 2)



NOTES

- 1. REFERENCE DESIGNATIONS WITHIN THIS ASSEMBLY ARE ABBREVIATED. ADD ASSEMBLY NUMBER TO ABBREVIATION FOR COMPLETE DESCRIPTION.
- 2. UNLESS OTHERWISE INDICATED:
- 3. RESISTANCE IN OHMS; CAPACITANCE IN FARADS; INDUCTANCE IN HENRIES.
- 4. ASTERISK (*) INDICATES FACTORY SELECTED COMPONENT. AVERAGE VALUE SHOWN.
- A TILDE ("~") PRECEDING A SIGNAL INDICATES A NEGATIVE-TRUE SIGNAL.
- TEST IC A3U8 IS A DUMMY 16-PIN DIP PACKAGE WITH NO INTEGRATED CIRCUIT. ALL THE IMPORTANT DIGITAL SIGNALS CONNECT TO A3U8 SO THAT A LOGIC CLIP CAN BE USED FOR MONITORING

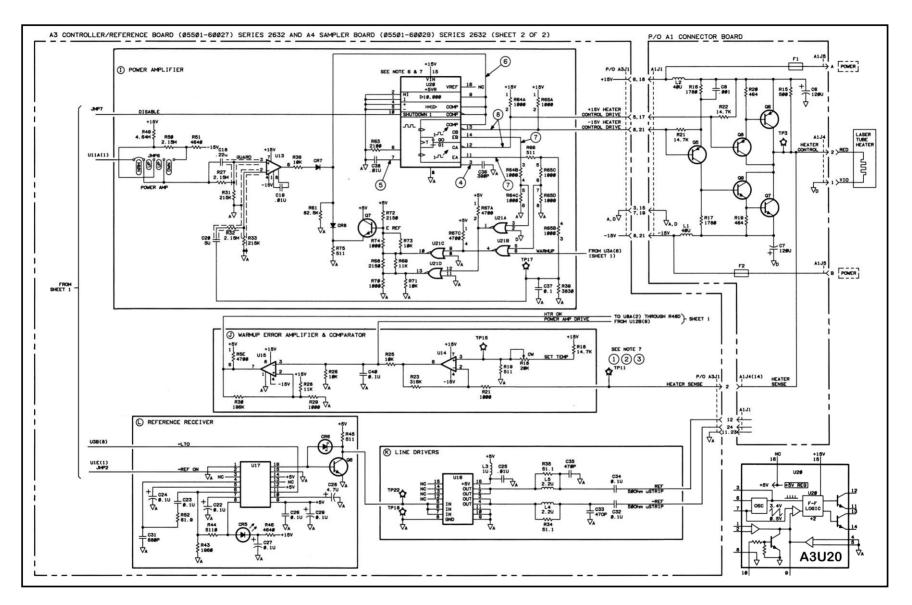


Figure 8-24. A3 Controller/Reference Board (05501-60027) and A4 Sampler Board (05501-60029) Schematic Diagram (Sheet 2 of 2)

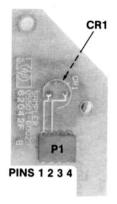


TABLE OF ACTIVE ELEMENTS

REFERENCE DESIGNATOR	HP PART NO.	MFG PART NO.
CR1,7-8	1901-0050	1N4150
CR2	1901-0731	1N4004G
CR5	1980-0770	OP913(SELECTED)
CR6	1901-0518	SAME
DS1	1990-0485	HLMP-1503
DS2	1990-0487	HLMP-1401
Q6-7	1854-0215	2N3904
U1	1820-1416	SN74LS14N
U2	1820-2889	SN74ALS11N
U3,8	1820-2488	SN74ALS74AN
U4	1820-2078	SN74LS490N
U5	1820-2635	SN74ALS08N
U6	1820-2096	SN74LS383N
U7	1820-0122	7805UC
U8	1260-0510	SAME
U10	1820-2466	1CM7555IPA
U11	1826-0753	MC34004BL
U12	1826-0416	LF13331D
U13	1826-0493	MLM308AP1
U14	1826-0519	TL071CP
U15	1826-0065	LM311N
U16	1826-2668	SN75114N
U17	1826-0775	IDA7Q
U18	1826-3562	SN74ALS1005N
U20	1826-0428	SG3524J
U21	1826-1272	SN74LS33N

Reference Designations

A3 ASSY			
CI-C45	R2-8,10,11,		
CR1,2,5-8	14-36, 39,43-		
DS1,2	46,		
J1,2	48-52, 61-85		
JMP1-8	TPI-22,		
L1-5	U1-17, 19-21		
Q6,7			

NOT USED: CR3, CR4, Q1-Q5, R1, 9, 12, 13, 37, 38, 40, 41, R42, 47, 53-60, U18

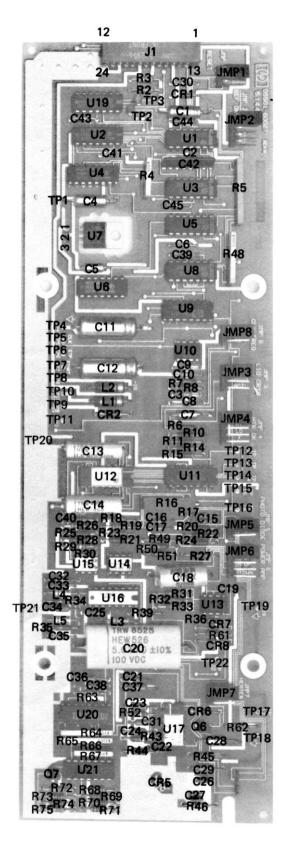


Figure 8-24 A3 Controller/Reference Board and A4 Sampler Board Photos & Data

9 SERVICE NOTES

9-1. Service Note 5501-02A July 2001

SUPERSEDES: 5501 B-02

5501B Laser Heads

Serial Numbers: 0000A00000 / 9999A99999

USOOOOOOO / US99999999

To Be Performed By: Agilent-Qualified Personnel Situation:

In many incidences, the temperature adjustment process for the laser heads had been found being adjusted incorrectly. The result of in-correct adjustment might shorten the life of the laser tube and some other un-predictable laser head performance. This service note is important addition to the manual instructions when replacing the laser tube or the control board.

Solution / Action:

- 1. After the Laser Tube or the control board has been replaced, the heater voltage must be correctly readjusted! The adjustment is done with the pot (R16) to the right of U11 on the control board.
- The adjustment must be performed when the laser tube is at room temperature, 21 to 25 degrees C (approx. 70 to 77 degrees F). If the laser High Voltage Power Supply or heater has been on, allow at least two hours with ±15 Vs off before performing this adjustment.

ADMINISTRATIVE INFORMATION

SERVICE NOTE CLASS	SIFICATION:		
MODIFICATION RECOMMENDED			
ACTION CATEGORY:	 IMMEDIATELY ON SPECIFIED FAILURE □ AGREEABLE TIME 	STANDARDS: LABOR 1.0 Hours	
LOCATION CATEGORY:	CUSTOMER INSTALLABLE	SERVICE RETURN USED RETURN INVENTORY: SCRAP PARTS: SCRAP SEE TEXT SEE TEXT SEE TEXT	
AVAILABILITY:	PRODUCT'S SUPPORT LIFE	AGILENT RESPONSIBLE UNTIL: July 2002	
AUTHOR: EL	ENTITY: 0200	ADDITIONAL INFORMATION:	

- 3. To make sure that the tube does not begin heating perform the following with the laser head "OFF":
 - a. On A3, the control board, change the HEATER jumper, JMP7, from NRM to OFF.
 - b. ON A1, connector board, UNPLUG J3, the Hi Voltage Power Supply.
- 4. Turn "ON" the laser head and measure the Voltage on Test Pin 11 (A3TP11). It should be between .2 and .3 volts.

NOTE:

The measurement should be done immediately after the head is turned on.

- 5. Calculate the heater adjust set point using the following equation: Vset = 1.285 X V(A3TP11) + 0.005 Volts
- 6. Measure A3TP15 and adjust A3R16 until it equals Vset to \pm 1 millivolt.
- 7. Turn off the laser head. Move the HEATER jumper from OFF to NRM and PLUG J3, the HV Power Supply back onto it's connector on A1.
- 8. Turn on the laser head again and wait until it locks.

NOTE:

If the laser does not lock, wait for two hours and repeat Step 1 - 5 using following equation: Vset = $1.285 \times V(A3TP11) + 0.01$ Volts then repeat Step 6 - 8.

Measure A3TP11. It should be between 5 and 7.5 Volts! Leave the head on for another half an hour and measure A3TP11 again. The voltage will have decreased, but it should still be between 5 and 7.5 Volts!